

# 32-bit Microcontroller

CMOS

## FR60 MB91305

# MB91305

### ■ DESCRIPTION

MB91305 is a single-chip microcontroller that has a 32-bit high-performance RISC CPU as well as built-in I/O resources for embedded controllers requiring high-performance and high-speed CPU processing.

The FR family is the most suitable for embedded applications, for example, DVD player, printer, TV, and PDP control, that require a high level of CPU processing power.

MB91305 is an FR60 model that is based on the FR30/40 of CPUs. It has enhanced bus access and is optimized for high-speed use.

### ■ FEATURES

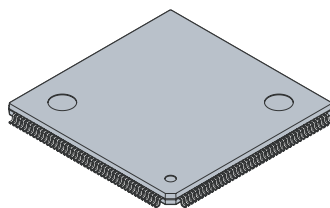
#### 1. FR CPU

- 32-bit RISC, load/store architecture, 5 stages pipeline
- With USB function (MOD = 0000<sub>B</sub>) : operating frequency of 64 MHz [original oscillation at 48 MHz] 48 MHz / 3-divided × 4 multiplication

(Continued)

### ■ PACKAGE

176-pin plastic LQFP



(FPT-176P-M07)

(Continued)

- With no USB function (MOD = 0010<sub>B</sub>) : operating frequency of 64 MHz [original oscillation at 16 MHz] 16 MHz × 4 multiplication
- 16-bit fixed-length instructions (basic instructions) , one instruction per cycle
- Memory-to-memory transfer, bit processing, instructions including barrel shift, etc. : instructions appropriate for embedded applications
- Function entry and exit instructions, multi load/store instructions of register contents : instructions compatible with high-level languages
- Register interlock function to facilitate assembly-language coding
- Built-in multiplier/instruction-level support
  - Signed 32-bit multiplication : 5 cycles
  - Signed 16-bit multiplication : 3 cycles
- Interrupts (saving of PC and PS) : 6 cycles, 16 priority levels
- Harvard architecture enabling simultaneous execution of both program access and data access
- 4-word queues in the CPU provided to add an instruction prefetch function
- Instructions compatible with the FR family

## 2. Bus Interface

This bus interface is used for external bus and internal macro USB function.

- Maximum operating frequency of 32 MHz
- 16-bit data input-output
- Totally independent 8-area chip select outputs that can be defined in the minimum units of 64K bytes. The  $\overline{CS2}$  and  $\overline{CS3}$  areas are reserved as shown below.  $\overline{CS0}$ ,  $\overline{CS1}$ , and  $\overline{CS4}$  to  $\overline{CS7}$  can be used only.
  - $\overline{CS2}$  area : USB function
  - $\overline{CS3}$  area : Unused
- Basic bus cycle (2 cycles)
- Automatic wait cycle generator that can be programmed for each area and can insert waits because  $\overline{CS2}$  and  $\overline{CS3}$  are reserved, the setting is fixed.
- 24-bit address can be fully outputted
- 8- and 16-bit data I/O
- Prefetch buffer installed
- Unused data and address pins can be used as general-purpose I/O and resource function.
- Support of interfaces for various memory modules
  - Asynchronous SRAM, asynchronous ROM/Flash memory
  - Page-mode ROM/Flash memory (a page-size of 1, 2, 4, or 8 can be selected)
  - Burst-mode ROM/Flash memory (MBM29BL160D/161D/162D etc.)
  - SDRAM (or FCRAM type, CAS Latency1 to Latency8, 2/4 bank product)
  - Address/data multiplexed bus (8-bit/16-bit width only)
- Basic bus cycle : 2 cycles
- Automatic wait cycle generator (Max 15 cycles) that can be programmed for each area
- External wait cycles due to RDY input
- Endian setting of byte ordering (big/little)

Note :  $\overline{CS0}$  area is only big endian.

- Write disable setting (read only area)
- Enable/disable set of capturing to the built-in cache
- Enable/disable set of prefetch function
- External bus arbitration using BRQ and  $\overline{BGRNT}$  is enabled

## 3. Built-in Memory

64K bytes RAM of built-in F-bus

**4. Instruction Cache Memory**

- Instruction cache : 4K bytes
- 2 way set associative
- 128 block/way, 4 entry (4 words) /block
- Lock function allows specific program codes to stay resident in cache.
- Instruction RAM function : A part of the instruction cache not in use can be used as RAM for instruction execution

**5. DMAC (DMA Controller)**

- 5 channels (channels 1 and 2 are connected to the USB function.)
- 3 transfer sources (internal peripherals, software)
- Addressing mode with 32-bit full address specifications (increase, decrease, fixed)
- Transfer modes (demand transfer, burst transfer, step transfer, block transfer)
- Transfer data size that can be selected from 8, 16, and 32 bits

**6. Bit Search Module (Used by REALOS)**

Searches for the position of the first bit varying between 1 and 0 in the MSB of a word

**7. 16-bit Reload Timer (Including One Channel for REALOS)**

- 16-bit timer; 3 channels
- Internal clock that can be selected from those resulting from frequency divided by 2, 8, and 32

**8. UART**

- Full-duplex double buffer
- 5 channels
- Parity or no parity can be selected.
- Either asynchronous (start-stop synchronization) or CLK synchronous communication can be selected.
- Built-in timer for dedicated baud rates
- An external clock can be used as the transfer clock.
- Plentiful error detection functions (parity, frame, overrun)

**9. I<sup>2</sup>C Interface\***

- 4 channels (bridge function and pin function for 5 channels)
- Master/slave transmission and reception
- Clock synchronization function
- Transfer direction detection function
- Bus error detection function
- Supports standard mode (Max 100 Kbps) and high-speed mode (Max 400 Kbps) .
- Built-in FIFO function : each 16-byte sending/receiving
- Arbitration function
- Slave address/general call address detection function
- Start condition repetitious occurrence and detection function
- 10-bit/7-bit slave address

**10. Interrupt Controller**

- Total of 17 external interrupts (one unmaskable interrupt pin ( $\overline{\text{NMI}}$ ) and 16 regular interrupt pins (INT15 to INT0) )
- Interrupts from internal peripherals
- Priority level can be defined as programmable (16 levels) except for the unmaskable interrupt pin.
- Can be used for wake-up during stop.

**11. 10-bit A/D Converter**

- 10-bit resolution, 10 channels
- Sequential comparison and conversion type (conversion time : about 8.18  $\mu\text{s}$ )
- Conversion modes (single conversion mode and scan conversion mode)
- Causes of startup (software and external triggers)

## 12. PPG

- 4 channels
- 16-bit data register with 16-bit down counter and cycle setting buffer
- Internal clock : Frequency-divide-by number selectable from 1, 4, 16, and 64

## 13. PWC

- 1 channel (1 input)
- 16-bit up counter
- Simple Low-pass digital filter

## 14. 16-bit Free-run Timer

- 16-bit 1channel
- Input capture 4 channels

## 15. USB Function (Enabling/Disabling Function Can Be Selected by Mode Pin)

- USB2.0 full-speed, double buffer
- Configuration of FIFO for End point  
CONTROL IN/OUT, BULK IN/OUT, and INTERRUPT IN

## 16. Other Interval Timers

Watchdog timer

## 17. I/O Ports

Maximum of 98 ports

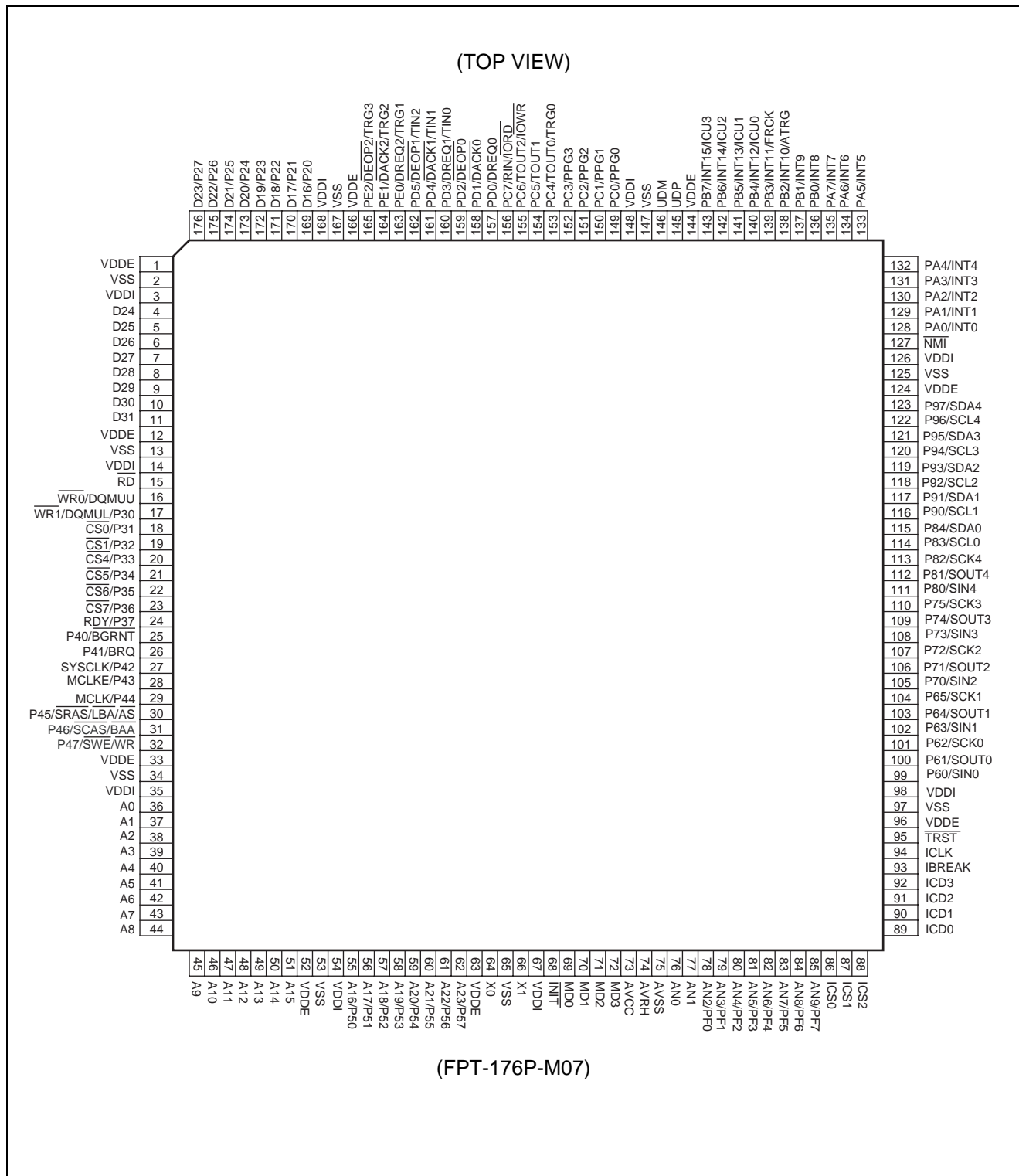
## 18. Other Features

- Has a built-in oscillation circuit as a clock source.
- $\overline{\text{INIT}}$  is provided as a reset pin.
- Additionally, a watchdog timer reset and software resets are provided.
- Stop mode and sleep mode supported as low-power consumption modes
- Gear function
- Built-in timebase timer
- Package : LQFP-176, 0.5 mm pitch, and 24 mm × 24 mm
- CMOS technology : 0.18  $\mu\text{m}$
- Power supply voltage : two sources (0.18  $\mu\text{m}$ ) of 3.3 V (−0.3 V to +0.3 V) and 1.8 V (−0.15 V to +0.15 V)

### \* : LICENSE

Purchase of Fujitsu I<sup>2</sup>C components conveys a license under the Philips I<sup>2</sup>C Patent Rights to use, these components in an I<sup>2</sup>C system provided that the system conforms to the I<sup>2</sup>C Standard Specification as defined by Philips.

## PIN ASSIGNMENT



## ■ PIN DESCRIPTION

### • Function pins

Pin no.	Pin name	I/O Type*	Function
169 to 176	D16 to D23	C	External data bus bit16 to bit23. It is available in the external bus mode.
	P20 to P27		Can be used as ports in 8-bit external bus mode.
4 to 11	D24 to D31	C	External data bus bit24 to bit31. It is available in the external bus mode.
15	$\overline{RD}$	H	External bus read strobe output. This pin is enabled at external bus mode.
16	$\overline{WR0}$ /DQMUU	H	External bus write strobe output. This pin is enabled at external bus mode. When $\overline{WR}$ is used as the write strobe, this becomes the byte-enable pin (DQMUU) .
17	$\overline{WR1}$ /DQMUL	D	External bus write strobe output. The pin is enabled when $\overline{WR1}$ output is enabled in the external bus mode. When $\overline{WR}$ is used as the write strobe, this becomes the byte-enable pin (DQMUL) .
	P30		General-purpose input/output port. The pin is enabled when the external bus write-enable output is disabled.
18	$\overline{CS0}$	D	Chip select 0 output. This pin is enabled at external bus mode.
	P31		General-purpose input/output port. This pin is enabled in the single-chip mode.
19	$\overline{CS1}$	D	Chip select 1 output. This function is enabled when chip select 1 output is enabled.
	P32		General-purpose input/output port. This function is enabled when chip select 1 output is disabled.
20	$\overline{CS4}$	D	Chip select 4 output. This function is enabled when chip select 4 output is enabled.
	P33		General-purpose input/output port. This function is enabled when chip select 4 output is disabled.
21	$\overline{CS5}$	D	Chip select 5 output. This function is enabled when chip select 5 output is enabled.
	P34		General-purpose input/output port. This function is enabled when chip select 5 output is disabled.
22	$\overline{CS6}$	D	Chip select 6 output. This function is enabled when chip select 6 output is enabled.
	P35		General-purpose input/output port. This function is enabled when chip select 6 output is disabled.
23	$\overline{CS7}$	D	Chip select 7 output. This function is enabled when chip select 7 output is enabled.
	P36		General-purpose input/output port. This function is enabled when chip select 7 output is disabled.

(Continued)

Pin no.	Pin name	I/O Type*	Function
24	RDY	D	External ready input. This function is enabled when external ready input is enabled.
	P37		General-purpose input/output port. This function is enabled when external ready input is disabled.
25	$\overline{\text{BGRNT}}$	D	Acceptance output for external bus release. Outputs "L" when the external bus is released. This function is enabled when output is enabled.
	P40		General-purpose input/output port. This function is enabled when external bus release acceptance is disabled.
26	BRQ	D	External bus release request input. Input "1" to request release of the external bus. The function is enabled when input is enabled.
	P41		General-purpose input/output port. This function is enabled when the external bus release request is disabled.
27	SYCLK	D	System clock output. This function is enabled when system clock output is enabled. This outputs the same clock as the external bus operating frequency. (Output halts in stop mode.)
	P42		General-purpose input/output port. This function is enabled when system clock output is disabled.
28	MCLKE	D	Clock enable signal for SDRAM.
	P43		General-purpose input/output port. This function is enabled when memory clock output is disabled.
29	MCLK	D	Memory clock output. This function is enabled when memory clock output is enabled. This outputs the same clock as the external bus operating frequency. (Output halts in sleep mode.)
	P44		General-purpose input/output port. This function is enabled when memory clock output is disabled.
30	$\overline{\text{AS}}$	D	Address strobe output. This function is enabled when address strobe output is enabled.
	$\overline{\text{LBA}}$		Address load output for burst flash memory. This function is enabled when address load output is enabled.
	$\overline{\text{SRAS}}$		RAS strobe single for SDRAM.
	P45		General-purpose input/output port. This function is enabled when address load output is disabled.
31	$\overline{\text{BAA}}$	D	Address advance output for burst flash memory. This function is enabled when address advance output is enabled.
	$\overline{\text{SCAS}}$		CAS strobe signal for SDRAM.
	P46		General-purpose input/output port. This function is enabled when address advance output is disabled.

(Continued)

# MB91305

Pin no.	Pin name	I/O Type*	Function
32	$\overline{WR}$	D	Memory write strobe output. This function is enabled when write strobe output is enabled.
	$\overline{SWE}$		Write output for SDRAM.
	P47		General-purpose input/output port. This function is enabled when write strobe output is disabled.
36 to 51	A0 to A15	H	External address bus bit0 to bit15.
55 to 62	A16 to A23	D	External address bus bit16 to bit23.
	P50 to P57		Can be used as ports when external address bus is not used.
64	X0	A	Clock (oscillation) input.
66	X1		Clock (oscillation) output.
68	$\overline{INIT}$	B	External reset input (Reset to initialize settings)
69 to 71	MD0 to MD2	I	These pins set the basic operating mode. Connect V <sub>CC</sub> or V <sub>SS</sub> .
72	MD3	J	These pins set the basic operating mode. Connect V <sub>CC</sub> or V <sub>SS</sub> .
76, 77	AN0, AN1	M	Analog input pin.
78 to 85	AN2 to AN9	F	Analog input pin.
	PF0 to PF7		Can be used as ports when analog input pin is not used.
86 to 88	ICS0 to ICS2	C	Status output pin for development tool.
89 to 92	ICD0 to ICD3	L	Data input/output pin for development tool.
93	IBREAK	J	Break pin for development tool.
94	ICLK	D	Clock pin for development tool.
95	$\overline{TRST}$	B	Reset pin for development tool.
99	SIN0	D	UART0 data input pin. This input is used continuously when UART0 is performing input. In this case, do not output to this port unless doing so intentionally.
	P60		General-purpose input/output port.
100	SOUT0	D	UART0 data output pin. This function is enabled when UART0 data output is enabled.
	P61		General-purpose input/output port.
101	SCK0	D	UART0 clock input/output pin. This function is enabled when UART0 clock output is enabled.
	P62		General-purpose input/output port.

(Continued)



Pin no.	Pin name	I/O Type*	Function
102	SIN1	D	UART1 data input pin. This input is used continuously when UART1 is performing input. In this case, do not output to this port unless doing so intentionally.
	P63		General-purpose input/output port.
103	SOUT1	D	UART1 data output pin. This function is enabled when UART1 data output is enabled.
	P64		General-purpose input/output port.
104	SCK1	D	UART1 clock input/output pin. This function is enabled when UART1 clock output is enabled.
	P65		General-purpose input/output port.
105	SIN2	D	UART2 data input pin. This input is used continuously when UART2 is performing input. In this case, do not output to this port unless doing so intentionally.
	P70		General-purpose input/output port.
106	SOUT2	D	UART2 data output pin. This function is enabled when UART2 data output is enabled.
	P71		General-purpose input/output port.
107	SCK2	D	UART2 clock input/output pin. This function is enabled when UART2 clock output is enabled.
	P72		General-purpose input/output port.
108	SIN3	D	UART3 data input pin. This input is used continuously when UART3 is performing input. In this case, do not output to this port unless doing so intentionally.
	P73		General-purpose input/output port.
109	SOUT3	D	UART3 data output pin. This function is enabled when UART3 data output is enabled.
	P74		General-purpose input/output port.
110	SCK3	D	UART3 clock input/output pin. This function is enabled when UART3 clock output is enabled.
	P75		General-purpose input/output port.
111	SIN4	D	UART4 data input pin. This input is used continuously when UART4 is performing input. In this case, do not output to this port unless doing so intentionally.
	P80		General-purpose input/output port.
112	SOUT4	D	UART4 data output pin. This function is enabled when UART4 data output is enabled.
	P81		General-purpose input/output port.

(Continued)

Pin no.	Pin name	I/O Type*	Function
113	SCK4	D	UART4 clock input/output pin. This function is enabled when UART4 clock output is enabled.
	P82		General-purpose input/output port.
114	SCL0	D	Clock I/O pin for I <sup>2</sup> C bus. This function is enabled when typical operation of I <sup>2</sup> C is enabled. The port output must remain off unless intentionally turned on. (pseudo open drain output)
	P83		General-purpose input/output port.
115	SDA0	D	Data I/O pin for I <sup>2</sup> C bus. This function is enabled when typical operation of I <sup>2</sup> C is enabled. The port output must remain off unless intentionally turned on. (pseudo open drain output)
	P84		General-purpose input/output port.
116	SCL1	D	Clock I/O pin for I <sup>2</sup> C bus. This function is enabled when typical operation of I <sup>2</sup> C is enabled. The port output must remain off unless intentionally turned on. (pseudo open drain output)
	P90		General-purpose input/output port.
117	SDA1	D	Data I/O pin for I <sup>2</sup> C bus. This function is enabled when typical operation of I <sup>2</sup> C is enabled. The port output must remain off unless intentionally turned on. (pseudo open drain output)
	P91		General-purpose input/output port.
118	SCL2	K	Clock I/O pin for I <sup>2</sup> C bus. This function is enabled when typical operation of I <sup>2</sup> C is enabled. The port output must remain off unless intentionally turned on. (pseudo open drain output)
	P92		General-purpose input/output port.
119	SDA2	K	Data I/O pin for I <sup>2</sup> C bus. This function is enabled when typical operation of I <sup>2</sup> C is enabled. The port output must remain off unless intentionally turned on. (pseudo open drain output)
	P93		General-purpose input/output port.
120	SCL3	K	Clock I/O pin for I <sup>2</sup> C bus. This function is enabled when typical operation of I <sup>2</sup> C is enabled. The port output must remain off unless intentionally turned on. (pseudo open drain output)
	P94		General-purpose input/output port.
121	SDA3	K	Data I/O pin for I <sup>2</sup> C bus. This function is enabled when typical operation of I <sup>2</sup> C is enabled. The port output must remain off unless intentionally turned on. (pseudo open drain output)
	P95		General-purpose input/output port.
122	SCL4	K	Clock I/O pin for I <sup>2</sup> C bus. This function is enabled when typical operation of I <sup>2</sup> C is enabled. The port output must remain off unless intentionally turned on. (pseudo open drain output)
	P96		General-purpose input/output port.

(Continued)

Pin no.	Pin name	I/O Type*	Function
123	SDA4	K	Data I/O pin for I <sup>2</sup> C bus. This function is enabled when typical operation of I <sup>2</sup> C is enabled. The port output must remain off unless intentionally turned on. (pseudo open drain output)
	P97		General-purpose input/output port.
127	$\overline{\text{NMI}}$	B	NMI (Non Maskable Interrupt) input
128 to 131	INT0 to INT3	G	External interrupt inputs. These inputs are used continuously when the corresponding external interrupt is enabled. In this case, do not output to these ports unless doing so intentionally.
	PA0 to PA3		General-purpose input/output port.
132	INT4	G	External interrupt input. These inputs are used continuously when the corresponding external interrupt is enabled. In this case, do not output to these ports unless doing so intentionally. When USB function is enabled (MD3, MD2, MD1, MD0 = 0000 <sub>B</sub> ), INT4 function is used only for the USB interrupt. Therefore, it is not possible to use it as an external interrupt pin.
	PA4		General-purpose input/output port.
133 to 135	INT5 to INT7	G	External interrupt input. These inputs are used continuously when the corresponding external interrupt is enabled. In this case, do not output to these ports unless doing so intentionally.
	PA5 to PA7		General-purpose input/output port.
136	INT8	G	External interrupt input. These inputs are used continuously when the corresponding external interrupt is enabled. In this case, do not output to these ports unless doing so intentionally.
	PB0		General-purpose input/output port.
137	INT9	G	External interrupt input. These inputs are used continuously when the corresponding external interrupt is enabled. In this case, do not output to these ports unless doing so intentionally.
	PB1		General-purpose input/output port.
138	INT10	G	External interrupt input. These inputs are used continuously when the corresponding external interrupt is enabled. In this case, do not output to these ports unless doing so intentionally.
	ATR $\overline{\text{G}}$		A/D converter external trigger input. These inputs are used continuously when using as A/D start trigger. In this case, do not output to these ports unless doing so intentionally.
	PB2		General-purpose input/output port.
139	INT11	G	External interrupt input. These inputs are used continuously when the corresponding external interrupt is enabled. In this case, do not output to these ports unless doing so intentionally.
	FRCK		External clock input pin of free-run timer. These inputs are used continuously when using as external clock input pin of free-run timer. In this case, do not output to these ports unless doing so intentionally.
	PB3		General-purpose input/output port.

(Continued)

# MB91305

Pin no.	Pin name	I/O Type*	Function
140 to 143	INT12 to INT15	G	External interrupt input. These inputs are used continuously when the corresponding external interrupt is enabled. In this case, do not output to these ports unless doing so intentionally.
	ICU0 to ICU3		Input capture input pins. These inputs are used continuously when selected as input capture inputs. In this case, do not output to these ports unless doing so intentionally.
	PB4 to PB7		General-purpose input/output port.
145	UDP	USB	+ pin of USB.
146	UDM		- pin of USB.
149 to 152	PPG0 to PPG3	D	PPG ch.0 to PPG ch.3 timer output.
	PC0 to PC3		General-purpose input/output port.
153	TOUT0	D	Data output of reload timer 0. This function is enabled when data output of reload timer 0 is enabled using port function register.
	TRG0		External trigger input for PPG0 timer. This input is used continuously when the corresponding timer input is enabled. In this case, do not output to this port unless doing so intentionally.
	PC4		General-purpose input/output port.
154	TOUT1	D	Data output of reload timer 1. This function is enabled when data output of reload timer 1 is enabled using port function register.
	PC5		General-purpose input/output port.
155	TOUT2	D	Data output of reload timer 2. This function is enabled when data output of reload timer 2 is enabled using port function register.
	$\overline{\text{IOWR}}$		Write strobe output for DMA fly-by transfer. This function is enabled when outputting a write strobe for DMA fly-by transfer is enabled.
	PC6		General-purpose input/output port.
156	RIN	D	PWC input. These inputs are used continuously when the corresponding external interrupt is enabled. In this case, do not output to these ports unless doing so intentionally.
	$\overline{\text{IORD}}$		Read strobe output for DMA fly-by transfer. This function is enabled when outputting a read strobe for DMA fly-by transfer is enabled.
	PC7		General-purpose input/output port.
157	DREQ0	D	External input for DMA transfer requests. This input is used continuously when the corresponding external input for DMA transfer requests are enabled. In this case, do not output to this port unless doing so intentionally.
	PD0		General-purpose input/output port.

(Continued)

Pin no.	Pin name	I/O Type*	Function
158	$\overline{\text{DACK0}}$	D	DMA external transfer request acceptance output. This function is enabled when DMA external transfer request acceptance output is enabled.
	PD1		General-purpose input/output port.
159	$\overline{\text{DEOP0}}$	D	Completion output for DMA external transfer. This function is enabled when completion output for DMA external transfer is enabled.
	PD2		General-purpose input/output port.
160	DREQ1	D	External input for DMA transfer requests. This input is used continuously when external input for DMA transfer request is enabled. In this case, do not output to this port unless doing so intentionally. When using USB, this function (DMAC ch.1) cannot be used because it is used as USB data transfer. DREQ2 input is disabled.
	TIN0		Reload timer input. This input is used continuously when the corresponding timer input is enabled. In this case, do not output to this port unless doing so intentionally.
	PD3		General-purpose input/output port.
161	$\overline{\text{DACK1}}$	D	DMA external transfer request acceptance output. This function is enabled when DMA transfer request acceptance output is enabled. When using USB, this function (DMAC ch.1) cannot be used because it is used as USB data transfer. External transfer ACK output of DMA should be disabled.
	TIN1		Reload timer input. This input is used continuously when the corresponding timer input is enabled. In this case, do not output to this port unless doing so intentionally.
	PD4		General-purpose input/output port.
162	$\overline{\text{DEOP1}}$	D	Completion output for DMA external transfer. This function is enabled when completion output for DMA external transfer is enabled. When using USB, this function (DMAC ch.1) cannot be used because it is used as USB data transfer. External transfer EOP output of DMA should be disabled.
	TIN2		Reload timer input. This input is used continuously when the corresponding timer input is enabled. In this case, do not output to this port unless doing so intentionally.
	PD5		General-purpose input/output port.
163	DREQ2	D	External input for DMA transfer requests. This input is used continuously when external input for DMA transfer request is enabled. In this case, do not output to this port unless doing so intentionally. When using USB, this function (DMAC ch.2) cannot be used because it is used as USB data transfer. DREQ2 input is disabled.
	TRG1		External trigger input for PPG1 timer. This input is used continuously when the corresponding timer input is enabled. In this case, do not output to this port unless doing so intentionally.
	PE0		General-purpose input/output port.

(Continued)

(Continued)

Pin no.	Pin name	I/O Type*	Function
164	$\overline{\text{DACK2}}$	D	DMA external transfer request acceptance output. This function is enabled when DMA transfer request acceptance output is enabled. When using USB, this function (DMAC ch.2) cannot be used because it is used as USB data transfer. External transfer ACK output of DMA should be disabled.
	TRG2		External trigger input for PPG2 timer. This input is used continuously when the corresponding timer input is enabled. In this case, do not output to this port unless doing so intentionally.
	PE1		General-purpose input/output port.
165	$\overline{\text{DEOP2}}$	D	Completion output for DMA external transfer. This function is enabled when completion output for DMA external transfer is enabled. When using USB, this function (DMAC ch.2) cannot be used because it is used as USB data transfer. External transfer EOP output of DMA should be disabled.
	TRG3		External trigger input for PPG3 timer. This input is used continuously when the corresponding timer input is enabled. In this case, do not output to this port unless doing so intentionally.
	PE2		General-purpose input/output port.

\* : For I/O circuit type, refer to “■ I/O CIRCUIT TYPES”.

### • Power supply and GND pins

Pin no.	Pin name	Function
2, 13, 34, 53, 65, 97, 125, 147, 167	VSS	GND pins. Connect all pins at the same potential.
3, 14, 35, 54, 67, 98, 126, 148, 168	VDDI	1.8 V power supply pins. Connect all pins at the same potential.
1, 12, 33, 52, 63, 96, 124, 144, 166	VDDE	3.3 V power supply pins. Connect all pins at the same potential.
73	AVCC	Analog power supply pin for A/D converter
74	AVRH	Reference power supply pin for A/D converter
75	AVSS	Analog GND pin for the A/D converter

## ■ I/O CIRCUIT TYPES

Type	Circuit	Remarks
A		<p>Oscillation feedback resistance approx. <math>1M\Omega</math></p>
B		<ul style="list-style-type: none"> <li>• With pull-up resistor</li> <li>• CMOS level hysteresis input</li> </ul>
C		<ul style="list-style-type: none"> <li>• CMOS level I/O</li> <li>• With standby control</li> <li>• <math>I_{OL} = 4 \text{ mA}</math></li> </ul>

(Continued)

# MB91305

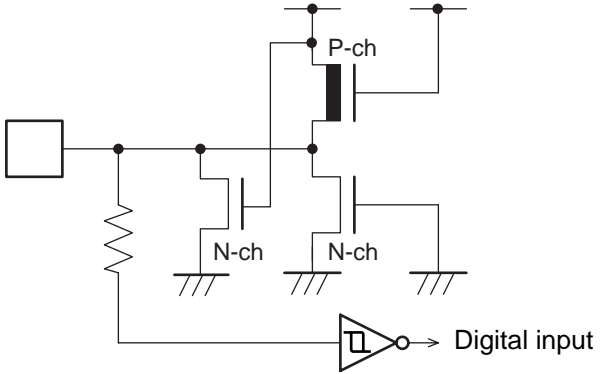
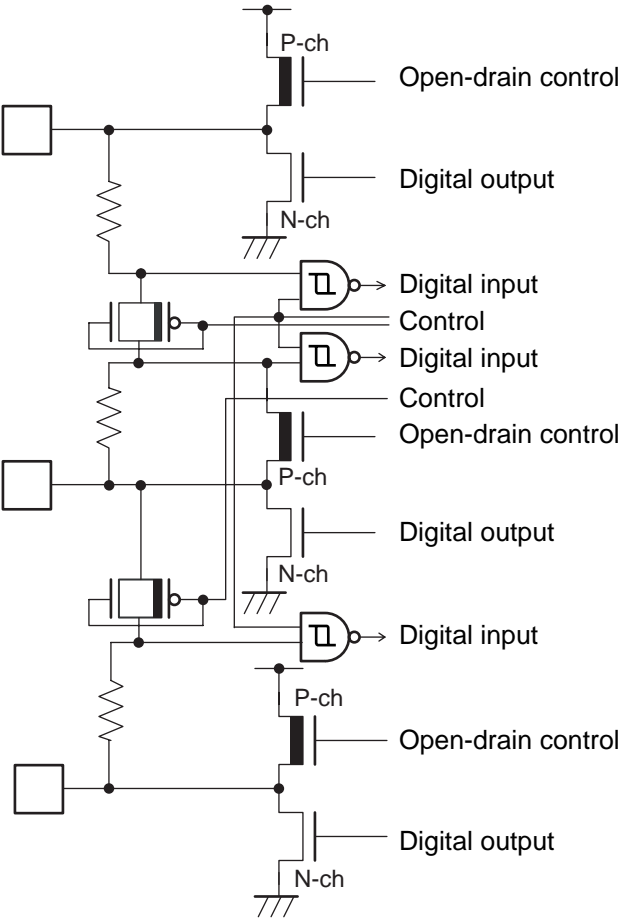
Type	Circuit	Remarks
D		<ul style="list-style-type: none"> <li>• CMOS level output</li> <li>• CMOS level hysteresis input</li> <li>• With standby control</li> <li>• <math>I_{OL} = 4 \text{ mA}</math></li> </ul>
E		<ul style="list-style-type: none"> <li>• CMOS level input</li> <li>• No standby control</li> </ul>
F		<ul style="list-style-type: none"> <li>• CMOS level output</li> <li>• CMOS level hysteresis input</li> <li>• With standby control</li> <li>• With analog input</li> <li>• <math>I_{OL} = 4 \text{ mA}</math></li> </ul>

(Continued)



Type	Circuit	Remarks
G		<ul style="list-style-type: none"> <li>• With pull-up control</li> <li>• CMOS level output</li> <li>• CMOS level hysteresis input</li> <li>• No standby control</li> <li>• <math>I_{OL} = 4 \text{ mA}</math></li> </ul>
H		<p>CMOS level output</p>
I		<ul style="list-style-type: none"> <li>• CMOS level hysteresis input</li> <li>• No standby control</li> </ul>

(Continued)

Type	Circuit	Remarks
J		<ul style="list-style-type: none"> <li>• CMOS level hysteresis input</li> <li>• With pull-down resistor</li> </ul>
K		<ul style="list-style-type: none"> <li>• 3 ports for I<sup>2</sup>C</li> <li>• CMOS level hysteresis input</li> <li>• CMOS level output</li> <li>• With stop control</li> </ul>

(Continued)

(Continued)

Type	Circuit	Remarks
L		<ul style="list-style-type: none"> <li>• CMOS I/O</li> <li>• With pull-down control</li> </ul>
M		<p>Analog pin</p>

## ■ HANDLING DEVICES

### • Preventing a Latch-up

A latch-up can occur on a CMOS IC under following conditions. A latch-up, if it occurs, significantly increases the power supply current and may cause thermal destruction of an element. When you use a CMOS IC, be very careful not to exceed the maximum rating.

- When a voltage higher than VDDE or VDDI or a voltage lower than VSS is applied to an input or output pin.
- When a voltage higher than the rating is applied between VDDE or VDDI and VSS.

### • Handling of Unused Input Pins

Do not leave an unused input pin open since it may cause a malfunction. Handle by, for example, using a pull-up or pull-down resistor.

### • Power Supply Pins

If more than one VDDE or VDDI or VSS pin exists, those that must be kept at the same potential are designed to be connected to one other inside the device to prevent malfunctions such as latch-up. Be sure to connect the pins to a power supply and ground external to the device to minimize undesired electromagnetic radiation, prevent strobe signal malfunctions due to an increase in ground level, and conform to the total output current rating. Given consideration to connecting the current supply source to VDDE or VDDI and VSS pin of the device at the lowest impedance possible.

It is also recommended that a ceramic capacitor of around 0.1  $\mu$ F be connected between VDDE or VDDI and VSS pin at circuit points close to the device as a bypass capacitor.

### • Quartz Oscillation Circuit

Noise near the X0 or X1 pin may cause the device to malfunction. Design printed circuit boards so that X0, X1, the quartz oscillator (or ceramic oscillator), and the bypass capacitor to ground are located as near to one another as possible.

It is strongly recommended that printed circuit board artwork that surrounds the X0 and X1 pins with ground be used to increase the expectation of stable operation.

Please ask the Oscillation maker to evaluate the oscillational characteristics of the crystal and this device.

### • Mode Pins (MD0 to MD3)

In order to prevent mistakes due to noise, and sending them into test mode, connect these pins as close to VDDE and VSS pins, and at as low an impedance as possible.

### • Tool Reset Pins ( $\overline{\text{TRST}}$ )

Be sure to input the same signal as the  $\overline{\text{INIT}}$  when this pin is not used for the tool. The same processing is executed for the mass product.

### • Power-on

Immediately after power-on, be sure to apply setting initialization reset (INIT) with  $\overline{\text{INIT}}$  pin.

Also immediately after power-on, keep the  $\overline{\text{INIT}}$  pin at the "L" level until the oscillator has reached the required oscillation stabilization wait time. (For initialization by INIT from the  $\overline{\text{INIT}}$  pin, the oscillation stabilization wait time is set to the minimum value.)

### • Source Oscillation Input at Power-on

At power-on, be sure to input a source clock until the oscillation stabilization wait time is reached.

## • Precautions at Power-On/Power-Off

- Precautions when turning on and off VDDI pin and VDDE pin

To ensure the reliability of LSI devices, do not continuously apply only VDDE pin for about a minute when VDDI is off.

When VDDE pin is changed from off to on, the power noise may make it impossible to retain the internal state of the circuit.

---

Power-on : Supply voltage of VDDI pin → analog → Supply voltage of VDDE pin → signal

Power-off : Signal → Supply voltage of VDDE pin → analog → Supply voltage of VDDI pin

---

- Indeterminate Output when the Power is Turned On

When turning on the power, the output pin may remain indeterminate until internal power supply becomes stable.

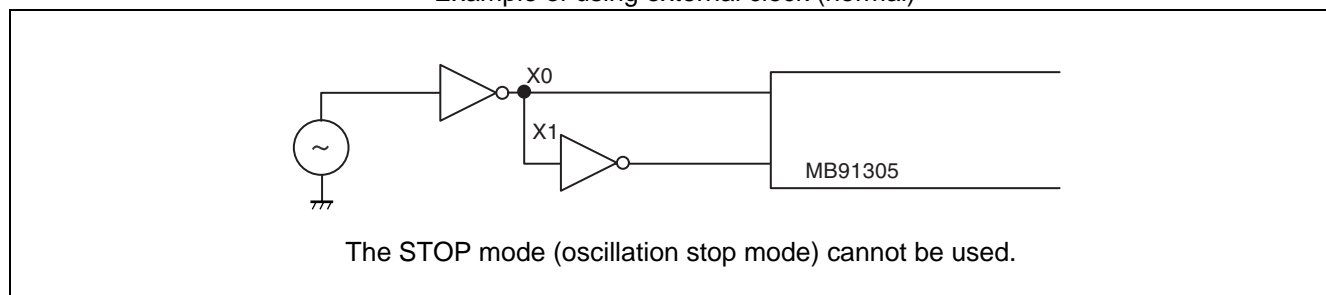
## • Clocks

- Notes on using external clock

When the external clock is used, in principle, supply a clock signal to the X0 pin and an opposite-phase clock signal to the X1 pin at the same time. However, in this case the STOP mode (oscillation stop mode) must not be used (This is because, in the STOP mode, the X1 pin stops at "H" output).

Example of using an external clock is illustrated in the following figure.

Example of using external clock (normal)



## • Limitations

- Clock controller

Secure the stabilization wait time while "L" is input to  $\overline{\text{INIT}}$  pin.

- Bit search module

Only word access is permitted for data register for detection 0 (BSD0), data register for detection 1 (BSD1), and data register for change point detection (BSDC) .

- I/O port

Only byte access is permitted for ports.

- Low-power Consumption Mode

To switch to standby mode, use synchronous standby mode (set by the SYNCS bit, that is bit8 of the TBCR, timebase counter control register) and be sure to use the following sequence :

```
(LD1 #value_of_stanby, R0)
(LD1 #_STCR, R12)
STB R0, @R12 : Writing into the standby control register (STCR)
LDUB @R12, R0 : STCR read for synchronous standby
LDUB @R12, R0 : Dummy re-read of STCR
NOP           : NOP × 5 for timing adjustment
NOP
NOP
NOP
NOP
```

- When using the monitor debugger, do not :
  - Set a break point within the above sequence of instructions.
  - Step of the instructions within the above sequence of instructions.

- Prefetch

When allowing prefetch in the little endian area, only word access (32-bit) should be used to access the area. Byte access and halfword access are not working properly.

- Notes on using PS register

PS register is processed by some instructions in advance so that exception operations as stated below may cause breaks during interruption handling routine when using debugger and may cause updates to the display contents of PS flags.

In either case, this device is designed to carry out reprocessing properly after returning from such EIT events. The operations before and after EIT events are performed as prescribed in the specification.

1. The following operations may be performed when the instruction immediately followed by a DIVOV/DIVOS instruction is acceptance of a user interrupt/NMI, single-stepped, or breaks in response to an emulator menu.
  - (1) D0 and D1 flags are updated in advance.
  - (2) EIT handling routine (user interrupt/NMI, or emulator) is executed.
  - (3) After returning from the EIT, a DIVOU/DIVOS instruction is executed and the D0 and D1 flags are updated to the same values as in (1) .
2. The following operations are performed if each instruction from ORCCR, STILM, MOV Ri, and PS is executed to allow an interruption while user interrupt/NMI trigger exists.
  - (1) PS register is updated in advance.
  - (2) EIT handling routine (user interrupt/NMI) is executed.
  - (3) After returning from the EIT, the above instructions are executed and the PS register is updated to the same value as in (1) .

- Watchdog Timer Function

The watchdog timer equipped in this model operates to monitor programs to ensure that they execute reset defer function within a certain period of time, and to reset the CPU if the reset defer function is not executed due to the program runaway. For that reason, once the watchdog timer function is enabled, it keeps its operation until it is reset.

By way of exception, the watchdog timer automatically defers a reset under the condition where the CPU program executions are stopped. For more detail, refer to the description section of the watchdog timer function in "Hardware Manual".

If the system gets out of control and the situation becomes as mentioned above, watchdog reset may not be generated. In that case, please reset (INIT) from the external  $\overline{\text{INIT}}$  pin.

- Note on using A/D

The MB91305 has a built-in A/D converter. Do not supply a voltage higher than VDDE to the AVCC.

- Software reset in synchronous mode

When software reset in the synchronous mode is used, the following two conditions must be satisfied before setting the SRST bit of the STCR (standby control register) to 0.

- Set the interrupt enable flag (I-Flag) to the interrupt disabled (I-Flag = 0).
- Do not use NMI.

- Simultaneous occurrences of software break and user interrupt/NMI

If software break and user interrupt/NMI occur together, emulator debugger may:

- Stop at a point other than the programmed break points.
- Not reexecute properly after halting.

If such failures occur, use hardware break instead of software break. When using monitor debugger, do not set any break points within the corresponding instructions.

- Stepping of the RETI Instruction

In the environment where interruptions occur frequently during stepping, the RETI is executed repeatedly for the corresponding interrupt process routines after the stepping. As the result of it, the main routine and low interrupt-level programs are not executed. To avoid this situation, do not step the RETI instruction. Otherwise, perform debugging by disabling the interruptions when the debug on the corresponding interrupt routines becomes unnecessary.

- Operand Break

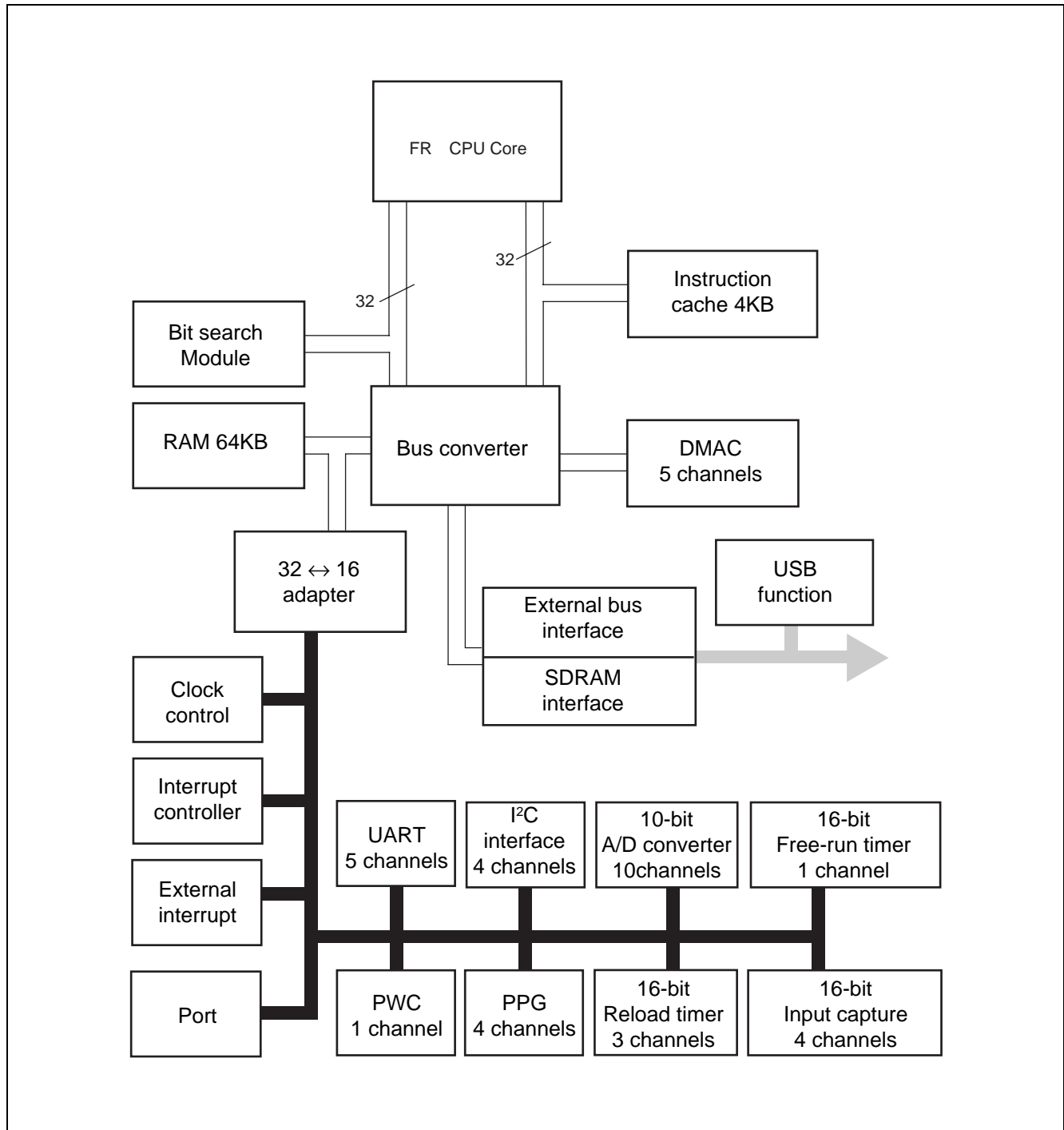
Do not set the access to the areas containing the address of stack pointer as a target of data event break.

- Sample Batch File for Configuration

When a program is downloaded to internal RAM to execute debug, be sure to execute the following batch file after reset.

```
#-----
# Set MODR (0x7fd) = Enable In memory + 16-bit External Bus
set mem/byte 0x7fd = 0x5
#-----
```

## ■ BLOCK DIAGRAM





## ■ CPU AND CONTROL UNIT

### Internal Architecture

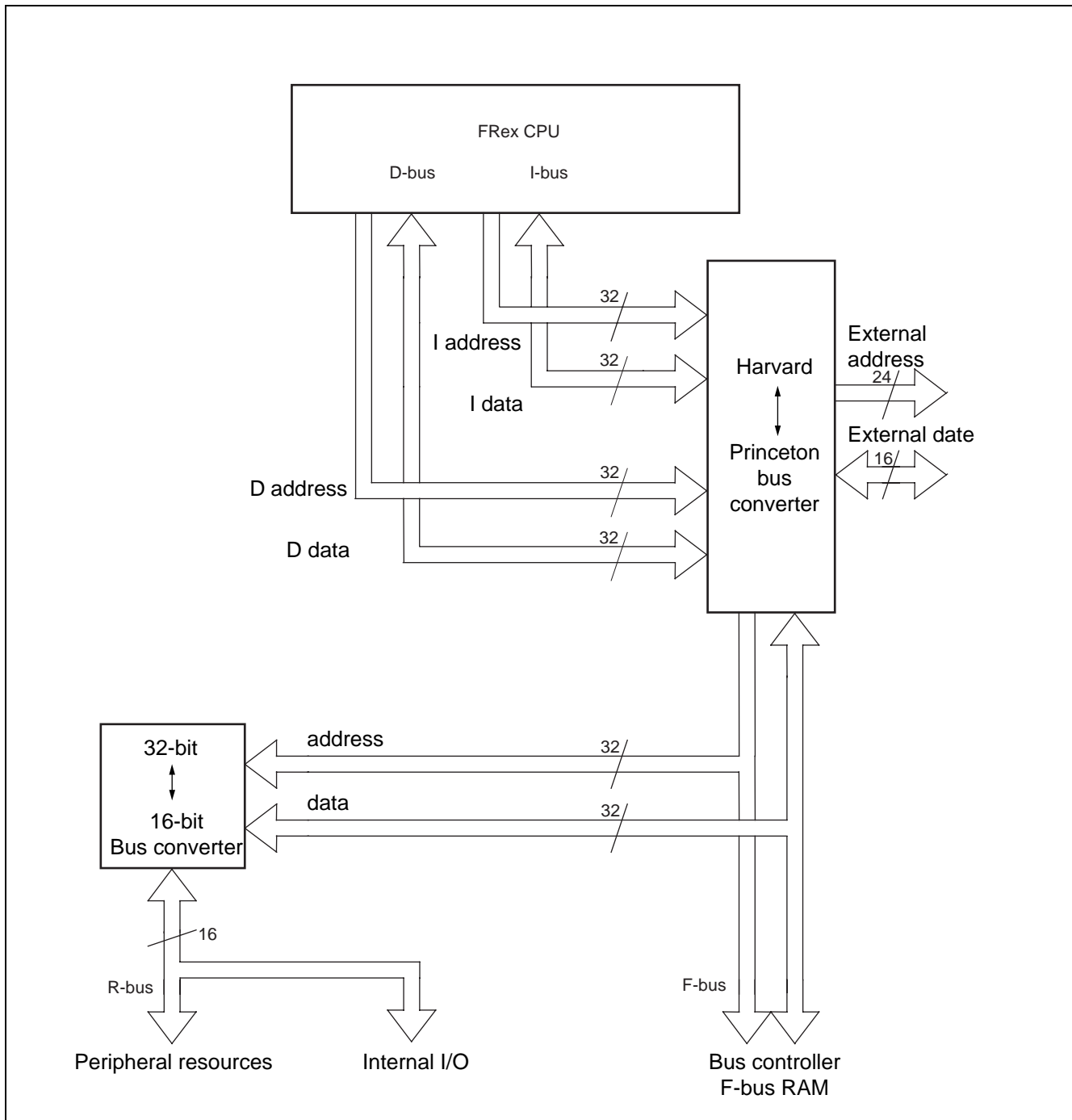
The FR family is a high-performance core based on RISC architecture and advanced instructions for embedded applications.

#### 1. Features

- RISC architecture used  
Basic instruction : One instruction per cycle
- 32-bit architecture  
General-purpose register : 32 bits × 16
- 4G bytes linear memory space
- Multiplier installed  
32-bit by 32-bit multiplication : 5 cycles  
16-bit by 16-bit multiplication : 3 cycles
- Enhanced interrupt processing function  
Quick response speed : 6 cycles  
Support of multiple interrupts  
Level mask function : 16 levels
- Enhanced instructions for I/O operations  
Memory-to-memory transfer instruction  
Bit-processing instructions
- Efficient code  
Basic instruction word length : 16 bits
- Low-power consumption  
Sleep and stop modes
- Gear function

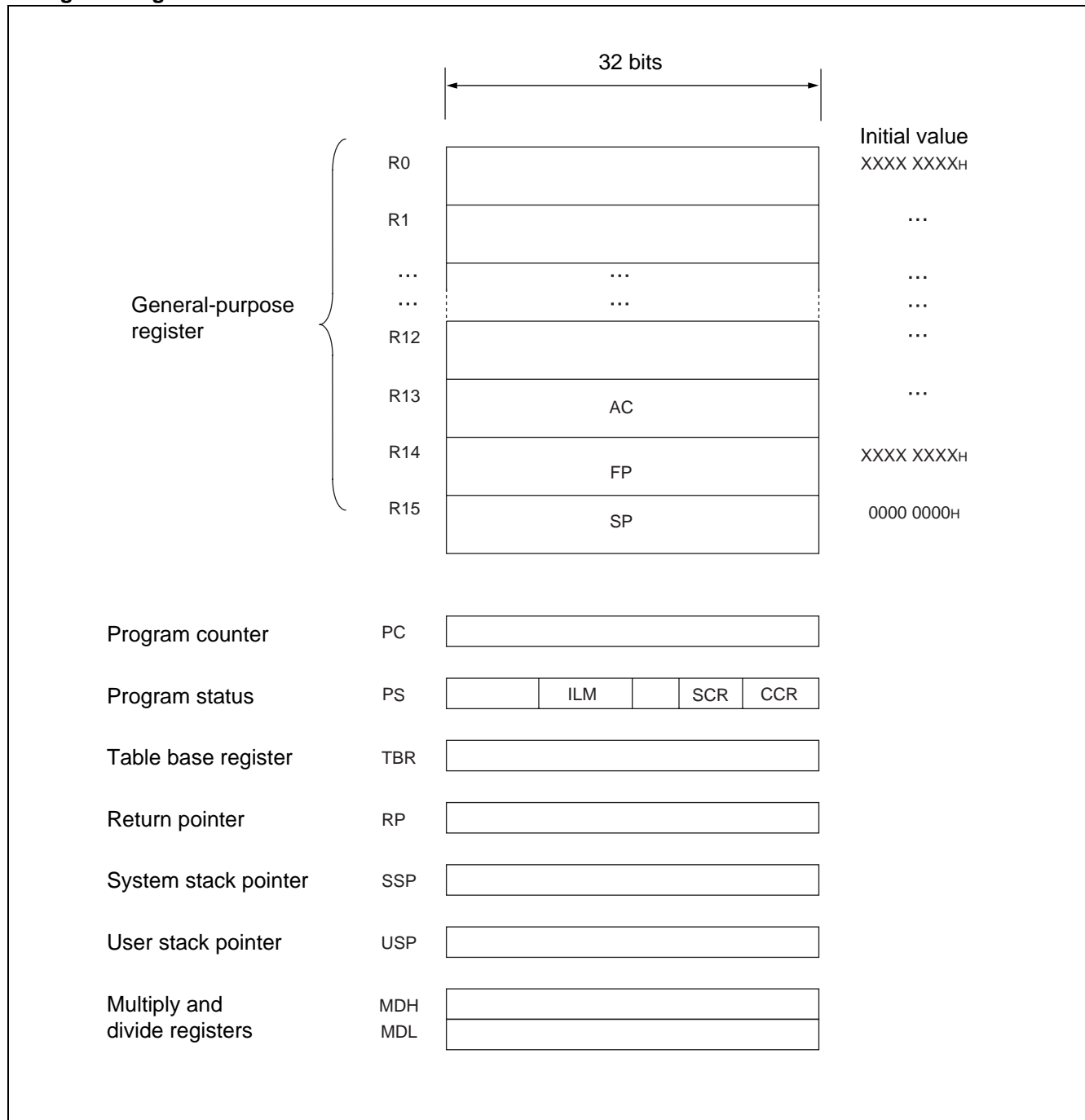
## 2. Internal Architecture

The FR family CPU uses the Harvard architecture, which has separate buses for instructions and data. A 32-bit↔16-bit bus converter is connected to the 32-bit bus (F-bus), providing an interface between the CPU and peripheral resources. A Harvard↔Princeton bus converter is connected to both the I-bus and D-bus, providing an interface between the CPU and bus controllers.



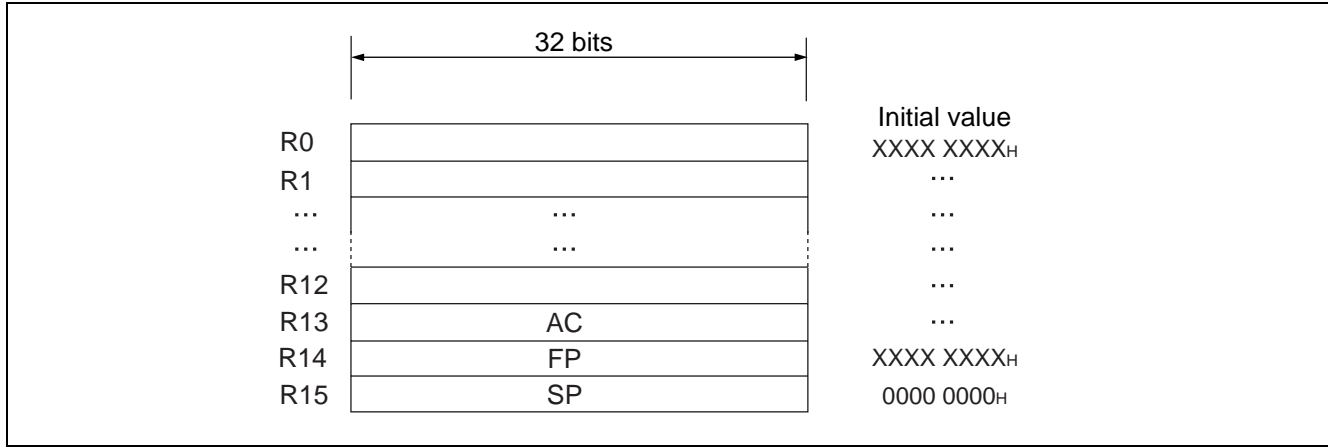
## 3. Programming Model

### • Programming Model



## 4. Registers

### • General-purpose Registers



Registers R0 to R15 are general-purpose registers. These registers are used as an accumulator in an operation or a pointer in a memory access.

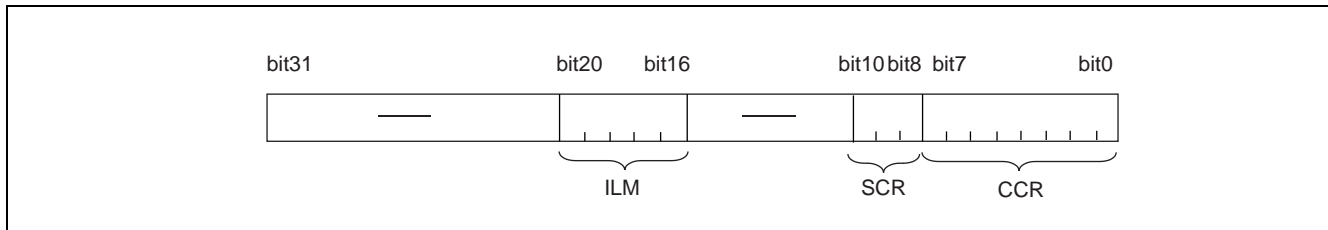
Of these 16 registers, the following are intended for special applications and therefore enhanced instructions are provided for them :

- R13 :  
Virtual accumulator (AC)
- R14 :  
Frame pointer (FP)
- R15 :  
Stack pointer (SP)

The initial value upon reset is undefined for R0 through R14 and is "00000000H" (SSP value) for R15.

- PS (Program Status)

The program status register (PS : Program Status) holds the program status. The PS register consists of three parts : ILM, SCR, and CCR. All undefined bits are reserved. During reading, "0" is always read. Writing is disabled.



## • CCR (Condition Code Register)

bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0	Initial value
—	—	S	I	N	Z	V	C	--00XXXX <sub>B</sub>

S : Stack flag

- This bit is cleared to “0” by a reset.
- Set this bit to “0” when the RETI instruction is executed.

I : Interrupt enable flag

This bit is cleared to “0” by a reset.

N : Negative flag

The initial state of this bit upon reset is undefined.

Z : Zero flag

The initial state of this bit upon reset is undefined.

V : Overflow flag

The initial state of this bit upon reset is undefined.

C : Carry flag

The initial state of this bit upon reset is undefined.

## • SCR (System Condition code Register)

bit10	bit9	bit8	Initial value
D1	D0	T	XX0 <sub>B</sub>

D1, D0 : Step division flag

These bits hold the intermediate data obtained when step division is executed.

T : Step trace trap flag

This bit specifies whether the step trace trap is to be enabled.

The step trace trap function is used by an emulator. When an emulator is used, this function cannot be used in a user program.

## • ILM (Interrupt Level Mask Register)

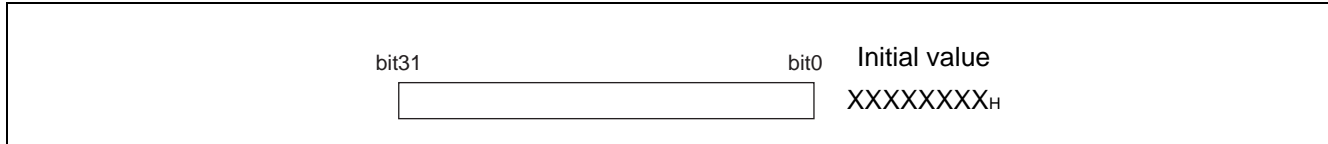
bit20	bit19	bit18	bit17	bit16	Initial value
ILM4	ILM3	ILM2	ILM1	ILM0	01111 <sub>B</sub>

The interrupt level mask (ILM) register holds an interrupt level mask value. The value held in ILM register is used as a level mask.

This register is initialized to 15 (01111<sub>B</sub>) by a reset.

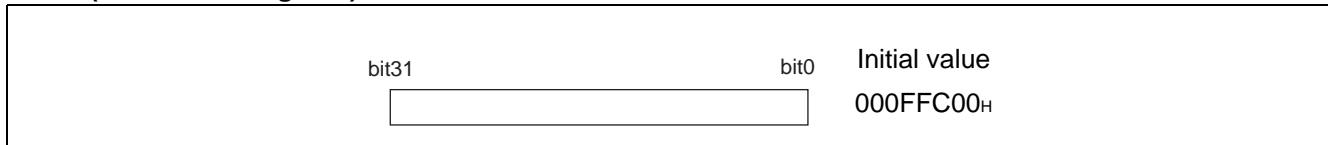
# MB91305

## • PC (Program Counter)



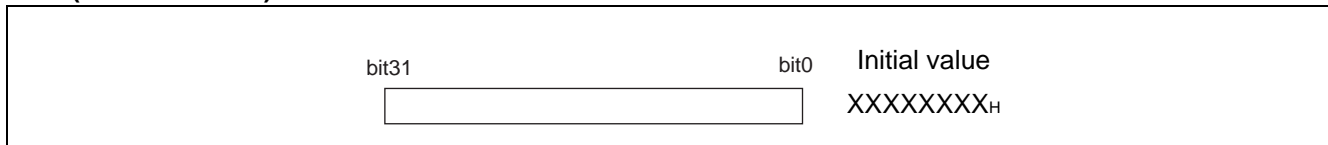
The program counter indicates the address of the instruction being executed.  
The initial value upon reset is undefined.

## • TBR (Table Base Register)



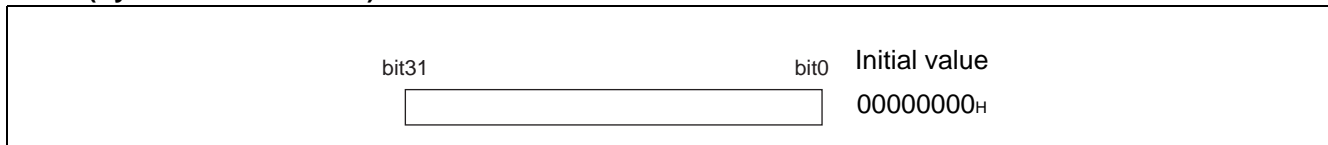
The table base register holds the first address of the vector table to be used during EIT processing.  
The initial value upon reset is "000FFC00H".

## • RP (Return Pointer)



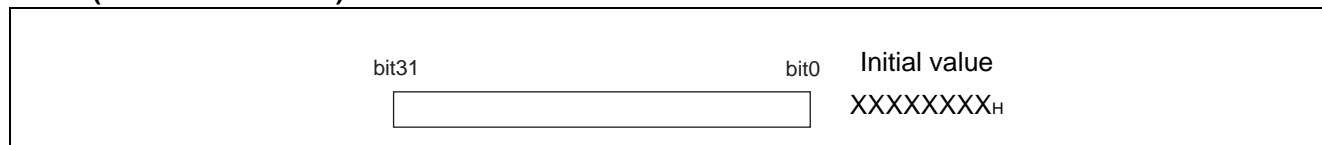
The return pointer holds the return address from a subroutine.  
When the CALL instruction is executed, the value of the PC is transferred to the RP.  
When the RET instruction is executed, the contents of the RP are transferred to the PC.  
The initial value upon reset is undefined.

## • SSP (System Stack Pointer)



The SSP is the system stack pointer.  
This register is used as an R15 general-purpose register if the S flag of the condition code register (CCR) is "0".  
The SSP can also be specified explicitly.  
This register is also used as a stack pointer that specifies a stack on which the contents of the PS and PC are to be saved if an EIT occurs.  
The initial value upon reset is "00000000H".

• **USP (User Stack Pointer)**



The USP is the user stack pointer.

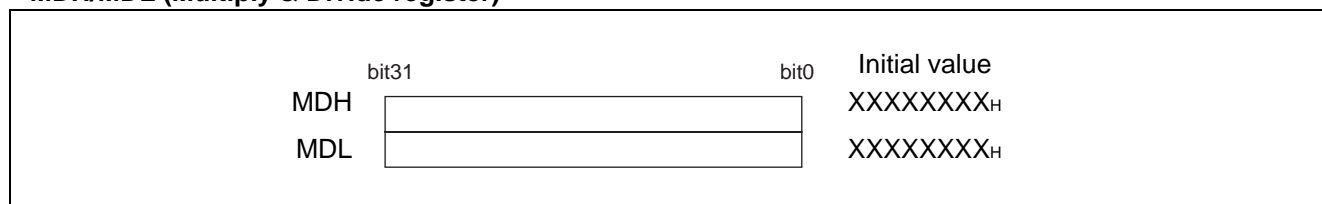
This register is used as an R15 general-purpose register if the S flag of the condition code register (CCR) is “1”.

The USP can also be specified explicitly.

The initial value upon reset is undefined.

This register cannot be used by the RETI instruction.

• **MDH/MDL (Multiply & Divide register)**



MDH and MDL are the multiply and divide registers. Each register is 32 bits long.

The initial value upon reset is undefined.

## MODE SETTINGS

For the FR family, set the operating mode using the mode pins (MD3, MD2, MD1 and MD0) and the mode register (MODR) .

### 1. Mode pins

Use the four mode pins (MD3, MD2, MD1, and MD0) to specify mode vector fetch.

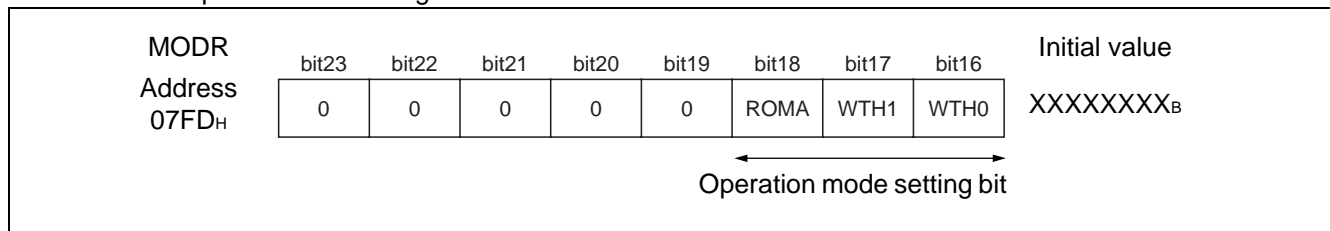
shows the specification related to the mode vector fetch.

Mode pin				Mode name	Reset vector access area	Remarks
MD3	MD2	MD1	MD0			
0	0	0	0	External ROM mode vector	External	With USB. Used at 48 MHz source oscillation.
0	0	1	0	External ROM mode vector	External	Without USB. Used at 16 MHz source oscillation.

Note : The setting other than that shown is prohibited. The single-chip mode is not supported.

### 2. Mode Register (MODR)

- Detailed explanation of the register

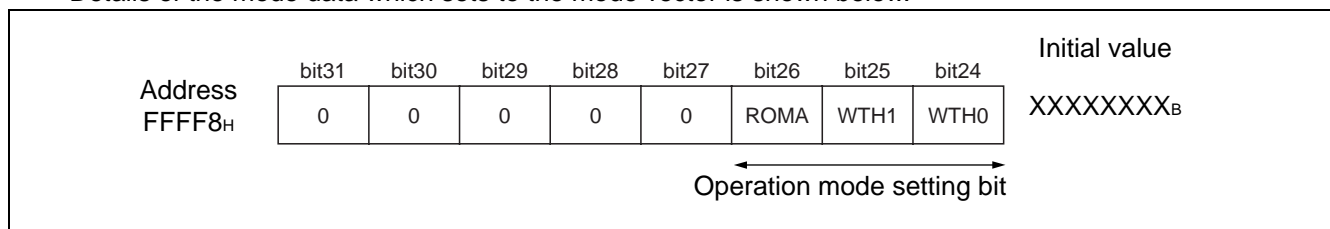


Mode data is data written to the mode register by a mode vector fetch.

After setting to the mode register (MODR) is completed, perform with the operation mode according to this register.

The mode register is set by all reset sources. Accordingly, user program cannot write data to the mode register.

- Detailed explanation of the mode data.
- In the save way of the reset vector, set the mode vector in the vector area.
- Details of the mode data which sets to the mode vector is shown below.



[bit31 to bit27] Reserved bits

Be sure to set "00000<sub>B</sub>" to these bits.

Operation when value other than "00000<sub>B</sub>" is set cannot guarantee.

[bit26] ROMA (Internal ROM enable bit)

This bit sets whether to enable internal ROM areas.



ROMA	Function	Remarks
0	External ROM mode *	Internal F-bus region (40000 <sub>H</sub> to 100000 <sub>H</sub> ) becomes an external region.
1	Internal ROM mode	Internal F-bus region (40000 <sub>H</sub> to 100000 <sub>H</sub> ) becomes access prohibited (setting disabled) .

\* : MB91305 does not contain internal ROM. Use as external ROM mode (setting ROMA = 0) .

[bit25, bit24] WTH1, WTH0 (Bus width specification bit)

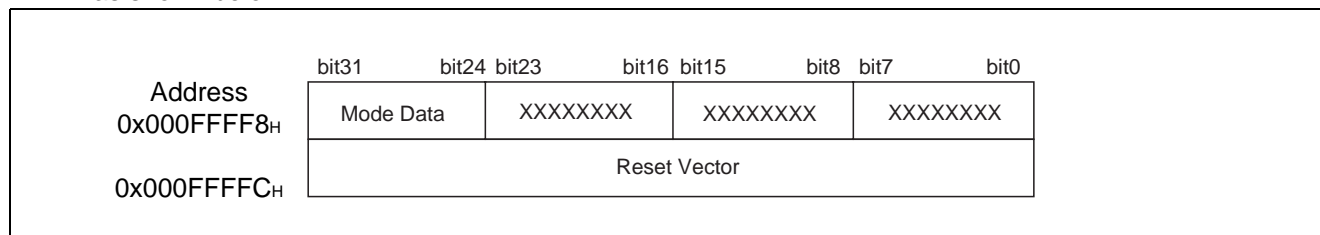
Set the bus width specification in external bus mode.

This value is set by DBW1 and DBW0 bits of ACR0 (CS0 area) in the external bus mode.

WTH1	WTH0	Function	Remarks
0	0	8-bit bus width	External bus mode
0	1	16-bit bus width	External bus mode
1	0	32-bit bus width	External bus mode (setting disabled)
1	1	Single-chip mode *	Single-chip mode (setting disabled)

\* : not supported.

Note : Mode data set in mode vector must be allocated to “0x000FFFF8<sub>H</sub>” as a byte data. In the FR family, since big endian is used as byte endian, the data must be allocated to the most significant byte in bit31 to bit24 as shown below.



# MB91305

## ■ MEMORY SPACE

### 1. Memory Space

The FR family has a logical address space of 4G bytes ( $2^{32}$  addresses) , which the CPU accesses linearly.

#### • Direct addressing area

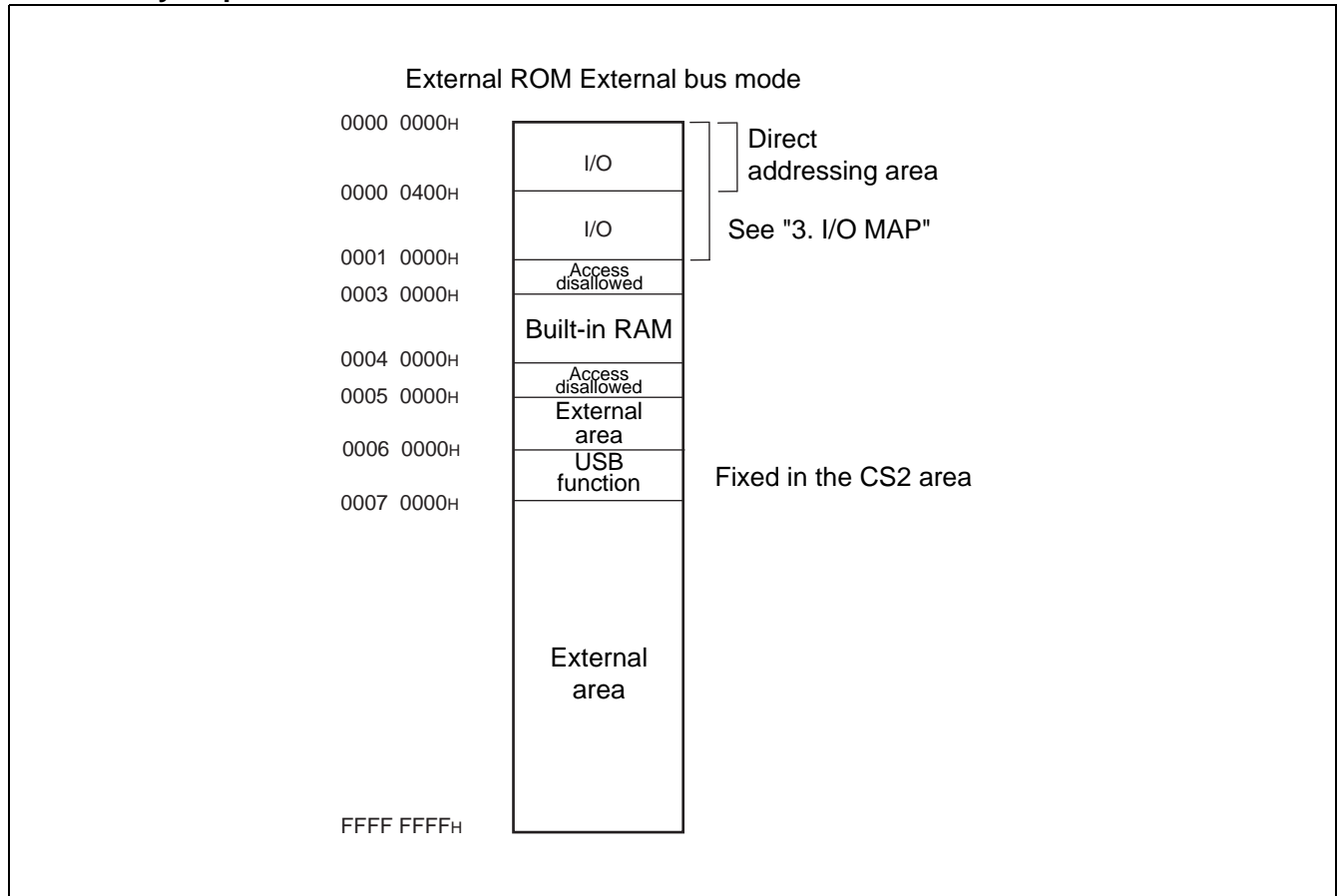
The areas in the address space listed below are used for input-output.

These areas are called the direct addressing area. The address of an operand can be directly specified in an instruction.

The size of the direct addressing area varies according to the size of data to be accessed :

- Byte data access : 000H to 0FFH
- Halfword data access : 000H to 1FFH
- Word data access : 000H to 3FFH

### 2. Memory Map



Note : Internal RAM area of the MB91305 is "0003 0000H" to "0003 FFFFH".

## ■ I/O MAP

Shows the correspondence between the memory space area and the peripheral resource registers.

Reading the table

Address	Register				Block
	+0	+1	+2	+3	
000000H	PDR0 [R/W] X*XXXXXX*	PDR1 [R/W] XXXXXXXX	PDR2 [R/W] XXXXXXXX	PDR3 [R/W] XXXXXXXX	T-unit Port Data Register

Read/write attribute  
 Initial value of register after reset  
 Register name (column 1 of the register is at address 4n, column 2 is at address 4n + 2...)  
 Leftmost register address (For word-length access, column 1 of the register becomes the MSB of the data.)

Note : The initial value of bits in a register are indicated as follows :

“1” : Initial value “1”

“0” : Initial value “0”

“X” : Initial value “X”

“-” : A physical register does not exist at the location.

# MB91305

Address	Register				Block
	+0	+1	+2	+3	
000000 <sub>H</sub> to 00000F <sub>H</sub>	—	—	—	—	Reserved
000010 <sub>H</sub>	PDR0[R/W] XXXXXXXX	PDR1[R/W] XXXXXXXX	PDR2[R/W] XXXXXXXX	PDR3[R/W] XXXXXXXX	R-bus Port Data Register
000014 <sub>H</sub>	PDR4[R/W] XXXXXXXX	PDR5[R/W] XXXXXXXX	PDR6[R/W] --XXXXXX	PDR7[R/W] --XXXXXX	
000018 <sub>H</sub>	PDR8[R/W] XXXXXXXX	PDR9[R/W] XXXXXXXX	PDRA[R/W] ----XXX	PDRB[R/W] XXXXXXXX	
00001C <sub>H</sub>	PDRC[R/W] XXXXXXXX	PDRD[R/W] --XXXXXX	PDRE[R/W] ----XXX	PDRF[R/W] XXXXXXXX	
000020 <sub>H</sub>	ADCTH[R/W] XXXXXXXX00	ADCTL[R/W] 00000X00	ADCH[R/W] 00000000 00000000		10-bit A/D converter
000024 <sub>H</sub>	ADAT0[R] XXXXXXXX00 00000000		ADAT1[R] XXXXXXXX00 00000000		
000028 <sub>H</sub>	ADAT2[R] XXXXXXXX00 00000000		ADAT3[R] XXXXXXXX00 00000000		
00002C <sub>H</sub>	ADAT4[R] XXXXXXXX00 00000000		ADAT5[R] XXXXXXXX00 00000000		
000030 <sub>H</sub>	ADAT6[R] XXXXXXXX00 00000000		ADAT7[R] XXXXXXXX00 00000000		
000034 <sub>H</sub>	ADAT8[R] XXXXXXXX00 00000000		ADAT9[R] XXXXXXXX00 00000000		
000038 <sub>H</sub>	TEST [R/W] 00000000	—	—	—	
00003C <sub>H</sub>	—	—	—	—	
000040 <sub>H</sub>	HEIRR0 [R/W] 00000000	ENIR0 [R/W] 00000000	ELVR0 [R/W] 00000000		External interrupt
000044 <sub>H</sub>	DICR [R/W] -----0	HRCL [R/W] 0--11111	—		DLYI/I-unit
000048 <sub>H</sub>	TMRLR0 [W] XXXXXXXXXX XXXXXXXXX		TMR0 [R] XXXXXXXXXX XXXXXXXXX		16-bit Reload Timer 0
00004C <sub>H</sub>	—		TMCSR0 [R/W] ---0000 00000000		
000050 <sub>H</sub>	TMRLR1 [W] XXXXXXXXXX XXXXXXXXX		TMR1 [R] XXXXXXXXXX XXXXXXXXX		16-bit Reload Timer 1
000054 <sub>H</sub>	—		TMCSR1 [R/W] ---0000 00000000		

(Continued)

Address	Register				Block
	+0	+1	+2	+3	
000058 <sub>H</sub>	TMRLR2 [W] XXXXXXXX XXXXXXXX		TMR2 [R] XXXXXXXX XXXXXXXX		16-bit Reload Timer 2
00005C <sub>H</sub>	—		TMCSR2 [R/W] ----0000 00000000		
000060 <sub>H</sub>	SSR0 [R/W] 00001000	SIDR0 [R]/ SODR0 [W] XXXXXXXX	SCR0 [R/W] 00000100	SMR0 [R/W] 00--0-0-	UART0
000064 <sub>H</sub>	UTIM0 [R] (UTIMR0 [W]) 00000000 00000000		DRCL0 [W] -----	UTIMC0 [R/W] 0--00001	U-TIMER 0
000068 <sub>H</sub>	SSR1 [R/W] 00001000	SIDR1 [R]/ SODR1 [W] XXXXXXXX	SCR1 [R/W] 00000100	SMR1 [R/W] 00--0-0-	UART1
00006C <sub>H</sub>	UTIM1 [R] (UTIMR1 [W]) 00000000 00000000		DRCL1 [W] -----	UTIMC1 [R/W] 0--00001	U-TIMER 1
000070 <sub>H</sub>	SSR2 [R/W] 00001000	SIDR2 [R]/ SODR2 [W] XXXXXXXX	SCR2 [R/W] 00000100	SMR2 [R/W] 00--0-0-	UART2
000074 <sub>H</sub>	UTIM2 [R] (UTIMR2 [W]) 00000000 00000000		DRCL2 [W] -----	UTIMC2 [R/W] 0--00001	U-TIMER 2
000078 <sub>H</sub>	SSR3 [R/W] 00001000	SIDR3 [R]/ SODR3 [W] XXXXXXXX	SCR3 [R/W] 00000100	SMR3 [R/W] 00--0-0-	UART3
00007C <sub>H</sub>	UTIM3 [R] (UTIMR3 [W]) 00000000 00000000		DRCL3 [W] -----	UTIMC3 [R/W] 0--00001	U-TIMER 3
000080 <sub>H</sub>	SSR4 [R/W] 00001000	SIDR4 [R]/ SODR4 [W] XXXXXXXX	SCR4 [R/W] 00000100	SMR4 [R/W] 00--0-0-	UART4
000084 <sub>H</sub>	UTIM4 [R] (UTIMR4 [W]) 00000000 00000000		DRCL4 [W] -----	UTIMC4 [R/W] 0--00001	U-TIMER 4
000088 <sub>H</sub>	—		—		Reserved
00008C <sub>H</sub>	—		—		
000090 <sub>H</sub>	PWCCL[R/W] 0000--00	PWCCH[R/W] 00-00000	—		PWC
000094 <sub>H</sub>	PWCD[R] XXXXXXXX XXXXXXXX		—		
000098 <sub>H</sub>	PWCC2[R/W] 000-----	Reserved	—		
00009C <sub>H</sub>	PWCUD[R] XXXXXXXX XXXXXXXX		—		

(Continued)

# MB91305

Address	Register				Block
	+0	+1	+2	+3	
0000A0 <sub>H</sub>	—		—		Reserved
0000A4 <sub>H</sub>	—		—		
0000A8 <sub>H</sub>	—		—		
0000AC <sub>H</sub>	—		—		
0000B0 <sub>H</sub>	IFN0 [R] 00000000	IFRN0 [R/W] 00000000	IFCR0 [R/W] 00-00000	IFDR0 [R/W] 00000000	I <sup>2</sup> C interface ch.0
0000B4 <sub>H</sub>	IBCR0 [R/W] 00000000	IBSR0 [R] 00000000	ITBA0 [R, R/W] 00000000 00000000		
0000B8 <sub>H</sub>	ITMK0 [R/W] 00111111 11111111		ISMK0 [R/W] 01111111	ISBA0 [R/W] 00000000	
0000BC <sub>H</sub>	—	IDAR0 [R/W] 00000000	ICCR0 [R/W] 00011111	—	
0000C0 <sub>H</sub>	IFN1 [R] 00000000	IFRN1 [R/W] 00000000	IFCR1 [R/W] 00-00000	IFDR1 [R/W] 00000000	I <sup>2</sup> C interface ch.1
0000C4 <sub>H</sub>	IBCR1 [R/W] 00000000	IBSR1 [R] 00000000	ITBA1 [R, R/W] 00000000 00000000		
0000C8 <sub>H</sub>	ITMK1 [R/W] 00111111 11111111		ISMK1 [R/W] 01111111	ISBA1 [R/W] 00000000	
0000CC <sub>H</sub>	—	IDAR1 [R/W] 00000000	ICCR1 [R/W] 00011111	—	
0000D0 <sub>H</sub>	IFN2 [R] 00000000	IFRN2 [R/W] 00000000	IFCR2 [R/W] 00-00000	IFDR2 [R/W] 00000000	I <sup>2</sup> C interface ch.2
0000D4 <sub>H</sub>	IBCR2 [R/W] 00000000	IBSR2 [R] 00000000	ITBA2 [R, R/W] 00000000 00000000		
0000D8 <sub>H</sub>	ITMK2 [R/W] 00111111 11111111		ISMK2 [R/W] 01111111	ISBA2 [R/W] 00000000	
0000DC <sub>H</sub>	—	IDA2R [R/W] 00000000	ICCR2 [R/W] 00011111	—	
0000E0 <sub>H</sub>	IFN3 [R] 00000000	IFRN3 [R/W] 00000000	IFCR3 [R/W] 00-00000	IFDR3 [R/W] 00000000	I <sup>2</sup> C interface ch.3
0000E4 <sub>H</sub>	IBCR3 [R/W] 00000000	IBSR3 [R] 00000000	ITBA3 [R, R/W] 00000000 00000000		
0000E8 <sub>H</sub>	ITMK3 [R/W] 00111111 11111111		ISMK3 [R/W] 01111111	ISBA3 [R/W] 00000000	
0000EC <sub>H</sub>	—	IDAR3 [R/W] 00000000	ICCR3 [R/W] 00011111	—	
0000F0 <sub>H</sub>	—	—	—	—	Reserved
0000F4 <sub>H</sub>	TCDT [R/W] 00000000 00000000		—	TCCS [R/W] 00000000	16-bit free-run timer

(Continued)

Address	Register				Block
	+0	+1	+2	+3	
0000F8 <sub>H</sub>	IPCP1 [R] XXXXXXXX XXXXXXXX		IPCP0 [R] XXXXXXXX XXXXXXXX		16-bit input capture
0000FC <sub>H</sub>	IPCP3 [R] XXXXXXXX XXXXXXXX		IPCP2 [R] XXXXXXXX XXXXXXXX		
000100 <sub>H</sub>	—	ICS23 [R/W] 00000000	—	ICS01 [R/W] 00000000	Reserved
000104 <sub>H</sub>	—	—	—	—	
000108 <sub>H</sub>	—	—	—	—	
00010C <sub>H</sub>	—	—	—	—	
000110 <sub>H</sub>	EIRR1 [R/W] 00000000	ENIR1 [R/W] 00000000	ELVR1 [R/W] 00000000 00000000		External interrupt
000114 <sub>H</sub> to 00011F <sub>H</sub>	—		—		Reserved
000120 <sub>H</sub>	PTMR0 [R] 11111111 11111111		PCSR0 [W] XXXXXXXX XXXXXXXX		PPG0
000124 <sub>H</sub>	PDUT0 [W] XXXXXXXX XXXXXXXX		PCNH0 [R/W] 00000000	PCNL0 [R/W] 00000000	
000128 <sub>H</sub>	PTMR1 [R] 11111111 11111111		PCSR1 [W] XXXXXXXX XXXXXXXX		PPG1
00012C <sub>H</sub>	PDUT1 [W] XXXXXXXX XXXXXXXX		PCNH1 [R/W] 00000000	PCNL1 [R/W] 00000000	
000130 <sub>H</sub>	PTMR2 [R] 11111111 11111111		PCSR2 [W] XXXXXXXX XXXXXXXX		PPG2
000134 <sub>H</sub>	PDUT2 [W] XXXXXXXX XXXXXXXX		PCNH2 [R/W] 00000000	PCNL2 [R/W] 00000000	
000138 <sub>H</sub>	PTMR3 [R] 11111111 11111111		PCSR3[W] XXXXXXXX XXXXXXXX		PPG3
00013C <sub>H</sub>	PDUT3 [W] XXXXXXXX XXXXXXXX		PCNH3 [R/W] 00000000	PCNL3 [R/W] 00000000	
000140 <sub>H</sub> to 0001FC <sub>H</sub>	—				Reserved
000200 <sub>H</sub>	DMACA0 [R/W] 00000000 0000XXXX XXXXXXXX XXXXXXXX				DMAC
000204 <sub>H</sub>	DMACB0 [R/W] 00000000 00000000 00000000 00000000				

(Continued)

# MB91305

Address	Register				Block
	+0	+1	+2	+3	
000208 <sub>H</sub>	DMACA1 [R/W] 00000000 0000XXXX XXXXXXXX XXXXXXXX				DMAC
00020C <sub>H</sub>	DMACB1 [R/W] 00000000 00000000 00000000 00000000				
000210 <sub>H</sub>	DMACA2 [R/W] 00000000 0000XXXX XXXXXXXX XXXXXXXX				
000214 <sub>H</sub>	DMACB2 [R/W] 00000000 00000000 00000000 00000000				
000218 <sub>H</sub>	DMACA3 [R/W] 00000000 0000XXXX XXXXXXXX XXXXXXXX				
00021C <sub>H</sub>	DMACB3 [R/W] 00000000 00000000 00000000 00000000				
000220 <sub>H</sub>	DMACA4 [R/W] 00000000 0000XXXX XXXXXXXX XXXXXXXX				
000224 <sub>H</sub>	DMACB4 [R/W] 00000000 00000000 00000000 00000000				
000228 <sub>H</sub>	—				
00022C <sub>H</sub> to 00023C <sub>H</sub>	—				
000240 <sub>H</sub>	DMACR [R/W] 0XX00000 XXXXXXXX XXXXXXXX XXXXXXXX				
000244 <sub>H</sub> to 0002FC <sub>H</sub>	—				Reserved
000304 <sub>H</sub>	—	—	—	ISIZE[R/W] -----10	I-Cache
000308 <sub>H</sub> to 0003E0 <sub>H</sub>	—	—	—	—	Reserved
0003E4 <sub>H</sub>	—	—	—	ICHCR[R/W] 0-000000	I-Cache
0003E8 <sub>H</sub> to 0003EC <sub>H</sub>	—	—	—	—	Reserved

(Continued)



Address	Register				Block
	+0	+1	+2	+3	
0003F0 <sub>H</sub>	BSD0 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				Bit Search Module
0003F4 <sub>H</sub>	BSD1 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
0003F8 <sub>H</sub>	BSDC [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
0003FC <sub>H</sub>	BSRR [R] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000400 <sub>H</sub>	—	—	DDR2 [R/W] 00000000	DDR3 [R/W] ---0000	R-bus Port Direction Register
000404 <sub>H</sub>	DDR4 [R/W] 00000000	DDR5 [R/W] 00000000	DDR6 [R/W] --000000	DDR7 [R/W] --000000	
000408 <sub>H</sub>	DDR8 [R/W] ---00000	DDR9 [R/W] 00000000	DDRA [R/W] 00000000	DDRB [R/W] 00000000	
00040C <sub>H</sub>	DDRC [R/W] 00000000	DDRD [R/W] --000000	DDRE [R/W] -----00	DDRF [R/W] 00000000	
000410 <sub>H</sub>	PFR0 [R/W] 0--00000	PFR1 [R/W] 00000000	PFR2 [R/W] 000---00	PFR3 [R/W] ---0000	R-bus Port Function Register
000414 <sub>H</sub>	PFR4 [R/W] ----000	PFR5 [R/W] 11111111	PFR6 [R/W] 00000000	PFR7 [R/W] ----000	
000418 <sub>H</sub>	—	PFR9 [R/W] 11111111	—	PFRB [R/W] 00011-0-	
00041C <sub>H</sub>	PFRC [R/W] 1111--11	PFRD [R/W] ---101--	PCRA [R/W] 00000000	PCRB [R/W] 00000000	
000420 <sub>H</sub> to 00043C <sub>H</sub>	—				Reserved
000440 <sub>H</sub>	ICR00 [R/W] ---11111	ICR01 [R/W] ---11111	ICR02 [R/W] ---11111	ICR03 [R/W] ---11111	Interrupt Controller
000444 <sub>H</sub>	ICR04 [R/W] ---11111	ICR05 [R/W] ---11111	ICR06 [R/W] ---11111	ICR07 [R/W] ---11111	
000448 <sub>H</sub>	ICR08 [R/W] ---11111	ICR09 [R/W] ---11111	ICR10 [R/W] ---11111	ICR11 [R/W] ---11111	
00044C <sub>H</sub>	ICR12 [R/W] ---11111	ICR13 [R/W] ---11111	ICR14 [R/W] ---11111	ICR15 [R/W] ---11111	
000450 <sub>H</sub>	ICR16 [R/W] ---11111	ICR17 [R/W] ---11111	ICR18 [R/W] ---11111	ICR19 [R/W] ---11111	
000454 <sub>H</sub>	ICR20 [R/W] ---11111	ICR21 [R/W] ---11111	ICR22 [R/W] ---11111	ICR23 [R/W] ---11111	
000458 <sub>H</sub>	ICR24 [R/W] ---11111	ICR25 [R/W] ---11111	ICR26 [R/W] ---11111	ICR27 [R/W] ---11111	

(Continued)

# MB91305

Address	Register				Block
	+0	+1	+2	+3	
00045C <sub>H</sub>	ICR28 [R/W] ---11111	ICR29 [R/W] ---11111	ICR30 [R/W] ---11111	ICR31 [R/W] ---11111	Interrupt Controller
000460 <sub>H</sub>	ICR32 [R/W] ---11111	ICR33 [R/W] ---11111	ICR34 [R/W] ---11111	ICR35 [R/W] ---11111	
000464 <sub>H</sub>	ICR36 [R/W] ---11111	ICR37 [R/W] ---11111	ICR38 [R/W] ---11111	ICR39 [R/W] ---11111	
000468 <sub>H</sub>	ICR40 [R/W] ---11111	ICR41 [R/W] ---11111	ICR42 [R/W] ---11111	ICR43 [R/W] ---11111	
00046C <sub>H</sub>	ICR44 [R/W] ---11111	ICR45 [R/W] ---11111	ICR46 [R/W] ---11111	ICR47 [R/W] ---11111	
000470 <sub>H</sub> to 00047C <sub>H</sub>	—				Reserved
000480 <sub>H</sub>	RSRR [R/W] 10000000 * <sup>2</sup>	STCR [R/W] 00110011 * <sup>2</sup>	TBCR [R/W] 00XXXX00 * <sup>1</sup>	CTBR [W] XXXXXXXX	Clock Control
000484 <sub>H</sub>	CLKR [R/W] 00000000 * <sup>1</sup>	WPR [W] XXXXXXXX	DIVR0 [R/W] 00000011 * <sup>1</sup>	DIVR1[R/W] 00000000 * <sup>1</sup>	
000488 <sub>H</sub>	—	—	—	—	Reserved
00048C <sub>H</sub>	—	—	—	—	
000490 <sub>H</sub>	—	—	—	—	
000494 <sub>H</sub> to 0005FC <sub>H</sub>	—				
000600 <sub>H</sub> to 00063F <sub>H</sub>	—				
000640 <sub>H</sub>	ASR0 [R/W] 00000000 00000000 * <sup>1</sup>		ACR0 [R/W] 1111XX00 00000000 * <sup>1</sup>		T-unit
000644 <sub>H</sub>	ASR1 [R/W] XXXXXXXX XXXXXXXX * <sup>1</sup>		ACR1 [R/W] XXXXXXXX XXXXXXXX * <sup>1</sup>		
000648 <sub>H</sub>	ASR2 [R/W] XXXXXXXX XXXXXXXX * <sup>1</sup>		ACR2 [R/W] XXXXXXXX XXXXXXXX * <sup>1</sup>		
00064C <sub>H</sub>	ASR3 [R/W] XXXXXXXX XXXXXXXX * <sup>1</sup>		ACR3 [R/W] XXXXXXXX XXXXXXXX * <sup>1</sup>		
000650 <sub>H</sub>	ASR4 [R/W] XXXXXXXX XXXXXXXX * <sup>1</sup>		ACR4 [R/W] XXXXXXXX XXXXXXXX * <sup>1</sup>		
000654 <sub>H</sub>	ASR5 [R/W] XXXXXXXX XXXXXXXX * <sup>1</sup>		ACR5 [R/W] XXXXXXXX XXXXXXXX * <sup>1</sup>		
000658 <sub>H</sub>	ASR6 [R/W] XXXXXXXX XXXXXXXX * <sup>1</sup>		ACR6 [R/W] XXXXXXXX XXXXXXXX * <sup>1</sup>		

(Continued)

Address	Register				Block	
	+0	+1	+2	+3		
00065C <sub>H</sub>	ASR7 [R/W] XXXXXXXX XXXXXXXX *1		ACR7 [R/W] XXXXXXXX XXXXXXXX *1		T-unit	
000660 <sub>H</sub>	AWR0 [R/W] 01111111 11111111 *1		AWR1 [R/W] XXXXXXXX XXXXXXXX *1			
000664 <sub>H</sub>	AWR2 [R/W] XXXXXXXX XXXXXXXX *1		AWR3 [R/W] XXXXXXXX XXXXXXXX *1			
000668 <sub>H</sub>	AWR4 [R/W] XXXXXXXX XXXXXXXX *1		AWR5 [R/W] XXXXXXXX XXXXXXXX *1			
00066C <sub>H</sub>	AWR6 [R/W] XXXXXXXX XXXXXXXX *1		AWR7 [R/W] XXXXXXXX XXXXXXXX *1			
000670 <sub>H</sub>	MCRA [R/W] XXXXXXXX	MCRB [R/W] XXXXXXXX	—	—		
000674 <sub>H</sub>	—					
000678 <sub>H</sub>	IOWR0 [R/W] XXXXXXXX	IOWR1 [R/W] XXXXXXXX	IOWR2 [R/W] XXXXXXXX	—		
00067C <sub>H</sub>	—					
000680 <sub>H</sub>	CSER [R/W] 00000001	CHER [R/W] 11111111	—	TCR [R/W] 00000000		
000684 <sub>H</sub>	RCR [R/W] 00XXXXXXXX XXXX0XXX		—	—		
000688 <sub>H</sub> to 0007F8 <sub>H</sub>	—					Reserved
0007FC <sub>H</sub>	—	MODR [W] XXXXXXXX	—	—		—
000800 <sub>H</sub> to 000AFC <sub>H</sub>	—					Reserved
000B00 <sub>H</sub>	ESTS0 [R/W] X0000000	ESTS1 [R/W] XXXXXXXX	ESTS2 [R] 1XXXXXXXX	—	DSU	
000B04 <sub>H</sub>	ECTL0 [R/W] 0X000000	ECTL1 [R/W] 00000000	ECTL2 [W] 000X0000	ECTL3 [R/W] 00X00X11		
000B08 <sub>H</sub>	ECNT0 [W] XXXXXXXX	ECNT1 [W] XXXXXXXX	EUSA [W] XXX00000	EDTC [W] 0000XXXX		
000B0C <sub>H</sub>	EWP1 [R] 00000000 00000000		—			
000B10 <sub>H</sub>	EDTR0 [W] XXXXXXXX XXXXXXXX		EDTR1 [W] XXXXXXXX XXXXXXXX			

(Continued)

# MB91305

Address	Register				Block
	+0	+1	+2	+3	
000B14H to 000B1CH	—				DSU
000B20H	EIA0 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B24H	EIA1 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B28H	EIA2 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B2CH	EIA3 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B30H	EIA4 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B34H	EIA5 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B38H	EIA6 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B3CH	EIA7 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B40H	EDTA [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B44H	EDTM [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B48H	EOA0 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B4CH	EOA1 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B50H	EPCR [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B54H	EPSR [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B58H	EIAM0 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B5CH	EIAM1 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B60H	EOAM0/EODM0 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				
000B64H	EOAM1/EODM1 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				

(Continued)

(Continued)

Address	Register				Block	
	+0	+1	+2	+3		
000B68 <sub>H</sub>	EOD0 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				DSU	
000B6C <sub>H</sub>	EOD1 [W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX					
000B70 <sub>H</sub> to 000FFC <sub>H</sub>	—				Reserved	
001000 <sub>H</sub>	DMASA0 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX				DMAC	
001004 <sub>H</sub>	DMADA0 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX					
001008 <sub>H</sub>	DMASA1 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX					
00100C <sub>H</sub>	DMADA1 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX					
001010 <sub>H</sub>	DMASA2 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX					
001014 <sub>H</sub>	DMADA2 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX					
001018 <sub>H</sub>	DMASA3 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX					
00101C <sub>H</sub>	DMADA3 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX					
001020 <sub>H</sub>	DMASA4 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX					
001024 <sub>H</sub>	DMADA4 [R/W] XXXXXXXX XXXXXXXX XXXXXXXX XXXXXXXX					
001028 <sub>H</sub> to 007104 <sub>H</sub>	—					Reserved

\*1 : Register whose initial value depends on the reset level. The registers at the INIT level are indicated.

\*2 : Register whose initial value depends on the reset level. The registers at the INIT level due to the  $\overline{\text{INIT}}$  pin are indicated.

# MB91305

Address	Register				Block
	+0	+1	+2	+3	
00060000 <sub>H</sub>	FIFO0o [R] XXXXXXXX XXXXXXXX		FIFO0i [W] XXXXXXXX XXXXXXXX		USB Function
00060004 <sub>H</sub>	FIFO1 [R] XXXXXXXX XXXXXXXX		FIFO2 [W] XXXXXXXX XXXXXXXX		
00060008 <sub>H</sub>	FIFO3 [R] XXXXXXXX XXXXXXXX		—		
0006000C <sub>H</sub> to 0006001F <sub>H</sub>	—				
00060020 <sub>H</sub>	—		CONT1 [R/W] 000XX0XX XXX00000		
00060024 <sub>H</sub>	CONT2 [R/W] XXXXXXXX XXX00000		CONT3 [R/W] XXXXXXXX XXX00000		
00060028 <sub>H</sub>	CONT4 [R/W] XXXXXXXX XXX00000		CONT5 [R/W] XXXXXXXX XXXX00XX		
0006002C <sub>H</sub>	CONT6 [R/W] XXXXXXXX XXXX00XX		CONT7 [R/W] XXXXXXXX XXX00000		
00060030 <sub>H</sub>	CONT8 [R/W] XXXXXXXX XXX00000		CONT9 [R/W] 0XX0XXX 0XXX0000		
00060034 <sub>H</sub>	CONT10 [R/W] 00000000 X00000XX		TTSIZE [R/W] 00010001 00010001		
00060038 <sub>H</sub>	TRSIZE [R/W] 00010001 00010001		—		
0006003C <sub>H</sub>	—				
00060040 <sub>H</sub>	RSIZE0 [R] XXXXXXXX XXXX0000		—		
00060044 <sub>H</sub>	RSIZE1 [R] XXXXXXXX X0000000		—		
00060048 <sub>H</sub> to 0006005F <sub>H</sub>	—				
00060060 <sub>H</sub>	—		ST1 [R/W] XXXXXX00 00000000		
00060064 <sub>H</sub>	—				
00060068 <sub>H</sub>	ST2 [R] XXXXXXXX XXX00000		ST3 [R/W] XXXXXXXX XXX00000		
0006006C <sub>H</sub>	ST4 [R/W] XXXXX000 00000000		ST5 [R/W] XXXX0XXX XX000000		

(Continued)

(Continued)

Address	Register				Block
	+0	+1	+2	+3	
00060070 <sub>H</sub> to 0006007F <sub>H</sub>	—				USB Function
00060080 <sub>H</sub> to 0006FFFB <sub>H</sub>	—				Reserved
0006FFFC <sub>H</sub>	—	—	USBRST -0-----	—	USB reset

## ■ INTERRUPT SOURCE TABLE

Interrupt source	Interrupt number		Interrupt level	Offset	Address of TBR default	Resource number
	Decimal	Hexa-decimal				
Reset	0	00	—	3FC <sub>H</sub>	000FFFFC <sub>H</sub>	—
Mode vector	1	01	—	3F8 <sub>H</sub>	000FFFF8 <sub>H</sub>	—
Reserved for system	2	02	—	3F4 <sub>H</sub>	000FFFF4 <sub>H</sub>	—
Reserved for system	3	03	—	3F0 <sub>H</sub>	000FFFF0 <sub>H</sub>	—
Reserved for system	4	04	—	3EC <sub>H</sub>	000FFFE <sub>C</sub>	—
Reserved for system	5	05	—	3E8 <sub>H</sub>	000FFFE8 <sub>H</sub>	—
Reserved for system	6	06	—	3E4 <sub>H</sub>	000FFFE4 <sub>H</sub>	—
No-coprocessor trap	7	07	—	3E0 <sub>H</sub>	000FFFE0 <sub>H</sub>	—
Coprocessor error trap	8	08	—	3DC <sub>H</sub>	000FFFD <sub>C</sub>	—
INTE instruction	9	09	—	3D8 <sub>H</sub>	000FFFD8 <sub>H</sub>	—
Instruction break exception	10	0A	—	3D4 <sub>H</sub>	000FFFD4 <sub>H</sub>	—
Operand break trap	11	0B	—	3D0 <sub>H</sub>	000FFFD0 <sub>H</sub>	—
Step trace trap	12	0C	—	3CC <sub>H</sub>	000FFFC <sub>C</sub>	—
NMI request (tool)	13	0D	—	3C8 <sub>H</sub>	000FFFC8 <sub>H</sub>	—
Undefined instruction exception	14	0E	—	3C4 <sub>H</sub>	000FFFC4 <sub>H</sub>	—
NMI request	15	0F	15 (F <sub>H</sub> ) fixed	3C0 <sub>H</sub>	000FFFC0 <sub>H</sub>	—
External interrupt 0	16	10	ICR00	3BC <sub>H</sub>	000FFFB <sub>C</sub>	—
External interrupt 1	17	11	ICR01	3B8 <sub>H</sub>	000FFFB8 <sub>H</sub>	—
External interrupt 2	18	12	ICR02	3B4 <sub>H</sub>	000FFFB4 <sub>H</sub>	—
External interrupt 3	19	13	ICR03	3B0 <sub>H</sub>	000FFFB0 <sub>H</sub>	—
External interrupt 4 (USB-function)	20	14	ICR04	3AC <sub>H</sub>	000FFFA <sub>C</sub>	—
External interrupt 5	21	15	ICR05	3A8 <sub>H</sub>	000FFFA8 <sub>H</sub>	—
External interrupt 6	22	16	ICR06	3A4 <sub>H</sub>	000FFFA4 <sub>H</sub>	—
External interrupt 7	23	17	ICR07	3A0 <sub>H</sub>	000FFFA0 <sub>H</sub>	—
Reload timer 0	24	18	ICR08	39C <sub>H</sub>	000FFF9 <sub>C</sub>	8
Reload timer 1	25	19	ICR09	398 <sub>H</sub>	000FFF98 <sub>H</sub>	9
Reload timer 2	26	1A	ICR10	394 <sub>H</sub>	000FFF94 <sub>H</sub>	10
UART0 (Reception completed)	27	1B	ICR11	390 <sub>H</sub>	000FFF90 <sub>H</sub>	0
UART1 (Reception completed)	28	1C	ICR12	38C <sub>H</sub>	000FFF8 <sub>C</sub>	1
UART2 (Reception completed)	29	1D	ICR13	388 <sub>H</sub>	000FFF88 <sub>H</sub>	2
UART0 (Transmission completed)	30	1E	ICR14	384 <sub>H</sub>	000FFF84 <sub>H</sub>	3
UART1 (Transmission completed)	31	1F	ICR15	380 <sub>H</sub>	000FFF80 <sub>H</sub>	4

(Continued)



Interrupt source	Interrupt number		Interrupt level	Offset	Address of TBR default	Resource number
	Decimal	Hexa-decimal				
UART2 (Transmission completed)	32	20	ICR16	37C <sub>H</sub>	000FFF7C <sub>H</sub>	5
DMAC0 (end or error)	33	21	ICR17	378 <sub>H</sub>	000FFF78 <sub>H</sub>	—
DMAC1 (end or error)	34	22	ICR18	374 <sub>H</sub>	000FFF74 <sub>H</sub>	—
DMAC2 (end or error)	35	23	ICR19	370 <sub>H</sub>	000FFF70 <sub>H</sub>	—
DMAC3 (end or error)	36	24	ICR20	36C <sub>H</sub>	000FFF6C <sub>H</sub>	—
DMAC4 (end or error)	37	25	ICR21	368 <sub>H</sub>	000FFF68 <sub>H</sub>	—
A/D	38	26	ICR22	364 <sub>H</sub>	000FFF64 <sub>H</sub>	—
PPG0	39	27	ICR23	360 <sub>H</sub>	000FFF60 <sub>H</sub>	—
PPG1	40	28	ICR24	35C <sub>H</sub>	000FFF5C <sub>H</sub>	—
PPG2	41	29	ICR25	358 <sub>H</sub>	000FFF58 <sub>H</sub>	—
PPG3	42	2A	ICR26	354 <sub>H</sub>	000FFF54 <sub>H</sub>	—
PWC	43	2B	ICR27	350 <sub>H</sub>	000FFF50 <sub>H</sub>	—
External interrupt 8/U-TIMER0	44	2C	ICR28	34C <sub>H</sub>	000FFF4C <sub>H</sub>	—
External interrupt 9/U-TIMER1	45	2D	ICR29	348 <sub>H</sub>	000FFF48 <sub>H</sub>	—
External interrupt 10/U-TIMER2	46	2E	ICR30	344 <sub>H</sub>	000FFF44 <sub>H</sub>	—
Timebase timer overflow / U-TIMER3	47	2F	ICR31	340 <sub>H</sub>	000FFF40 <sub>H</sub>	—
External interrupt 11/U-TIMER4	48	30	ICR32	33C <sub>H</sub>	000FFF3C <sub>H</sub>	—
16-bit free-run timer	49	31	ICR33	338 <sub>H</sub>	000FFF38 <sub>H</sub>	—
I <sup>2</sup> C ch.0	50	32	ICR34	334 <sub>H</sub>	000FFF34 <sub>H</sub>	—
I <sup>2</sup> C ch.1	51	33	ICR35	330 <sub>H</sub>	000FFF30 <sub>H</sub>	—
I <sup>2</sup> C ch.2	52	34	ICR36	32C <sub>H</sub>	000FFF2C <sub>H</sub>	—
I <sup>2</sup> C ch.3	53	35	ICR37	328 <sub>H</sub>	000FFF28 <sub>H</sub>	—
UART3 (Reception completed)	54	36	ICR38	324 <sub>H</sub>	000FFF24 <sub>H</sub>	—
UART4 (Reception completed)	55	37	ICR39	320 <sub>H</sub>	000FFF20 <sub>H</sub>	—
UART3 (Transmission completed)	56	38	ICR40	31C <sub>H</sub>	000FFF1C <sub>H</sub>	—
UART4 (Transmission completed)	57	39	ICR41	318 <sub>H</sub>	000FFF18 <sub>H</sub>	—
External interrupt 12/Input capture 0	58	3A	ICR42	314 <sub>H</sub>	000FFF14 <sub>H</sub>	—
External interrupt 13/Input capture 1	59	3B	ICR43	310 <sub>H</sub>	000FFF10 <sub>H</sub>	—
External interrupt 14/Input capture 2	60	3C	ICR44	30C <sub>H</sub>	000FFF0C <sub>H</sub>	—
External interrupt 15/Input capture 3	61	3D	ICR45	308 <sub>H</sub>	000FFF08 <sub>H</sub>	—
Reserved for system	62	3E	ICR46	304 <sub>H</sub>	000FFF04 <sub>H</sub>	—
Delayed interrupt source bit	63	3F	ICR47	300 <sub>H</sub>	000FFF00 <sub>H</sub>	—

(Continued)

# MB91305

(Continued)

Interrupt source	Interrupt number		Interrupt level	Offset	Address of TBR default	Resource number
	Decimal	Hexa-decimal				
Reserved for system (used by REALOS)	64	40	—	2FC <sub>H</sub>	000FFEFC <sub>H</sub>	—
Reserved for system (used by REALOS)	65	41	—	2F8 <sub>H</sub>	000FFE8 <sub>H</sub>	—
Reserved for system	66	42	—	2F4 <sub>H</sub>	000FFE4 <sub>H</sub>	—
Reserved for system	67	43	—	2F0 <sub>H</sub>	000FEF0 <sub>H</sub>	—
Reserved for system	68	44	-	2EC <sub>H</sub>	000FEEC <sub>H</sub>	—
Reserved for system	69	45	—	2E8 <sub>H</sub>	000FEE8 <sub>H</sub>	—
Reserved for system	70	46	—	2E4 <sub>H</sub>	000FEE4 <sub>H</sub>	—
Reserved for system	71	47	—	2E0 <sub>H</sub>	000FEE0 <sub>H</sub>	—
Reserved for system	72	48	—	2DC <sub>H</sub>	000FEDC <sub>H</sub>	—
Reserved for system	73	49	—	2D8 <sub>H</sub>	000FED8 <sub>H</sub>	—
Reserved for system	74	4A	—	2D4 <sub>H</sub>	000FED4 <sub>H</sub>	—
Reserved for system	75	4B	—	2D0 <sub>H</sub>	000FED0 <sub>H</sub>	—
Reserved for system	76	4C	—	2CC <sub>H</sub>	000FECC <sub>H</sub>	—
Reserved for system	77	4D	—	2C8 <sub>H</sub>	000FEC8 <sub>H</sub>	—
Reserved for system	78	4E	—	2C4 <sub>H</sub>	000FEC4 <sub>H</sub>	—
Reserved for system	79	4F	—	2C0 <sub>H</sub>	000FEC0 <sub>H</sub>	—
Used in INT instruction	80 to 255	50 to FF	—	2BC <sub>H</sub> to 000 <sub>H</sub>	000FEBC <sub>H</sub> to 000FC00 <sub>H</sub>	—

## ■ ELECTRICAL CHARACTERISTICS

### 1. Absolute Maximum Rating

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1	V <sub>DDE</sub>	V <sub>SS</sub> - 0.5	V <sub>SS</sub> + 4.0	V	*2
Power supply voltage (Internal) *1	V <sub>DDI</sub>	V <sub>SS</sub> - 0.5	V <sub>SS</sub> + 2.2	V	*2
Analog power supply voltage*1	AV <sub>CC</sub>	V <sub>SS</sub> - 0.5	V <sub>SS</sub> + 4.0	V	*3
Analog reference voltage*1	AV <sub>RH</sub>	V <sub>SS</sub> - 0.5	V <sub>SS</sub> + 4.0	V	*3
Input voltage*1	V <sub>I</sub>	V <sub>SS</sub> - 0.3	V <sub>DDE</sub> + 0.3	V	
Analog pin input voltage*1	V <sub>IA</sub>	V <sub>SS</sub> - 0.3	AV <sub>CC</sub> + 0.3	V	
Output voltage*1	V <sub>O</sub>	V <sub>SS</sub> - 0.3	AV <sub>CC</sub> + 0.3	V	
“L” level maximum output current	I <sub>OL</sub>	—	10	mA	*4
“L” level average output current	I <sub>OLAV</sub>	—	4	mA	*5
“L” level total maximum output current	ΣI <sub>OL</sub>	—	100	mA	
“L” level total average output current	ΣI <sub>OLAV</sub>	—	50	mA	*6
“H” level maximum output current	I <sub>OH</sub>	—	-10	mA	*4
“H” level average output current	I <sub>OHAV</sub>	—	-4	mA	*5
“H” level total maximum output current	ΣI <sub>OH</sub>	—	-50	mA	
“H” level total average output current	ΣI <sub>OHAV</sub>	—	-20	mA	*6
Power consumption	P <sub>D</sub>	—	750	mW	
Operating temperature	T <sub>a</sub>	-10	+70	°C	
Storage temperature	T <sub>STG</sub>	—	+150	°C	

\*1 : This parameter is based on AV<sub>SS</sub> = V<sub>SS</sub> = 0.0 V.

\*2 : V<sub>DDE</sub> must not be lower than V<sub>SS</sub> - 0.3 V.

\*3 : Be careful not to exceed V<sub>DDE</sub> + 0.3 V, for example, when power is turned on.

\*4 : Maximum output current determines the peak value of any one of corresponding pins.

\*5 : Average output current is defined as the value of the average current flowing over 100 ms at any one of the corresponding pins.

\*6 : Average total output current is defined as the value of the average current flowing over 100 ms at all of the corresponding pins.

**WARNING:** Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

## 2. Recommended Operating Conditions

( $V_{SS} = AV_{SS} = 0\text{ V}$ )

Parameter	Symbol	Value		Unit	Remarks
		Min	Max		
Power supply voltage	$V_{DDE}$	3.0	3.6	V	
	$V_{DDI}$	1.65	1.95	V	
Analog power supply voltage	$AV_{CC}$	$V_{SS} - 0.3$	$V_{SS} + 3.6$	V	
Analog reference voltage	$AV_{RH}$	$AV_{SS}$	$AV_{CC}$	V	
Operating temperature	$T_a$	-10	+70	°C	

**WARNING:** The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

## 3. DC Characteristics

### (1) CPU

( $V_{DDI} = 1.8\text{ V} \pm 0.15\text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = AV_{SS} = 0\text{ V}$ ,  $T_a = -10\text{ }^\circ\text{C}$  to  $+70\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
“H” level input voltage	$V_{IH}$	D31 to D16	—	$0.7 \times V_{DDE}$	—	$V_{DDE} + 0.3$	V	
	$V_{HIS}$	Input ports except for D31 to D16	—	$0.8 \times V_{DDE}$	—	$V_{DDE} + 0.3$	V	Hysteresis input
“L” level input voltage	$V_{IL}$	D31 to D16	—	$V_{SS}$	—	$0.25 \times V_{DDE}$	V	
	$V_{ILS}$	Input ports except for D31 to D16	—	$V_{SS}$	—	$0.2 \times V_{DDE}$	V	Hysteresis input
“H” level output voltage	$V_{OH}$	All output pins	$V_{DDE} = 3.0\text{ V}$ $I_{OH} = -4.0\text{ mA}$	$V_{DDE} - 0.5$	—	$V_{DDE}$	V	
“L” level output voltage	$V_{OL}$	All output pins	$V_{DDE} = 3.0\text{ V}$ $I_{OL} = 4.0\text{ mA}$	$V_{SS}$	—	0.4	V	
Input leak current (High-Z output Leakage current)	$I_{LI}$	All input pins	$V_{DDE} = 3.6\text{ V}$ $0.45\text{ V} < V_I < V_{DDE}$	-5	—	+5	$\mu\text{A}$	
Pull-up resistance	$R_{UP}$	*1	$V_{DDE} = 3.6\text{ V}$ $V_I = 0.45\text{ V}$	12	25	100	$\text{k}\Omega$	
Pull-down resistance	$R_{DOWN}$	*2	$V_{DDE} = 3.6\text{ V}$ $V_I = 3.3\text{ V}$	12	25	100	$\text{k}\Omega$	
Power supply current	$I_{CC}$	VDDE, VDDI	$f_C = 16.5\text{ MHz}$ $V_{DDE} = 3.3\text{ V}$ $V_{DDI} = 1.8\text{ V}$	—	120	180	$\text{mA}$	(Multiply by 4) When operating at 66 MHz
	$I_{CCS}$		$f_C = 16.5\text{ MHz}$ $V_{DDE} = 3.3\text{ V}$ $V_{DDI} = 1.8\text{ V}$	—	60	90	$\text{mA}$	at sleep
	$I_{CCH}$		$T_a = +25\text{ }^\circ\text{C}$ $V_{DDE} = 3.3\text{ V}$ $V_{DDI} = 1.8\text{ V}$	—	200	1000	$\mu\text{A}$	at stop
Input capacitance	$C_{IH}$	Other than VDDE, VSS AVCC and AVSS	—	—	10	—	$\text{pF}$	

\*1 : Pins that the I/O circuit type is B and G

\*2 : Pins that the I/O circuit type is J

# MB91305

## (2) USB

### [1] DC characteristics

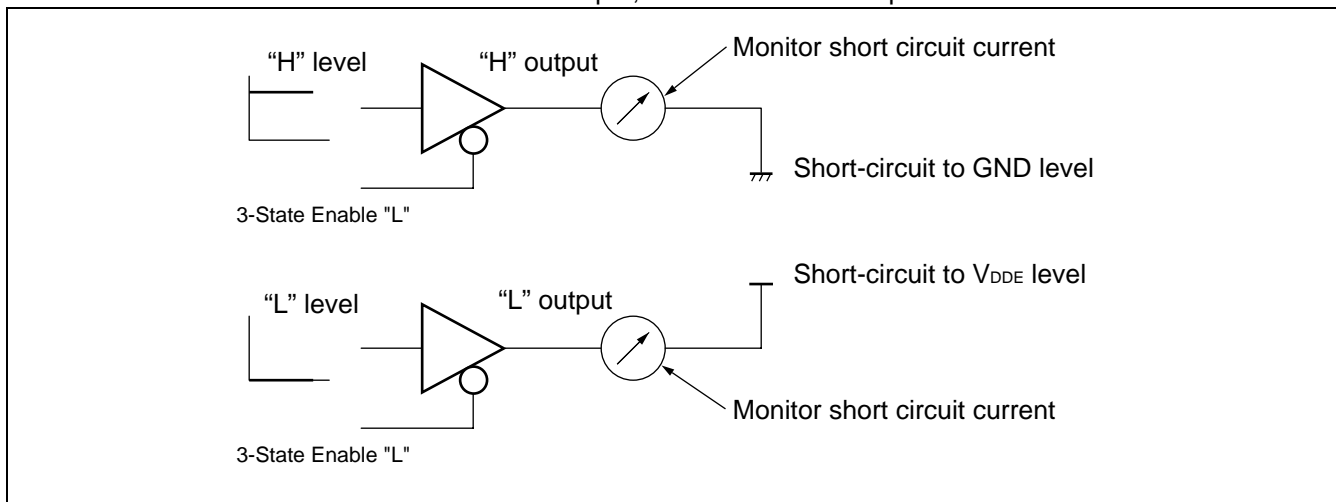
( $V_{DDI} = 1.8 \text{ V} \pm 0.15 \text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ,  $V_{SS} = AV_{SS} = 0 \text{ V}$ ,  $T_a = -10 \text{ }^\circ\text{C}$  to  $+70 \text{ }^\circ\text{C}$ )

Parameter	Sym- bol	Pin	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
"H" level output voltage	$V_{OH}$	—	$I_{OH} = -100 \mu\text{A}$	$V_{DDE} - 0.2$	—	$V_{DDE}$	V	
"L" level output voltage	$V_{OL}$	—	$I_{OL} = 100 \mu\text{A}$	0	—	0.2	V	
"H" level output voltage	$I_{OH}$	—	Full Speed $V_{OH} = V_{DDE} - 0.4 \text{ V}$	-20	—	—	mA	
		—	Low Speed $V_{OH} = V_{DDE} - 0.4 \text{ V}$	-6	—	—		
"L" level output voltage	$I_{OL}$	—	Full Speed $V_{OL} = 0.4 \text{ V}$	20	—	—	mA	
		—	Low Speed $V_{OL} = 0.4 \text{ V}$	6	—	—		
Output Short-Circuit Current	$I_{OS}$	—	—	—	—	300	mA	*1
Input leak current	$I_{LZ}$	—	—	—	—	$\pm 5$	$\mu\text{A}$	*2

\*1 : < Output Short Circuit Current  $I_{OS}$  >

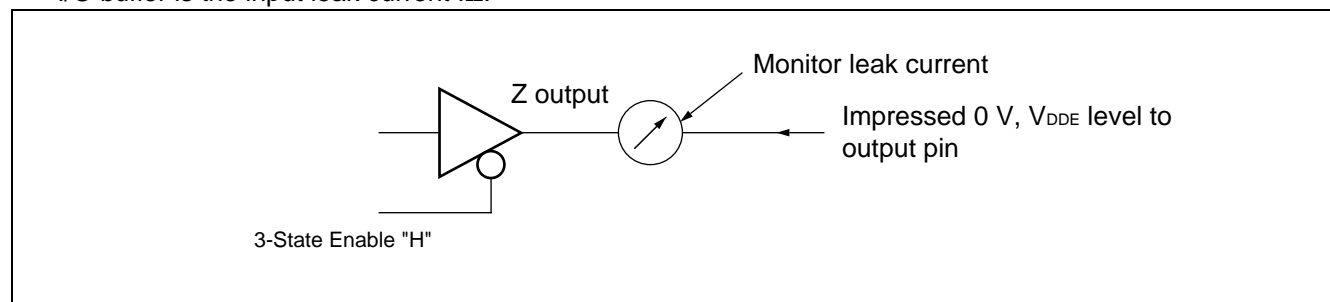
The output short circuit current  $I_{OS}$  is the maximum current that flows when the output pin is connected to  $V_{DDE}$  or  $V_{SS}$  pin (within the maximum rating) .

Output Short Circuit Current : The output short circuit current's value is the short-circuit current value of one terminal in one side of the differential output terminal. As this USB I/O buffer is a differential output, consider both of the pins.



\*2 : < Z leak current  $I_{LZ}$  measurement >

The leak current when  $V_{DDE}$  or  $V_{SS}$  potential is impressed to bi-directional pin at high-impedance state of USB I/O buffer is the input leak current  $I_{LZ}$ .



# MB91305

## [2] DC Characteristics

Conform to USB Specification Revision 1.1

( $V_{DDI} = 1.8 \text{ V} \pm 0.15 \text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ,  $V_{SS} = AV_{SS} = 0 \text{ V}$ ,  $T_a = -10 \text{ }^\circ\text{C}$  to  $+70 \text{ }^\circ\text{C}$ )

Parameter		Symbol	Value		Unit	Remarks
			Min	Max		
Input Levels	High (driven)	$V_{IH}$	2.0	—	V	*1
	Low	$V_{IL}$	—	0.8	V	*1
	Differential Input Sensitivity	$V_{DI}$	0.2	—	V	*2
	Common Mode Range	$V_{CM}$	0.8	2.5	V	*2
Output Levels	Low	$V_{OL}$	0.0	0.3	V	*3
	High (driven)	$V_{OH}$	2.8	3.6	V	*3
	Differential Output Signal Voltage	$V_{CRS}$	1.3	2.0	V	*4
Terminations	Bus Pull-Up Resistor on Upstream Port	$R_{PU}$	1.425	1.575	k $\Omega$	$1.5 \text{ k}\Omega \pm 5\%$
	Bus Pull-Down Resistor on Downstream Port	$R_{PD}$	1.425	1.575	k $\Omega$	$1.5 \text{ k}\Omega \pm 5\%$
	Termination Voltage for Upstream Port Pull-Up	$V_{TERM}$	3.0	3.6	V	*5

\*1 : < Input Levels  $V_{IH}$  and  $V_{IL}$  >

The switching-threshold voltage of the single-end-receiver in USB I/O buffer is set within the following range;  $V_{IL}$  (Max) = 0.8 V,  $V_{IH}$  (Min) = 2.0 V (TTL input standard).

And, to fall the noise sensitivity, a little hysteresis is set.

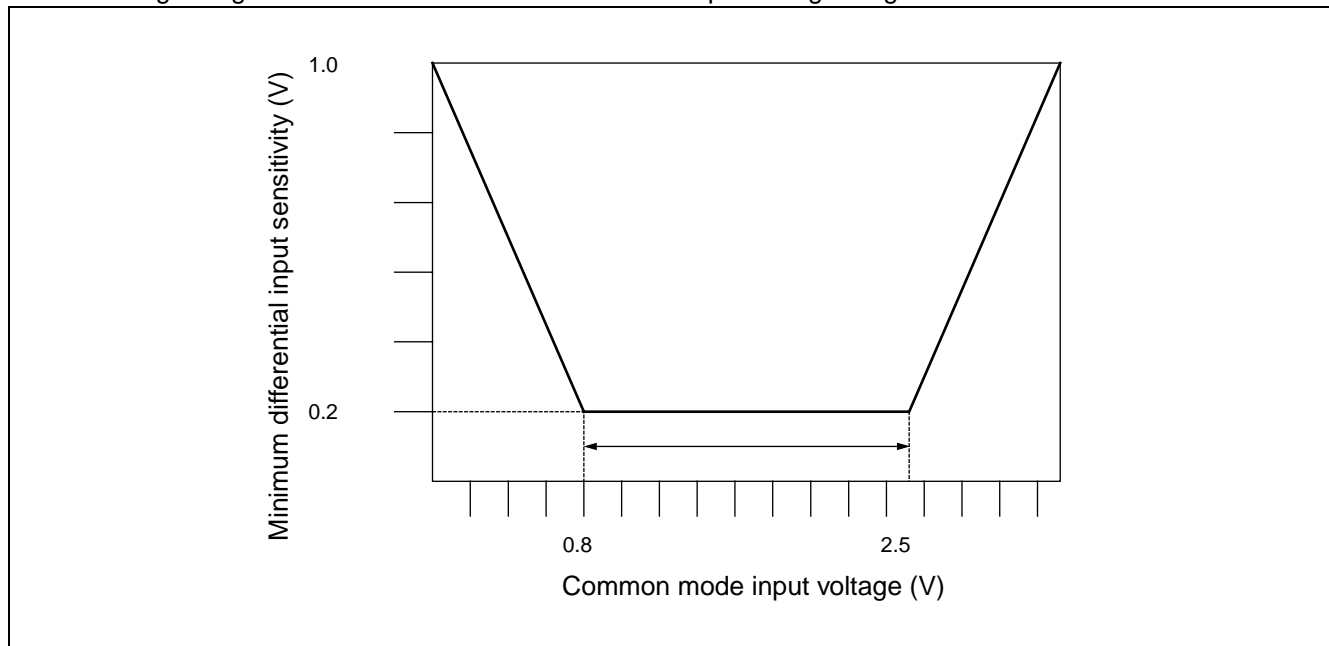


**\*2 : < Input Levels  $V_{DI}$  and  $V_{CM}$  >**

Reception of the USB differential data signal uses the differential-receiver.

The differential input sensitivity of the differential-receiver is 200 mV, when the difference voltage between the differential data input and local ground reference level is the following ranges; 0.8 V to 2.5 V.

The voltage range above is called the common<sup>2</sup> mode input voltage range.



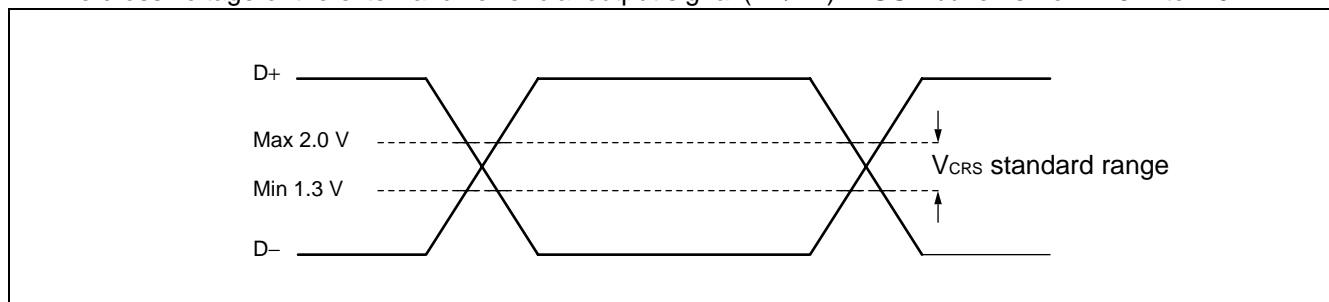
**\*3 : < Output Levels  $V_{OL}$  and  $V_{OH}$  >**

The driver's output driving ability is set to following;

- at low state ( $V_{OL}$ ) : less than 0.3 V (vs. 3.6 V, 1.5 k $\Omega$  load)
- at high state ( $V_{OH}$ ) : more than 2.8 V (vs. ground, 1.5 k $\Omega$  load)

**\*4 : < Output Levels  $V_{CRS}$  >**

The cross voltage of the external differential output signal (D+/D-) in USB buffer is from 1.3 V to 2.0 V.



**\*5 : < Terminations  $V_{TERM}$  >**

Pull-up voltage for the upstream port is shown.

## 4. AC Characteristics

### (1) Clock timing ratings

( $V_{DDI} = 1.8\text{ V} \pm 0.15\text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = AV_{SS} = 0\text{ V}$ ,  $T_a = -10\text{ }^\circ\text{C}$  to  $+70\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin	Condi- tions	Value		Unit	Remarks
				Min	Max		
Clock frequency (1)	$f_c$	X0 X1	—	37.5	48	MHz	Using PLL*1
				12.5	16	MHz	
Clock cycle time	$t_c$	X0 X1	—	—	20.8	ns	
				—	62.5	ns	
Clock frequency (2)	$f_c$	X0 X1	—	10	50	MHz	Self-oscillation (1/2 division input)
Clock frequency (3)	$f_c$	X0 X1		10	50	MHz	At external clock
Clock cycle time	$t_c$	X0 X1		40	100	ns	
Input clock pulse width	$P_{WH}$ $P_{WL}$	X0 X1		16	—	ns	
Input clock rise time and fall time	$t_{CR}$ $t_{CF}$	X0 X1		—	8	ns	
Internal operating clock frequency	$f_{CP}$	—	—	$3.125^{*2}$	64	MHz	CPU
	$f_{CPP}$			$3.125^{*2}$	32	MHz	Peripheral
	$f_{CPT}$			$3.125^{*2}$	32	MHz	External bus
Internal operating clock cycle time	$t_{CP}$	—	—	15.6	$1280^{*2}$	ns	CPU
	$t_{CPP}$			31.2	$1280^{*2}$	ns	Peripheral
	$t_{CPT}$			31.2	$1280^{*2}$	ns	External bus

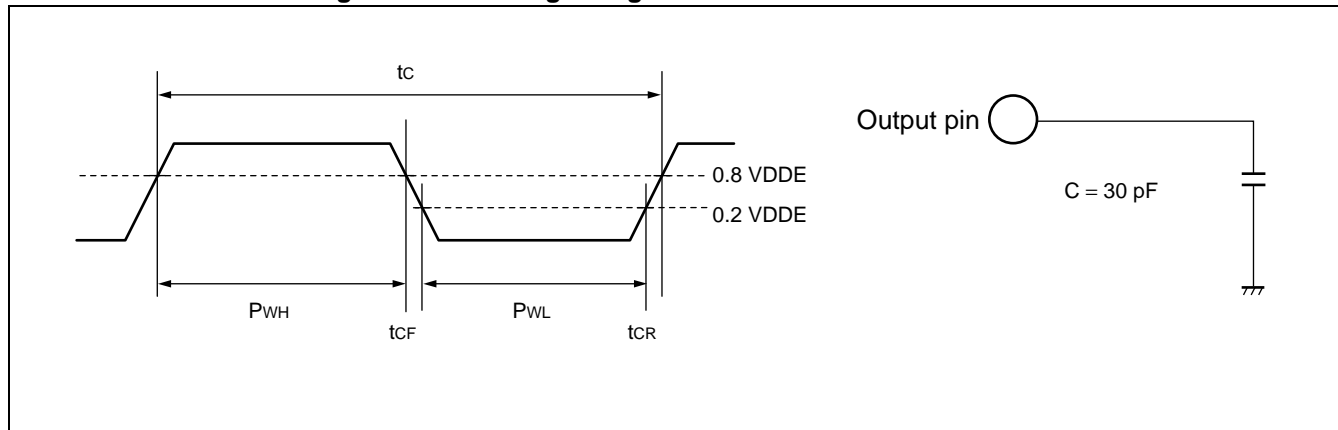
\*1 : This value is as follows;

- With USB function (MD pin = 0000<sub>B</sub>) : 37.5 MHz to 48 MHz And using USB: fixed to 48 MHz  
(operation at a maximum internal speed of 64 MHz by  
quadrupling a self-oscillation frequency of 48 MHz via PLL of  
divided by 3.)
- Without USB function (MD pin = 0010<sub>B</sub>) : 12.5 MHz to 16 MHz  
(operation at a maximum internal speed of 64 MHz by  
quadrupling a self-oscillation frequency of 16 MHz via PLL.)

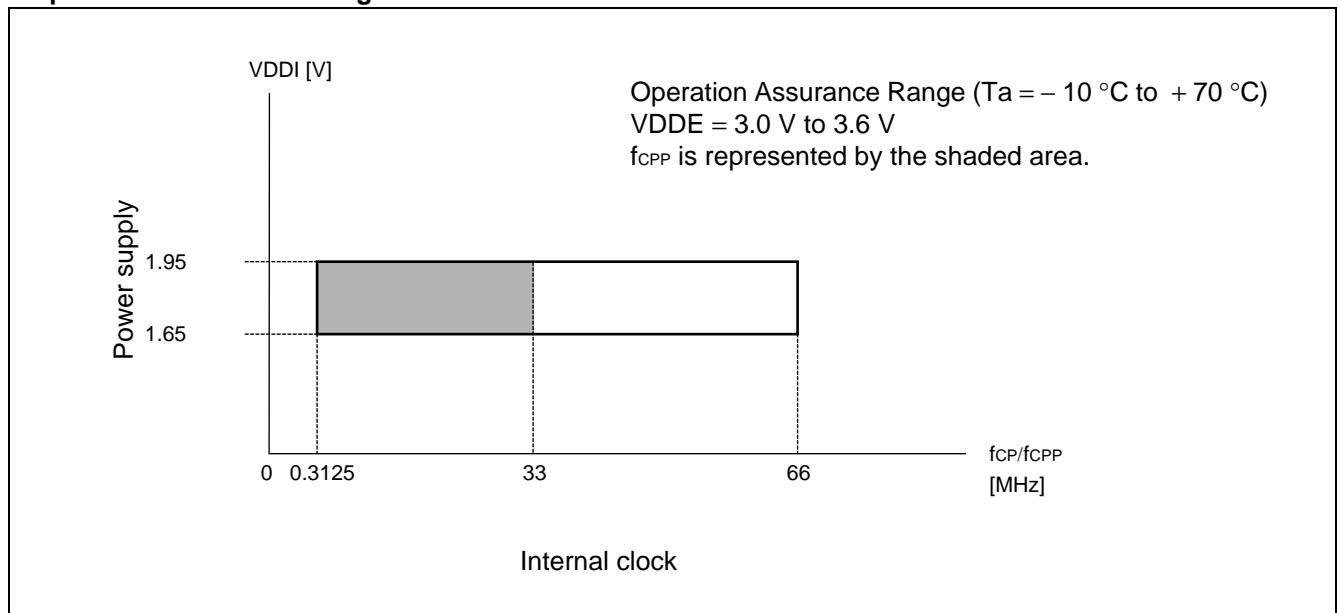
\*2 : The values shown represent a minimum clock frequency of 12.5 MHz input at the X0 pin, using the oscillation circuit PLL and a gear ratio of 1/16.

$$12.5\text{ [MHz]} \times 4\text{ (multiply)} \times 1/16\text{ (gear 1/16)} = 3.125\text{ [MHz]}$$

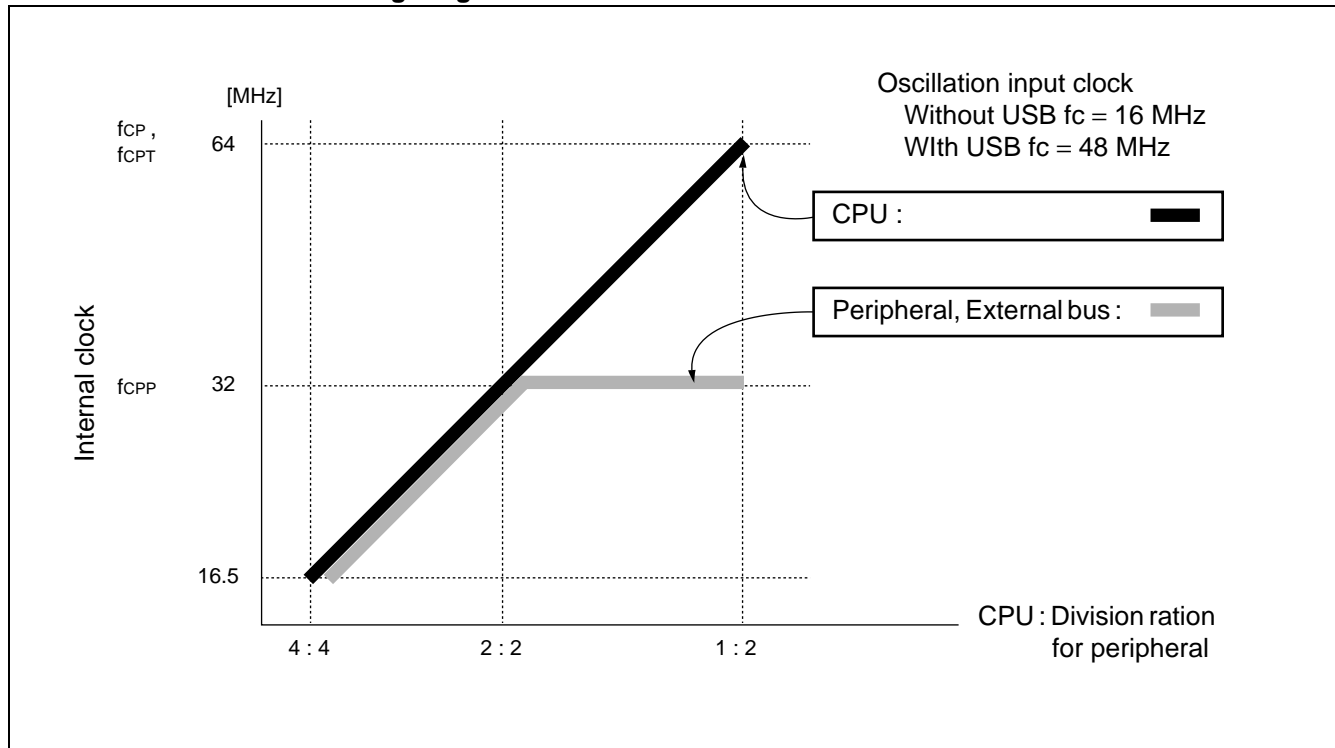
• **Conditions for measuring the clock timing ratings**



• **Operation Assurance Range**



• External/internal clock setting range

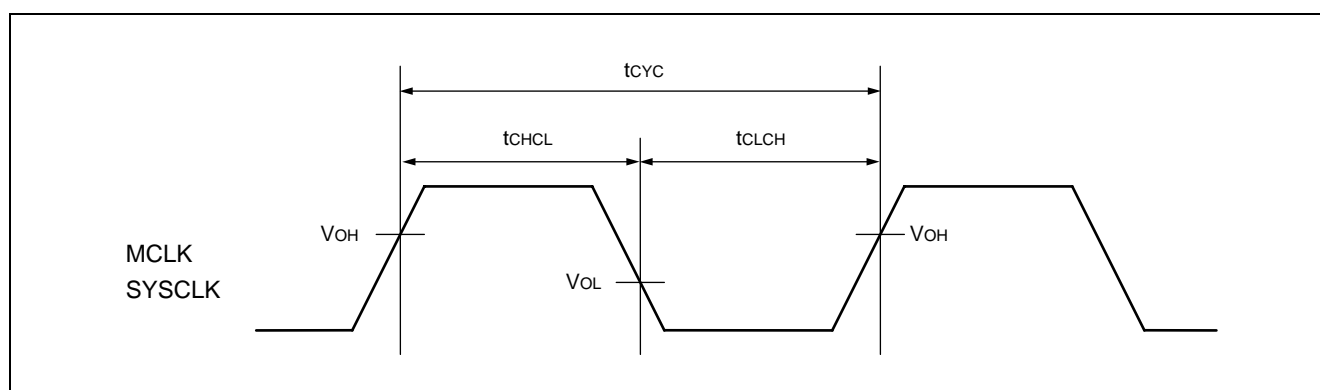


- Notes :
- When the PLL is used, the external clock input must fall between 12.5 MHz and 16.5 MHz.
  - Set the PLL oscillation stabilization wait time longer than 500  $\mu$ s.
  - The internal clock gear setting should not exceed the relevant value in the table in (1) "Clock timing ratings".

## (2) Clock output timing

( $V_{DDI} = 1.8\text{ V} \pm 0.15\text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = AV_{SS} = 0\text{ V}$ ,  $T_a = -10\text{ }^\circ\text{C}$  to  $+70\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin	Condi- tions	Value		Unit	Remarks
				Min	Max		
Cycle time	$t_{CYC}$	MCLK SYSCLK	—	$t_{CPT}$	—	ns	*1
MCLK (SYSCLK) $\uparrow$ → MCLK (SYSCLK) $\downarrow$	$t_{CHCL}$	MCLK SYSCLK		$1/2 \times t_{CYC} - 3$	$1/2 \times t_{CYC} + 3$	ns	*2
MCLK (SYSCLK) $\downarrow$ → MCLK (SYSCLK) $\uparrow$	$t_{CLCL}$	MCLK SYSCLK		$1/2 \times t_{CYC} - 3$	$1/2 \times t_{CYC} + 3$	ns	*3



\*1 :  $t_{CYC}$  is the frequency of one clock cycle after gearing.

\*2 : The following ratings are for the gear ratio set to 1.

For the ratings when the gear ratio is set to between 1/2, 1/4 and 1/8, substitute 1/2, 1/4 or 1/8 for n in the following equation.

$$t_{CHCL} = (1/2 \times 1/n) \times t_{CYC} - 10$$

\*3 : The following rating are for the gear ratio set to 1.

# MB91305

## (3) Reset and hardware standby input ratings

( $V_{DDI} = 1.8 \text{ V} \pm 0.15 \text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ,  $V_{SS} = AV_{SS} = 0 \text{ V}$ ,  $T_a = -10 \text{ }^\circ\text{C}$  to  $+70 \text{ }^\circ\text{C}$ )

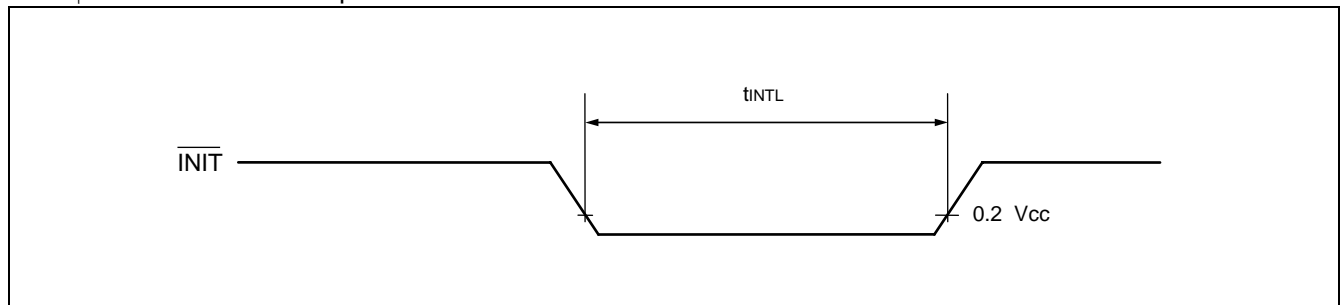
Parameter	Symbol	Pin	Condi- tions	Value		Unit	Remarks
				Min	Max		
$\overline{\text{INIT}}$ input time (at power-on)	$t_{\text{INTL}}$	$\overline{\text{INIT}}$	—	*	—	ns	
$\overline{\text{INIT}}$ input time (other than at power-on)				$t_{\text{CP}} \times 5$	—	ns	

\* :  $\overline{\text{INIT}}$  input time (at power-on)

FAR resonator, ceramic oscillator :  $\phi \times 2^{15}$  or greater recommended

Crystal :  $\phi \times 2^{21}$  or greater recommended

$\phi$  : Power on  $\rightarrow$  X0/X1 period  $\times 2$



## (4-1) Normal bus access read/write operation

( $V_{DDI} = 1.8\text{ V} \pm 0.15\text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = AV_{SS} = 0\text{ V}$ ,  $T_a = -10\text{ }^\circ\text{C}$  to  $+70\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin	Condi- tions	Value		Unit	Remarks
				Min	Max		
$\overline{CS0}/\overline{CS1}/\overline{CS4}/\overline{CS5}/\overline{CS6}/\overline{CS7}$ setup	$t_{CSLCH}$	MCLK/SYSCLK $\overline{CS0}$ to $\overline{CS7}$	—	3	—	ns	
$\overline{CS0}/\overline{CS1}/\overline{CS4}/\overline{CS5}/\overline{CS6}/\overline{CS7}$ hold	$t_{CSHCH}$			3	$t_{CYC} / 2 + 6$	ns	
Address setup	$t_{ASCH}$	MCLK/SYSCLK A23 to A0	—	3	—	ns	
Address hold	$t_{CHAX}$			3	$t_{CYC} / 2 + 6$	ns	
Valid address → Valid data input time	$t_{AVDV}$	A23 to A0 D31 to D16	—	—	$3/2 \times t_{CYC} - 15$	ns	*1 *2
$\overline{WR0}$ , $\overline{WR1}$ delay time	$t_{CHWL}$	MCLK/SYSCLK $\overline{WR0}$ , $\overline{WR1}$	—	—	6	ns	
$\overline{WR0}$ , $\overline{WR1}$ delay time	$t_{CHWH}$			—	6	ns	
$\overline{WR0}$ , $\overline{WR1}$ minimum pulse width	$t_{WLWH}$	$\overline{WR0}$ , $\overline{WR1}$	—	$t_{CYC} - 3$	—	ns	
Data setup → $\overline{WRx}$ ↑	$t_{DSWH}$	$\overline{WR0}$ , $\overline{WR1}$ D31 to D16	—	$t_{CYC}$	—	ns	
$\overline{WRx}$ ↑ → Data hold time	$t_{WHDX}$			5	—	ns	
$\overline{RD}$ delay time	$t_{CHRL}$	MCLK/SYSCLK $\overline{RD}$	—	—	6	ns	
$\overline{RD}$ delay time	$t_{CHRH}$			—	6	ns	
$\overline{RD}$ ↓ → Valid data input time	$t_{RLDV}$	$\overline{RD}$ D31 to D16	—	—	$t_{CYC} - 15$	ns	*1
Data setup → $\overline{RD}$ ↑ Time	$t_{DSRH}$			15	—	ns	
$\overline{RD}$ ↑ → Data hold time	$t_{RHDX}$			0	—	ns	
$\overline{RD}$ minimum pulse width	$t_{RLRH}$			$t_{CYC} - 3$	—	ns	
$\overline{AS}$ setup	$t_{ASLCH}$	MCLK/SYSCLK $\overline{AS}$	—	3	—	ns	
$\overline{AS}$ hold	$t_{ASHCH}$			3	—	ns	

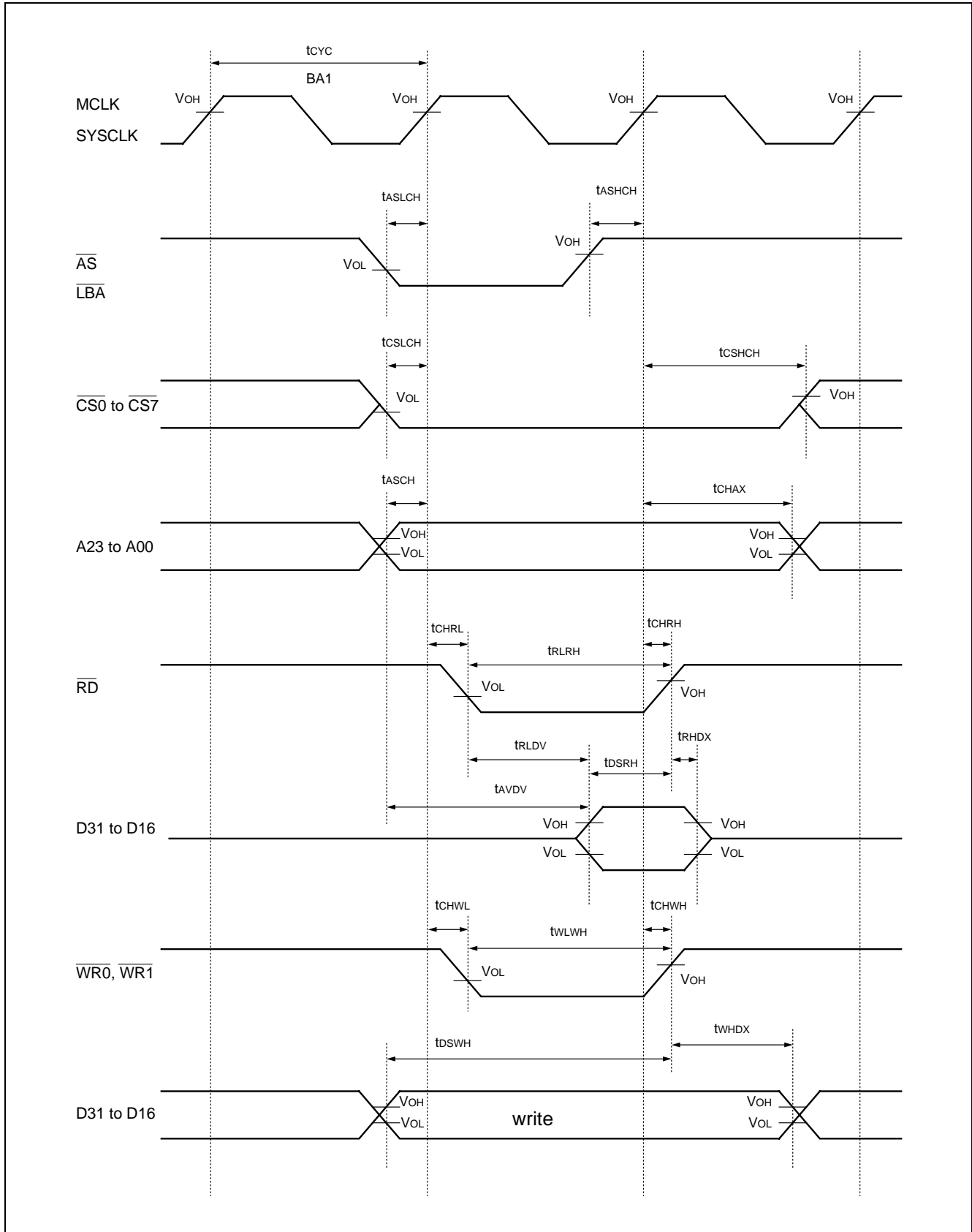
\*1 : When the bus timing is delayed by automatic wait insertion or RDY input, add the time ( $t_{CYC} \times$  the number of cycles added for the delay) to this rating.

\*2 : The following ratings are for the gear ratio set to 1.

For the ratings when the gear ratio is set to between 1/2, 1/4 and 1/8, substitute 1/2, 1/4 and 1/8 for n in the following equation.

$$t_{AVDV} : 3 / (2n) \times t_{CYC} - 15$$

# MB91305





## (4-2) Multiplex bus access read/write operation

( $V_{DDI} = 1.8 \text{ V} \pm 0.15 \text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ,  $V_{SS} = AV_{SS} = 0 \text{ V}$ ,  $T_a = -10 \text{ }^\circ\text{C}$  to  $+70 \text{ }^\circ\text{C}$ )

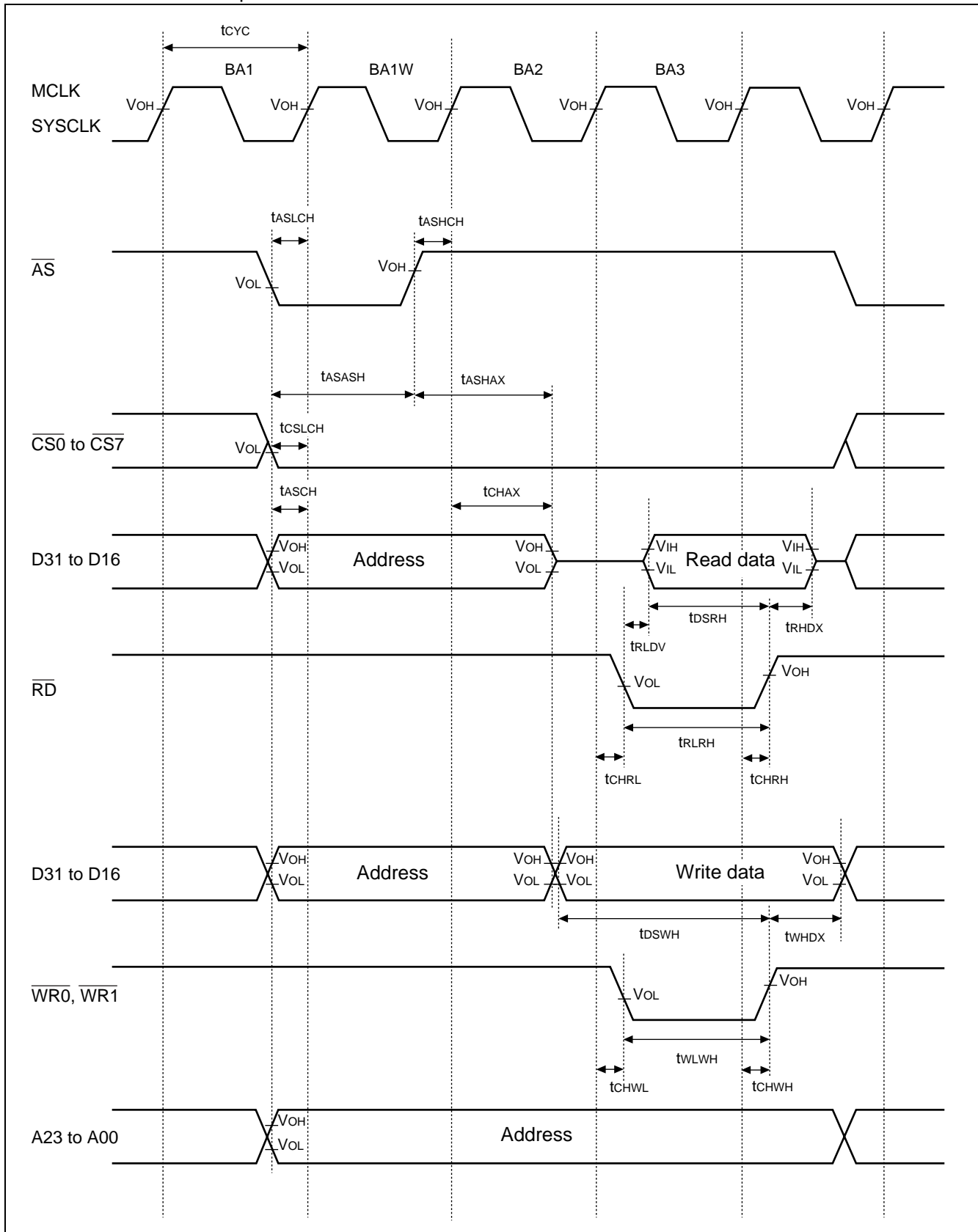
Parameter	Symbol	Pin	Condi- tions	Value		Unit	Remarks
				Min	Max		
D31 to D16 address setup time → MCLK (SYSCLK) ↑	$t_{ASCH}$	MCLK/SYSCLK D31 to D16 (address)	—	3	—	ns	
MCLK (SYSCLK) ↑ → D31 to D16 address hold time	$t_{CHAX}$			3	$t_{CYC} / 2 + 6$	ns	
D31 to D16 address setup time → $\overline{AS}$ ↑	$t_{ASASH}$	$\overline{AS}$ D31 to D16 (address)		12	—	ns	*
$\overline{AS}$ ↑ → D31 to D16 address hold time	$t_{ASHAX}$			$t_{CYC} - 3$	$t_{CYC} + 3$	ns	*

\* : At  $\overline{CS} \rightarrow \overline{RD}/\overline{WR}$  setup extension = 1

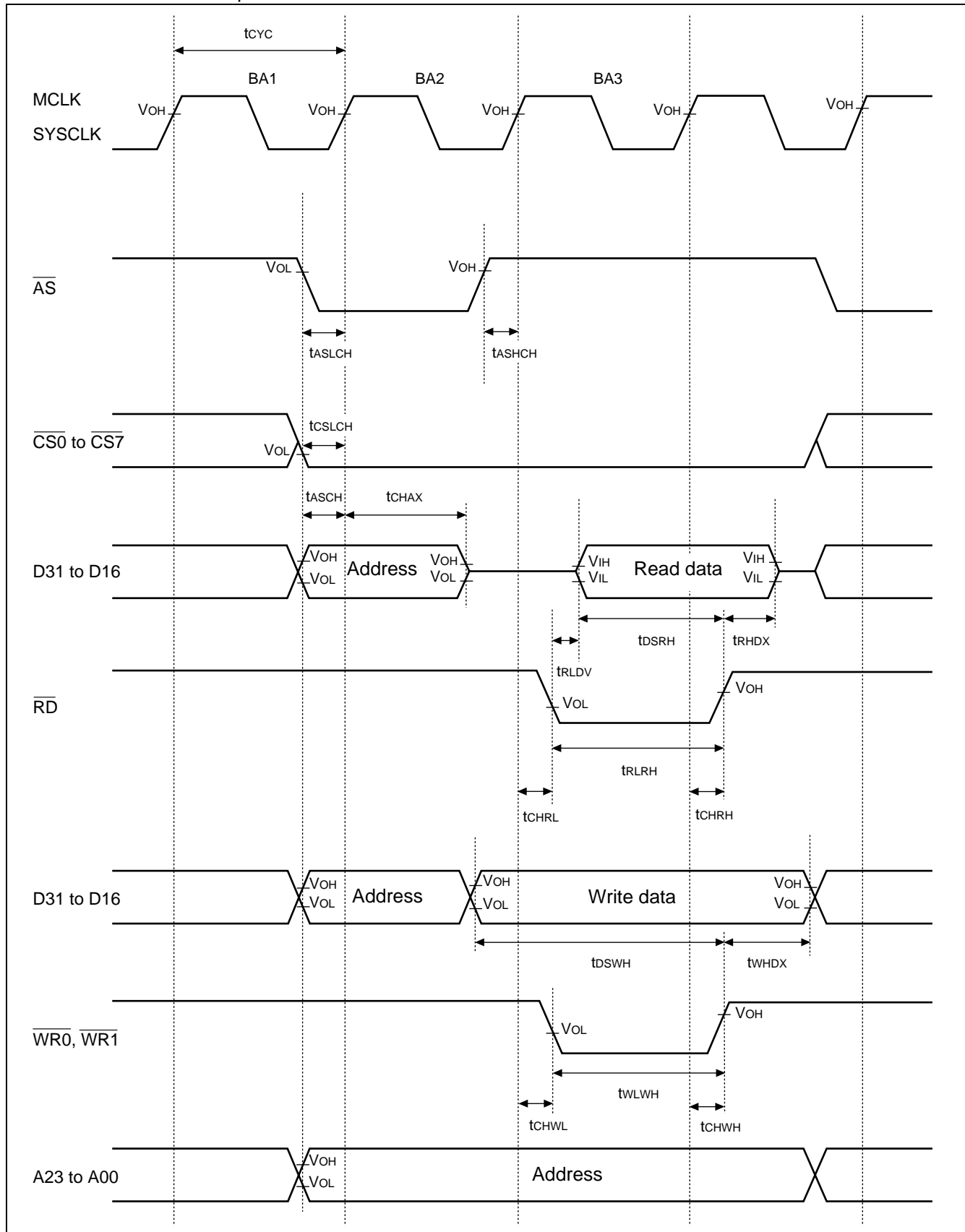
Note : Use the same rating as normal bus interface except for this rating.

# MB91305

- At  $\overline{CS} \rightarrow \overline{RD}/\overline{WR}$  setup extension = 1



- At  $\overline{CS} \rightarrow \overline{RD}/\overline{WR}$  setup extension = 0

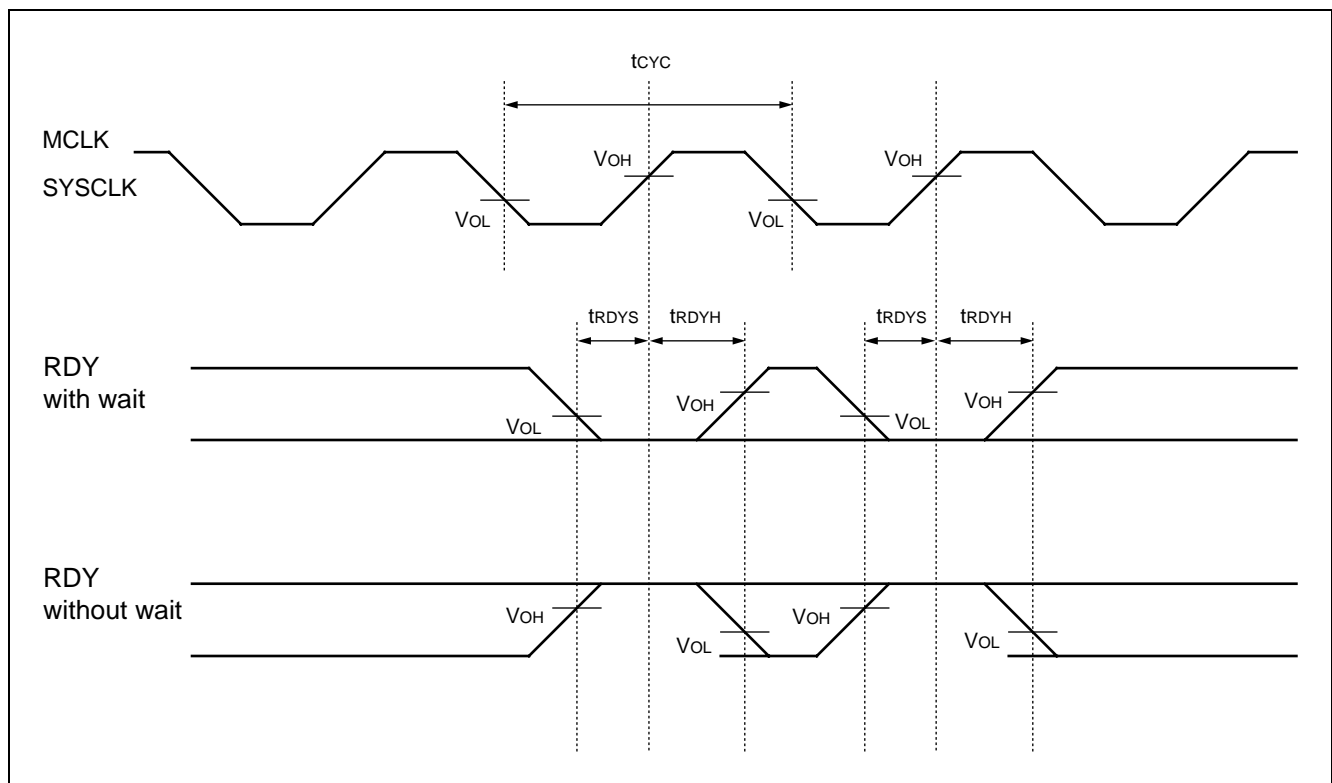


# MB91305

## (5) Ready input timings

( $V_{DDI} = 1.8 \text{ V} \pm 0.15 \text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ ,  $V_{SS} = AV_{SS} = 0 \text{ V}$ ,  $T_a = -10 \text{ }^\circ\text{C}$  to  $+70 \text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin	Conditions	Value		Unit	Remarks
				Min	Max		
RDY setup time → MCLK (SYSCLK) ↓	$t_{RDYS}$	MCLK SYSCLK RDY	—	10	—	ns	
MCLK (SYSCLK) ↓ → RDY hold time	$t_{RDYH}$	MCLK SYSCLK RDY	—	0	—	ns	

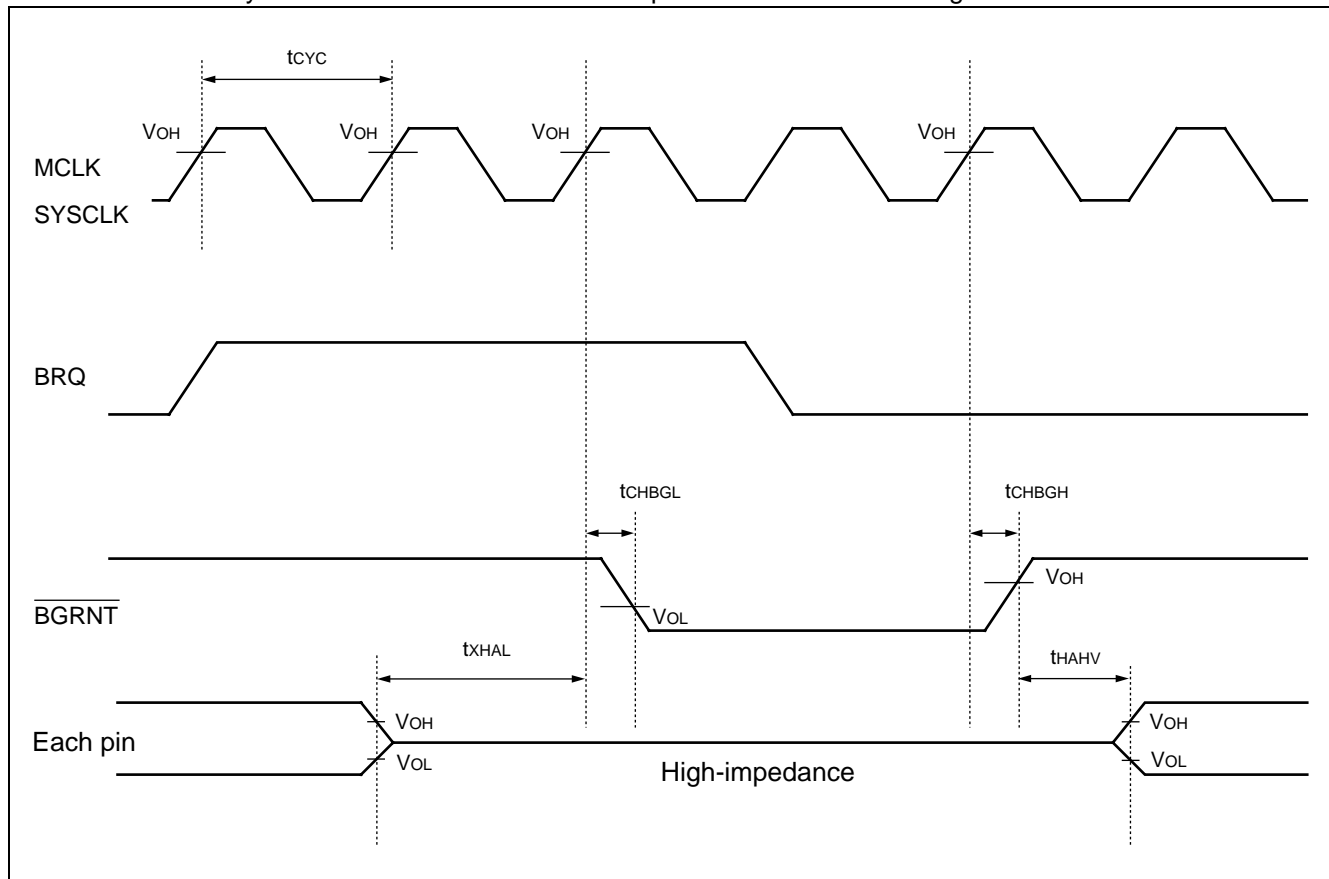


## (6) Hold timing

( $V_{DDI} = 1.8\text{ V} \pm 0.15\text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = AV_{SS} = 0\text{ V}$ ,  $T_a = -10\text{ }^\circ\text{C}$  to  $+70\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin	Condi- tions	Value		Unit	Remarks
				Min	Max		
$\overline{\text{BGRNT}}$ delay time	$t_{\text{CHBGL}}$	MCLK SYSCLK $\overline{\text{BGRNT}}$	—	$t_{\text{CYC}} / 2 - 6$	$t_{\text{CYC}} / 2 + 6$	ns	
$\overline{\text{BGRNT}}$ delay time	$t_{\text{CHBGH}}$			$t_{\text{CYC}} / 2 - 6$	$t_{\text{CYC}} / 2 + 6$	ns	
Pin floating → $\overline{\text{BGRNT}}$ ↓ time	$t_{\text{XHAL}}$	$\overline{\text{BGRNT}}$		$t_{\text{CYC}} - 10$	$t_{\text{CYC}} + 10$	ns	
$\overline{\text{BGRNT}}$ ↑ → Pin valid time	$t_{\text{HAHV}}$			$t_{\text{CYC}} - 10$	$t_{\text{CYC}} + 10$	ns	

Note : It takes one cycle or more from when BRQ is captured until  $\overline{\text{BGRNT}}$  changes.



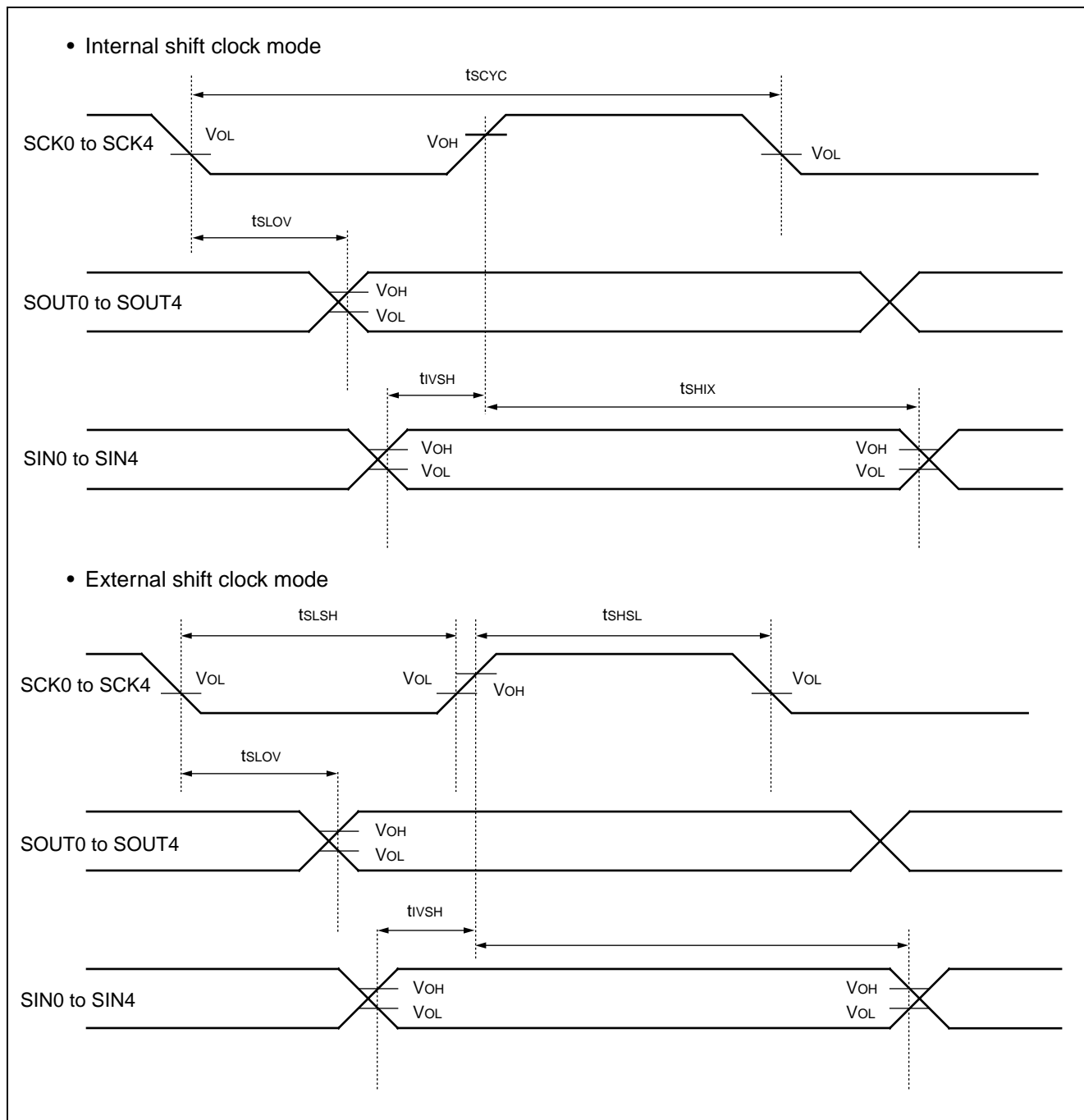
# MB91305

## (7) UART timing

( $V_{DDI} = 1.8\text{ V} \pm 0.15\text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = AV_{SS} = 0\text{ V}$ ,  $T_a = -10\text{ }^{\circ}\text{C}$  to  $+70\text{ }^{\circ}\text{C}$ )

Parameter	Symbol	Pin	Conditions	Value		Unit	Remarks
				Min	Max		
Serial clock cycle time	$t_{SCYC}$	SCK0 to SCK4	Internal shift clock mode	$8 t_{CYCP}$	—	ns	
SCLK $\downarrow \rightarrow$ SOUT delay time	$t_{SLOV}$	SCK0 to SCK4 SOUT0 to SOUT4		-80	+80	ns	
Valid SIN $\rightarrow$ SCLK $\uparrow$	$t_{IVSH}$	SCK0 to SCK4 SIN0 to SIN4		100	—	ns	
SCLK $\uparrow \rightarrow$ valid SIN hold time	$t_{SHIX}$	SCK0 to SCK4 SIN0 to SIN4		60	—	ns	
Serial clock "H" Pulse Width	$t_{SHSL}$	SCK0 to SCK4	External shift clock mode	$4 t_{CYCP}$	—	ns	
Serial clock "L" Pulse Width	$t_{SLSH}$	SCK0 to SCK4		$4 t_{CYCP}$	—	ns	
SCLK $\downarrow \rightarrow$ SOUT delay time	$t_{SLOV}$	SCK0 to SCK4 SOUT0 to SOUT4		—	150	ns	
Valid SIN $\rightarrow$ SCLK $\uparrow$	$t_{IVSH}$	SCK0 to SCK4 SIN0 to SIN4		60	—	ns	
SCLK $\uparrow \rightarrow$ valid SIN hold time	$t_{SHIX}$	SCK0 to SCK4 SIN0 to SIN4		60	—	ns	

- Notes :
- Above rating is for CLK synchronous mode.
  - $t_{CYCP}$  indicates the peripheral clock cycle time.

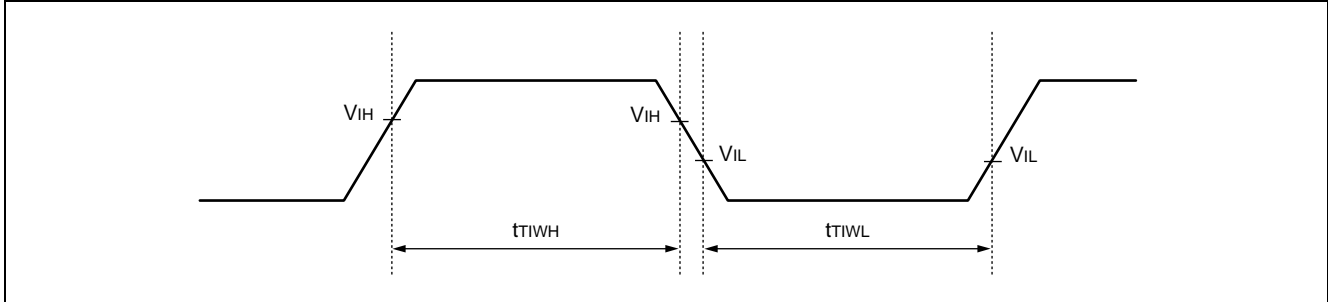


## (8) Timer clock Input Timing

( $V_{DDI} = 1.8\text{ V} \pm 0.15\text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = AV_{SS} = 0\text{ V}$ ,  $T_a = -10\text{ }^\circ\text{C}$  to  $+70\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin	Conditions	Value		Unit	Remarks
				Min	Max		
Input pulse width	$t_{TIWH}$ $t_{TIWL}$	TIN0 to TIN2	—	$2 t_{CYCP}$	—	ns	

Note :  $t_{CYCP}$  indicates the peripheral clock cycle time.

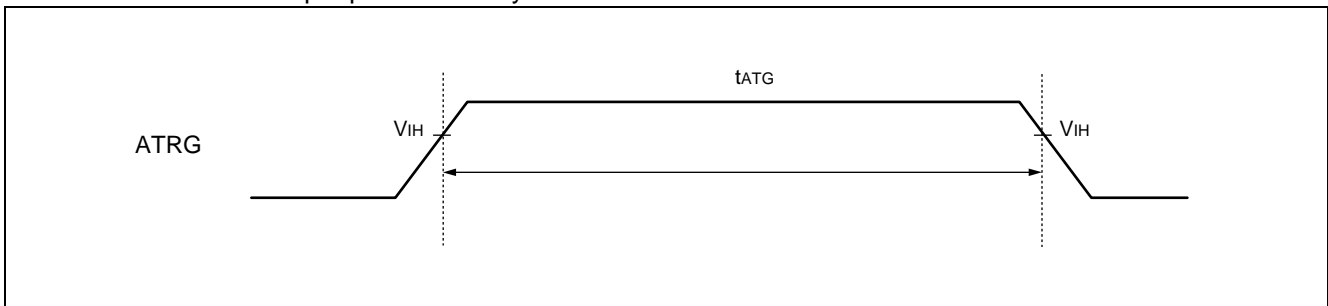


## (9) Trigger Input Timing

( $V_{DDI} = 1.8\text{ V} \pm 0.15\text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = AV_{SS} = 0\text{ V}$ ,  $T_a = -10\text{ }^\circ\text{C}$  to  $+70\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin	Conditions	Value		Unit	Remarks
				Min	Max		
A/D activation trigger input time	$t_{ATG}$	ATRG	—	$5 t_{CYCP}$	—	ns	

Note :  $t_{CYCP}$  indicates the peripheral clock cycle time.



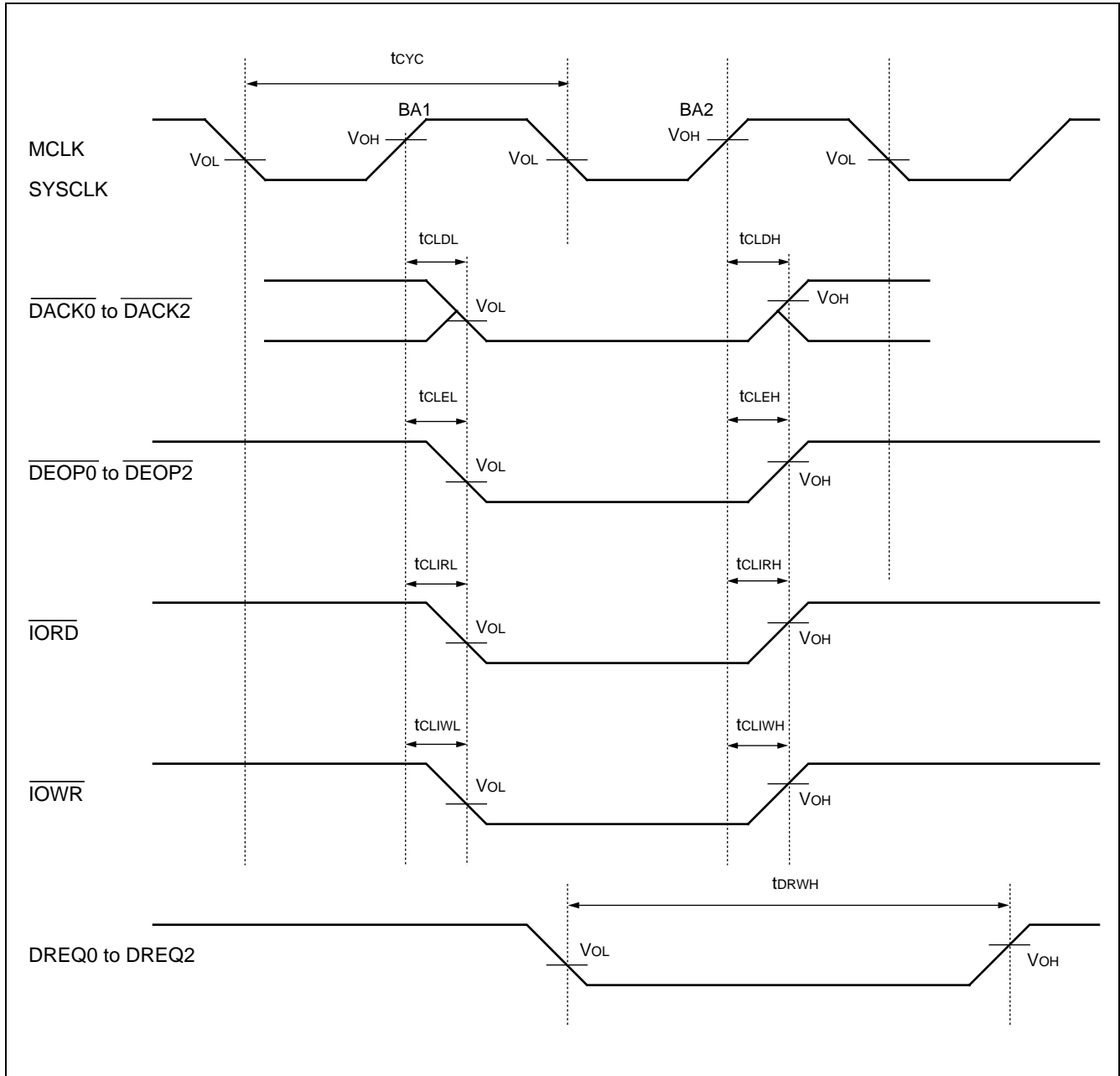


## (10) DMA controller timing

( $V_{DDI} = 1.8\text{ V} \pm 0.15\text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = AV_{SS} = 0\text{ V}$ ,  $T_a = -10\text{ }^{\circ}\text{C}$  to  $+70\text{ }^{\circ}\text{C}$ )

Parameter	Symbol	Pin	Condi- tions	Value		Unit	Remarks
				Min	Max		
DREQ Input pulse width	$t_{DRWH}$	DREQ0 to DREQ2	—	$5\ t_{CYC}$	—	ns	
$\overline{\text{DACK}}$ delay time	$t_{CLDL}$	MCLK/SYSCLK		—	6	ns	
	$t_{CLDH}$	$\overline{\text{DACK0}}$ to $\overline{\text{DACK2}}$		—	6		
$\overline{\text{DEOP}}$ delay time	$t_{CLEL}$	MCLK/SYSCLK		—	6	ns	
	$t_{CLEH}$	$\overline{\text{DEOP0}}$ to $\overline{\text{DEOP2}}$		—	6		
$\overline{\text{IORD}}$ delay time	$t_{CLIRL}$	MCLK/SYSCLK		—	6	ns	
	$t_{CLIRH}$			—	6		
$\overline{\text{IOWR}}$ delay time	$t_{CLIWL}$	MCLK/SYSCLK		—	6	ns	
	$t_{CLIWH}$			—	6		

# MB91305



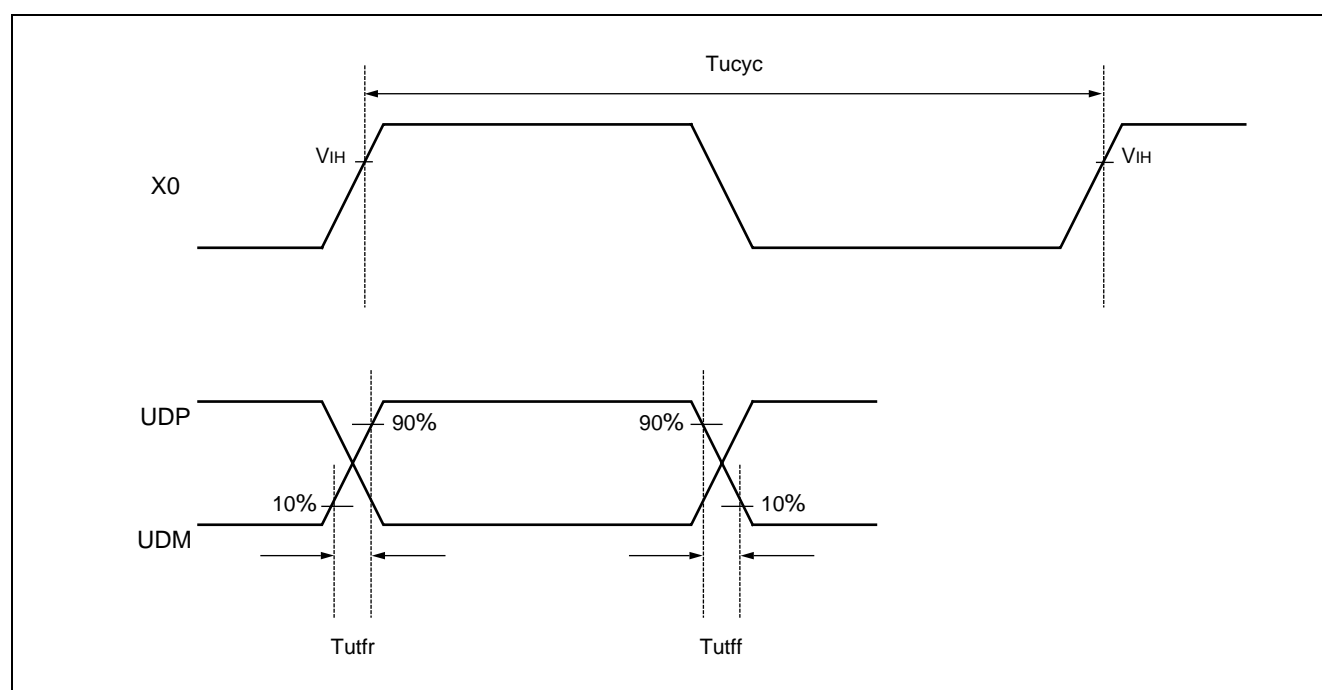
Note : The waveform of  $\overline{DACKx}$  and  $\overline{DEOPx}$  is the waveforms when the PFR register is set to FR30 compatible timing.

When the setting is chip selection timing, The delay starts from the falling edge of MCLK/SYSCLK.

## (11) USB interface

( $V_{DDI} = 1.8\text{ V} \pm 0.15\text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = AV_{SS} = 0\text{ V}$ ,  $T_a = -10\text{ }^{\circ}\text{C}$  to  $+70\text{ }^{\circ}\text{C}$ )

Parameter	Symbol	Pin	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Input clock	Tucyc	X0 X1	—	—	48*1	—	MHz	Self oscillation 2500 ppm accuracy*1
		X0	—	—	—	—		External input 2500 ppm accuracy*1
Rise Time	Tutfr	UDP/ UDM	Full Speed	4	—	20	ns	*2
Fall Time	Tutff	UDP/ UDM	Full Speed	4	—	20	ns	*2
Differential Rise and Fall Timing Matching	Tutfrfm	UDP/ UDM	Full Speed	90	—	111.11	%	*2
Driver Output Resistance	Tuzdrv	UDP UDM	—	28	—	44	$\Omega$	*3



\*1 : AC characteristics for USB interface conform to USB Specification Revision 1.1.

\*2 : < Driver Characteristics Tutfr, Tutff and Tutfrfm >

These are regulations of the rising / falling time of the differential data signal.

This time is defined at the time between 10% to 90% of the output signal voltage.

For full-speed buffer, Tutfr/Tutff is specified such that the Tutfr/Tutff ratio falls within  $\pm 10\%$  to minimize RFI radiation.

# MB91305

## \*3 : < Driver Characteristics ZDRV >

The USB Full-speed connection is done by  $90 \Omega \pm 15\%$  of characteristic impedance ( $Z_0$ ).

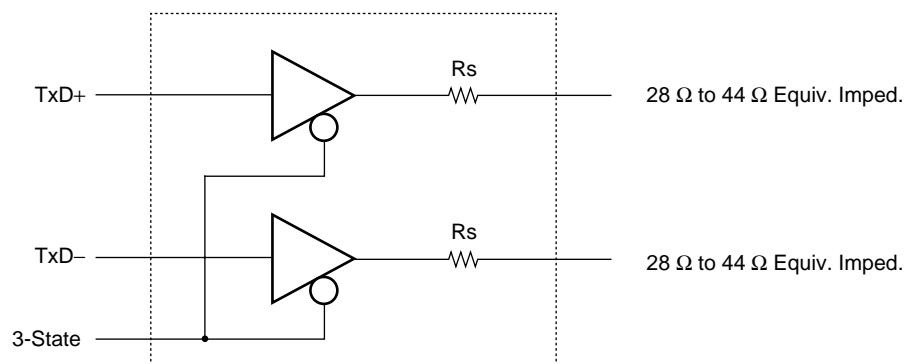
It is connected through the shielded twist 2-pair cable.

In this USB standard, both following conditions must be satisfied.

- The output impedance of USB Driver is from  $28 \Omega$  to  $44 \Omega$ .
- To balance, discrete series resistor ( $R_s$ ) is added.

The output impedance of USB I/O Buffer of this LSI is about  $3 \Omega$  to  $19 \Omega$ .

Therefore, it is necessary to add the series resistance  $R_s$  of  $25 \Omega$  to  $30 \Omega$  (recommended value  $27 \Omega$ ).



Driver output impedance  $3 \Omega$  to  $19 \Omega$   
Rs series resistance  $25 \Omega$  to  $30 \Omega$   
Resistance  $R_s$  of recommended value  $27 \Omega$  should be added.

## (12) I<sup>2</sup>C Timing

In the master mode operation

(V<sub>DDI</sub> = 1.8 V ± 0.15 V, V<sub>DDE</sub> = AV<sub>CC</sub> = 3.3 V ± 0.3 V, V<sub>SS</sub> = AV<sub>SS</sub> = 0 V, Ta = -10 °C to +70 °C)

Parameter	Symbol	Condition	Standard-mode		Fast-mode*3		Unit	Remarks
			Min	Max	Min	Max		
SCL clock frequency	f <sub>SCL</sub>	R = 1 kΩ, C = 50 pF*4	0	100	0	400	kHz	
"L" width of the SCL clock	t <sub>LOW</sub>		4.7	—	1.3	—	μs	
"H" width of the SCL clock	t <sub>HIGH</sub>		4.0	—	0.6	—	μs	
Bus free time between a STOP and START condition	t <sub>BUS</sub>		4.7	—	1.3	—	μs	
SCL ↓ → SDA output delay time	t <sub>DLDAT</sub>		—	5 × M*1	—	5 × M*1	ns	
Set-up time for a repeated START condition SCL ↑ → SDA ↓	t <sub>SUSTA</sub>		4.7	—	0.6	—	μs	
Hold time (repeated) START condition SDA ↓ → SCL ↓	t <sub>HDSTA</sub>		4.0	—	0.6	—	μs	The first clock pulse is generated afterword.
Set-up time for STOP condition SCL ↑ → SDA ↑	t <sub>SUSTO</sub>		4.0	—	0.6	—	μs	
Data input hold time (vs.SCL ↓)	t <sub>HDDAT</sub>		2 × M*1	—	2 × M*1	—	μs	
Data input set-up time (vs.SCL ↑)	t <sub>SUDAT</sub>		250	—	100*2	—	ns	

\*1 : M = Resource clock cycle (ns)

\*2 : To use high-speed mode I<sup>2</sup>C bus device for standard mode I<sup>2</sup>C bus system, it must satisfy the request condition (t<sub>SUDAT</sub> = 250 ns). If a device does not extend "L" period of the SCL signal, the following data must be output to the SDA line before 1250 ns (SCL line is opened, equal to SDA, SCL rise Max time + t<sub>SUDATA</sub>).

\*3 : To use it exceeding 100kHz, the resource clock is set to 6MHz or more.

\*4 : R and C is the pull-up resistor and the load capacity for SCL and SDA output lines respectively.

# MB91305

In the slave mode operation

( $V_{DDI} = 1.8\text{ V} \pm 0.15\text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = AV_{SS} = 0\text{ V}$ ,  $T_a = -10\text{ }^\circ\text{C}$  to  $+70\text{ }^\circ\text{C}$ )

Parameter	Symbol	Condition	Standard-mode		Fast-mode*3		Unit	Remarks
			Min	Max	Min	Max		
SCL clock frequency	f <sub>SCL</sub>	R = 1 kΩ, C = 50 pF*4	0	100	0	400	kHz	
"L" width of the SCL clock	t <sub>LOW</sub>		4.7	—	1.3	—	μs	
"H" width of the SCL clock	t <sub>HIGH</sub>		4.0	—	0.6	—	μs	
SCL ↓ → SDA output delay time	t <sub>DLDAT</sub>		—	5 × M*1	—	5 × M*1	ns	
Bus free time between a STOP and START condition	t <sub>BUS</sub>		4.7	—	1.3	—	μs	
Data input hold time (vs.SCL↓)	t <sub>HDDAT</sub>		2 × M*1	—	2 × M*1	—	μs	
Data input set-up time (vs.SCL↑)	t <sub>SUDAT</sub>		250	—	100*2	—	ns	
Set-up time for a repeated START condition SCL↑ → SDA↓	t <sub>SUSTA</sub>		4.7	—	0.6	—	μs	
Hold time for a repeated START condition SDA↓ → SCL↓	t <sub>HDSTA</sub>		4.0	—	0.6	—	μs	The first clock pulse is generated afterword.
Set-up time for STOP condition SCL↑ → SDA↑	t <sub>SUSTO</sub>		4.0	—	0.6	—	μs	

\*1 : M = Resource clock cycle (ns)

\*2 : To use high-speed mode I<sup>2</sup>C bus device for standard mode I<sup>2</sup>C bus system, it must satisfy the request condition (t<sub>SUDAT</sub> = 250 ns). If a device does not extend "L" period of the SCL signal, the following data must be output to the SDA line before 1250 ns (SCL line is opened, equal to SDA, SCL rise Max time + t<sub>SUDATA</sub>).

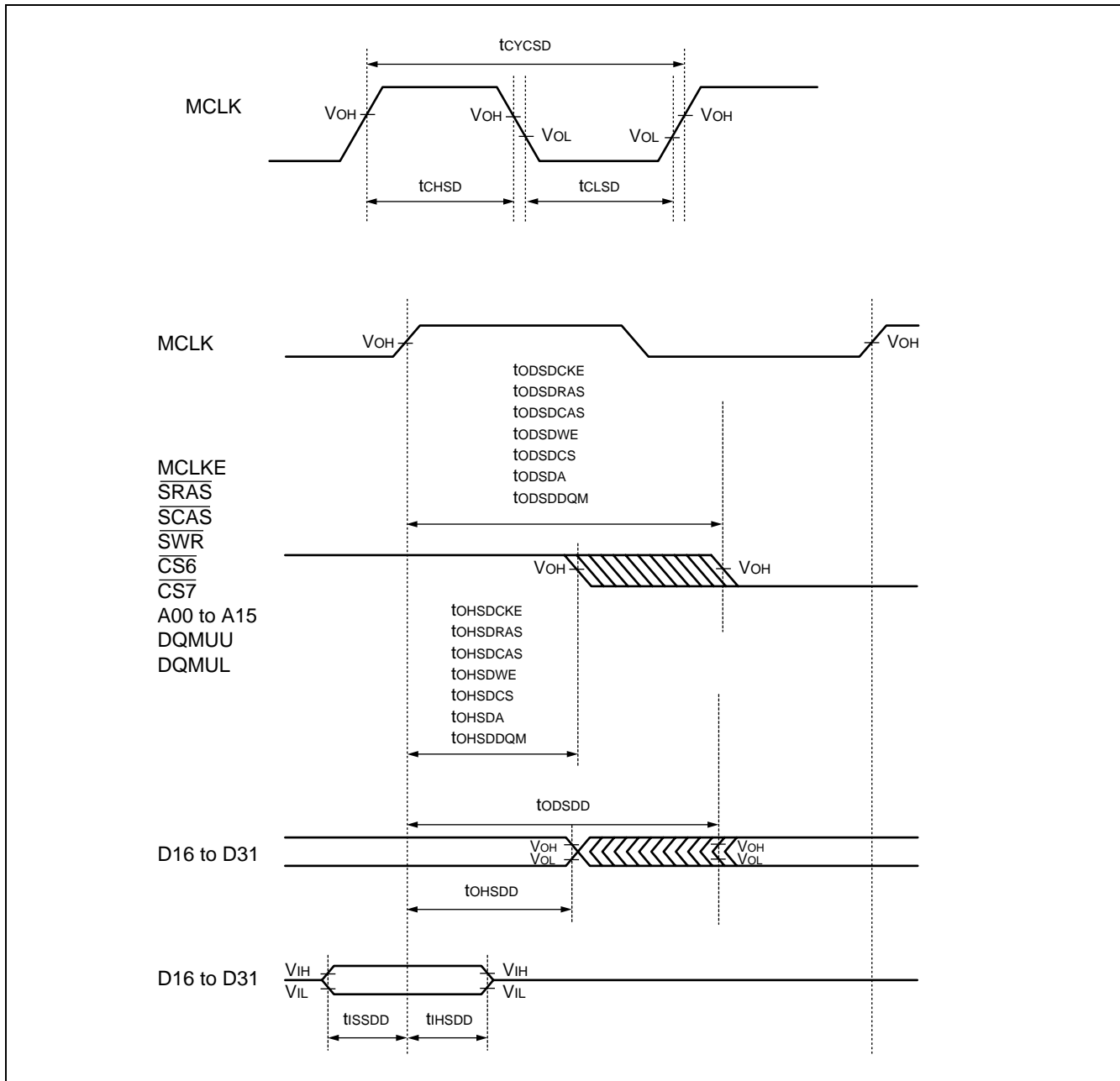
\*3 : To use it exceeding 100kHz, the resource clock is set to 6MHz or more.

\*4 : R and C is the pull-up resistor and the load capacity for SCL and SDA output lines respectively.

## (13) SDRAM Timing

( $V_{DDI} = 1.8\text{ V} \pm 0.15\text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = AV_{SS} = 0\text{ V}$ ,  $T_a = -10\text{ }^\circ\text{C}$  to  $+70\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin	Condi- tions	Value		Unit	Remarks
				Min	Max		
Output clock cycle time	$t_{CYCSD}$	MCLK	—	—	32	MHz	
“H” level clock pulse width	$t_{CHSD}$			12	—	ns	
“L” level clock pulse width	$t_{CLSD}$			12	—	ns	
MCLK $\uparrow$ → output delay time	$t_{ODSDCKE}$	MCLKE	—	—	15	ns	
Output hold time	$t_{OHSDCKE}$			2	—	ns	
MCLK $\uparrow$ → output delay time	$t_{ODSDRAS}$	$\overline{\text{SRAS}}$	—	—	15	ns	
Output hold time	$t_{OHSDRAS}$			2	—	ns	
MCLK $\uparrow$ → output delay time	$t_{ODSDCAS}$	$\overline{\text{SCAS}}$	—	—	15	ns	
Output hold time	$t_{OHSDCAS}$			2	—	ns	
MCLK $\uparrow$ → output delay time	$t_{ODSDWE}$	$\overline{\text{SWR}}$	—	—	15	ns	
Output hold time	$t_{OHSDWE}$			2	—	ns	
MCLK $\uparrow$ → output delay time	$t_{ODSDCS}$	$\overline{\text{CS6}}$ $\overline{\text{CS7}}$	—	—	15	ns	
Output hold time	$t_{OHSDCS}$			2	—	ns	
MCLK $\uparrow$ → output delay time	$t_{ODSDA}$	A00 to A15	—	—	15	ns	
Output hold time	$t_{OHSDA}$			2	—	ns	
MCLK $\uparrow$ → output delay time	$t_{ODSDDQM}$	DQM0U DQM0L	—	—	15	ns	
Output hold time	$t_{OHSDDQM}$			2	—	ns	
MCLK $\uparrow$ → output delay time	$t_{ODSDD}$	D16 to D31	—	—	15	ns	
Output hold time	$t_{OHSDD}$			2	—	ns	
Data input setup time	$t_{ISSDD}$	D16 to D31	—	15	—	ns	
Data input hold time	$t_{IHSDD}$			2	—	ns	





## 5. Electrical Characteristics for the A/D Converter

( $V_{DDI} = 1.8\text{ V} \pm 0.15\text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ,  $V_{SS} = AV_{SS} = 0\text{ V}$ ,  $T_a = -10\text{ }^\circ\text{C}$  to  $+70\text{ }^\circ\text{C}$ )

Parameter	Symbol	Pin	Value			Unit
			Min	Typ	Max	
Resolution	—	—	—	—	10	BIT
Total error	—	—	—	—	$\pm 5.5$	LSB
Nonlinear error	—	—	—	—	$\pm 3.5$	LSB
Differential linear error	—	—	—	—	$\pm 2.0$	LSB
Zero transition voltage	$V_{OT}$	AN0 to AN9	-4.0	—	+6.0	LSB
Full-transition voltage	$V_{FST}$	AN0 to AN9	$AVRH - 5.5$	—	$AVRH + 3.0$	LSB
Conversion time	—	—	8.18* <sup>1</sup>	—	—	$\mu\text{s}$
Analog port input current	$I_{AIN}$	AN0 to AN9	—	0.1	10	$\mu\text{A}$
Analog input voltage	$V_{AIN}$	AN0 to AN9	$AVSS$	—	$AVRH$	V
Reference voltage	—	$AVRH$	$AVSS$	—	$AVCC$	V
Power supply current	$I_A$	$AVCC$	—	3.6	—	mA
	$I_{AH}$		—	—	$10^{*2}$	$\mu\text{A}$
Reference voltage supply current	$I_R$	$AVRH$	—	600	—	$\mu\text{A}$
	$I_{RH}$		—	—	$10^{*2}$	$\mu\text{A}$
Variation between channels	—	AN0 to AN9	—	—	5	LSB

\*1 : For  $V_{DDI} = 1.8\text{ V} \pm 0.15\text{ V}$ ,  $V_{DDE} = AV_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ , machine clock = 32 MHz

\*2 : Current when A/D converter not operating ( $V_{DDE} = AV_{CC} = AVRH = 3.6\text{ V}$ ,  $V_{DDI} = 1.95\text{ V}$ )

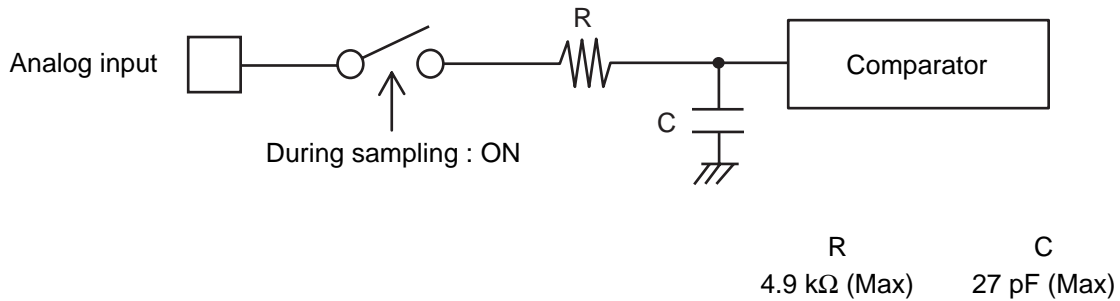
- Notes :
- The relative error increases as  $AVRH$  becomes smaller.
  - If the output impedance of the external circuit is too high, the analog voltage sampling time may be too short.

- **About the external impedance of the analog input and its sampling time**

- A/D converter with sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting A/D conversion precision. Therefore, to satisfy the A/D conversion precision standard, consider the relationship between the external impedance and minimum sampling time and either adjust the operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value.

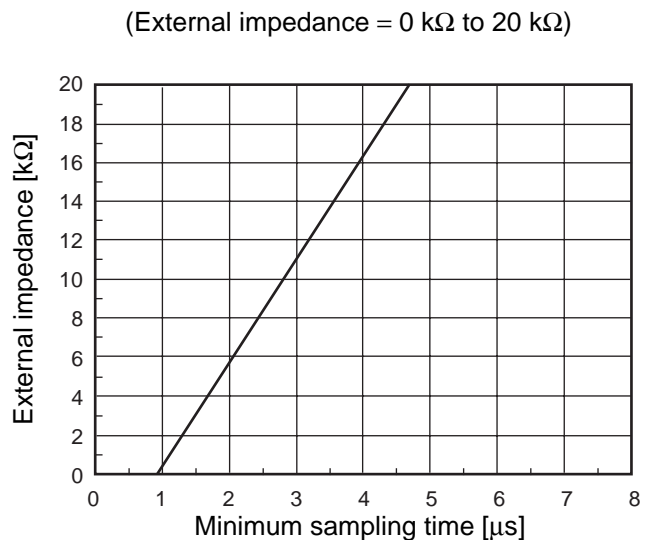
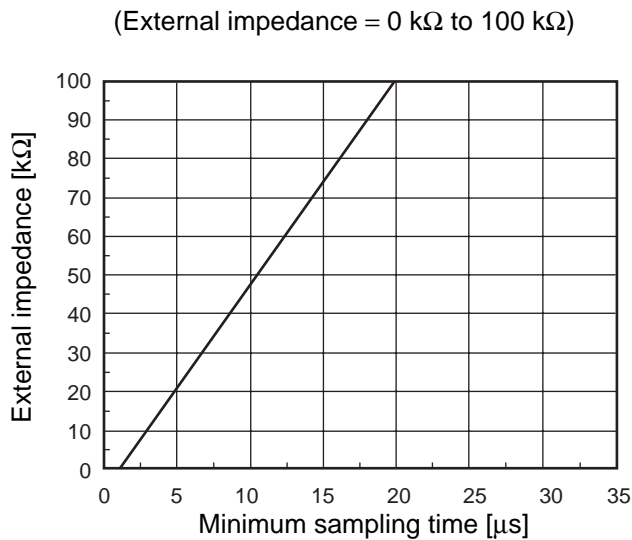
And if the sampling time cannot be sufficient, connect a capacitor of about 0.1  $\mu\text{F}$  to the analog input pin.

- Analog input circuit model



Note : The values are reference values.

- The relationship between the external impedance and minimum sampling time

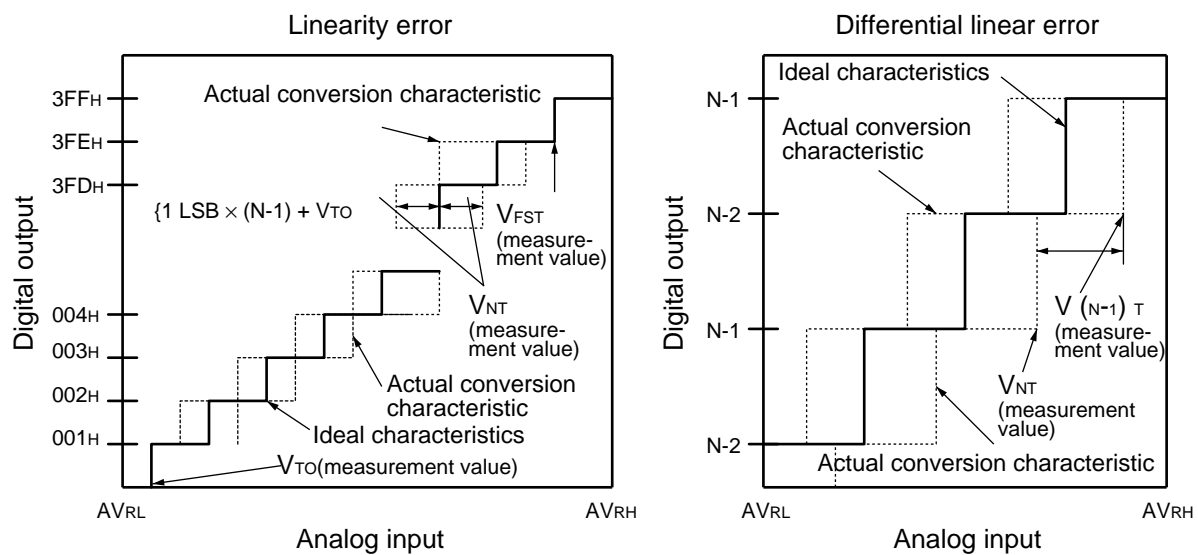


- About the error

The accuracy gets worse as  $|AVRH - AV_{SS}|$  becomes smaller.

## • Definition of A/D Converter Terms

- Resolution  
Analog variation that is recognized by an A/D converter.
- Linearity error  
The deviation between the actual conversion characteristics and a straight line connecting the device's zero transition point (“000000000” ←→ “000000001”) and full scale transition point (“111111110” ←→ “111111111”).
- Differential linear error  
Deviation of input voltage, which is required for changing output code by 1 LSB, from an ideal value.



$$\text{Linear error in digital output } N = \frac{V_{NT} - \{1\text{LSB} \times (N - 1) + V_{OT}\}}{1\text{LSB}} \text{ [LSB]}$$

$$\text{Differential linear error in digital output } N = \frac{V_{(N+1)T} - V_{NT}}{1\text{LSB}} \text{ [LSB]}$$

$$1\text{LSB} = \frac{V_{FST} - V_{OT}}{1022} \text{ [V]}$$

$$1\text{LSB}' = \frac{AV_{RH} - AV_{RL}}{1024} \text{ [V] (Ideal value)}$$

N : A/D converter digital output value

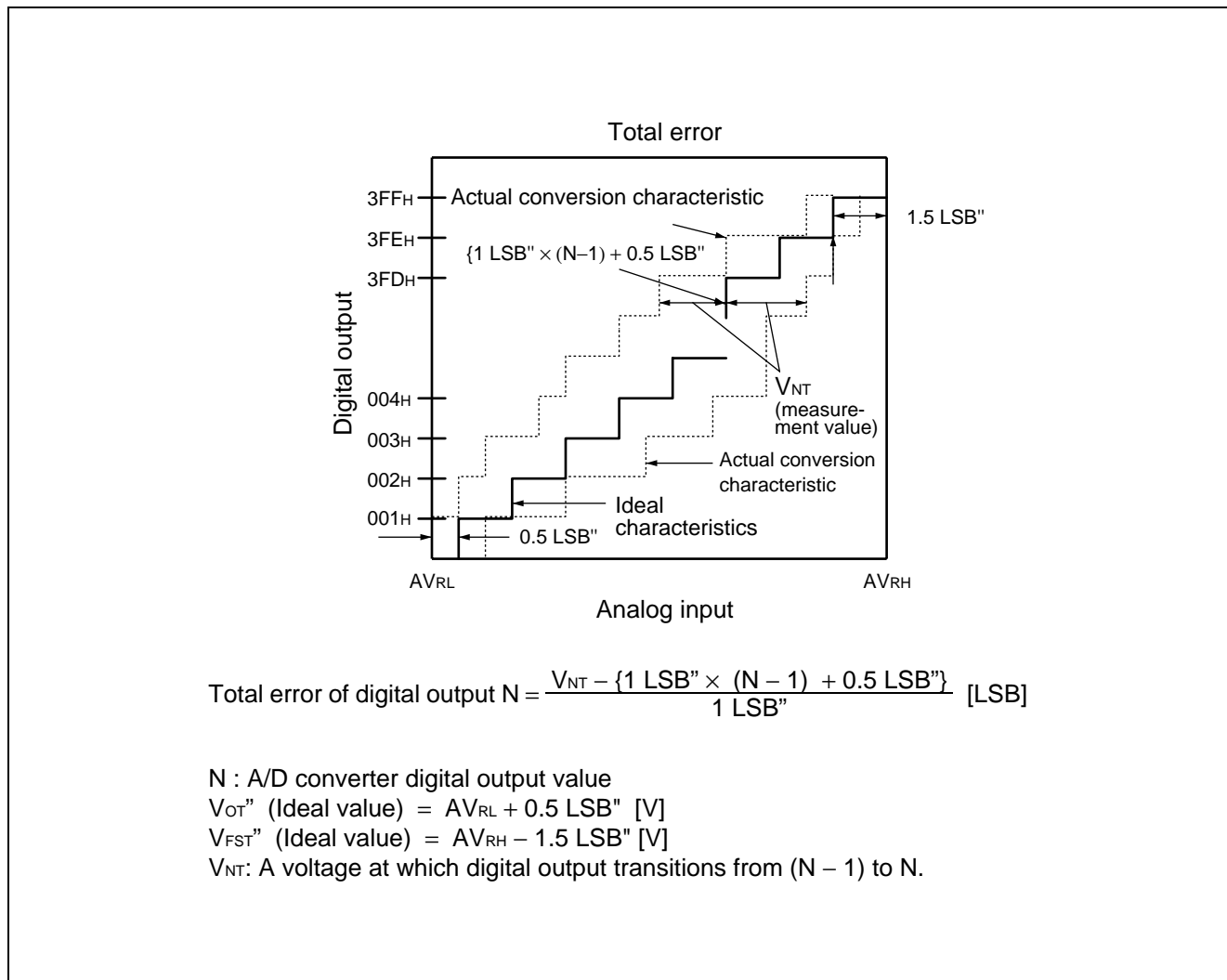
$V_{OT}$  : A voltage at which digital output transitions from (000)<sub>H</sub> to (001)<sub>H</sub>.

$V_{FST}$  : A voltage at which digital output transitions from (3FE)<sub>H</sub> to (3FF)<sub>H</sub>.

$V_{NT}$  : A voltage at which digital output transitions from (N - 1) to N.

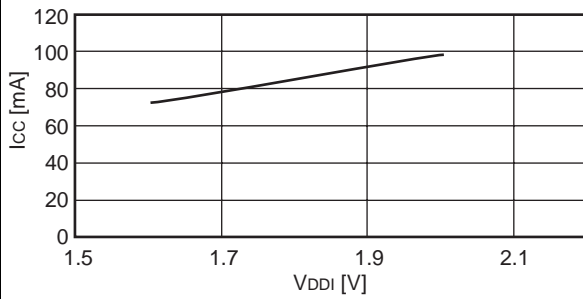
- Total error

This error indicates the difference between actual and ideal values, including the zero transition error/full-scale transition error/linearity error.

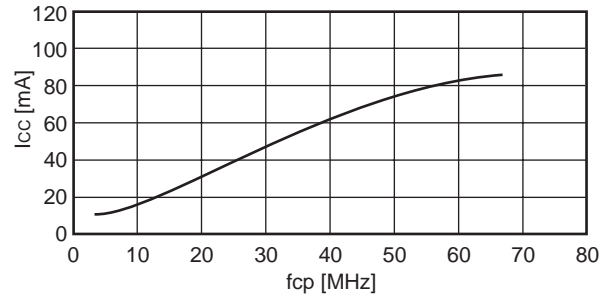


## EXAMPLE CHARACTERISTICS

**I<sub>CC</sub>-V<sub>DDI</sub> example characteristics**  
 Ta = + 25 °C, f<sub>CP</sub> = 68 MHz  
 f<sub>CPP</sub> = 34 MHz, f<sub>CPT</sub> = 34 MHz

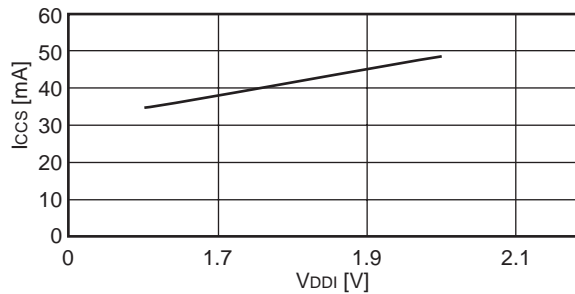


**I<sub>CC</sub>-f<sub>CP</sub> example characteristics**  
 Ta = + 25 °C, V<sub>DDE</sub> = 3.3 V  
 V<sub>DDI</sub> = 1.8 V

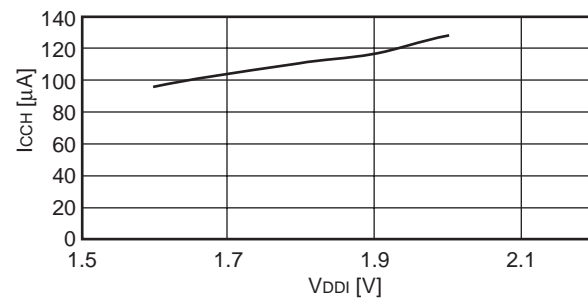


(f<sub>CP</sub> : f<sub>CPP</sub> : f<sub>CPT</sub> = 2 : 1 : 1, PLL 4 multiplication)

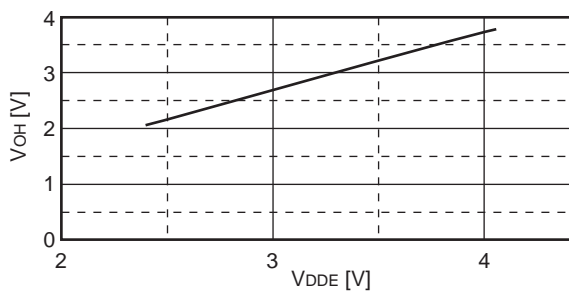
**I<sub>CCS</sub>-V<sub>DDI</sub> example characteristics**  
 Ta = + 25 °C



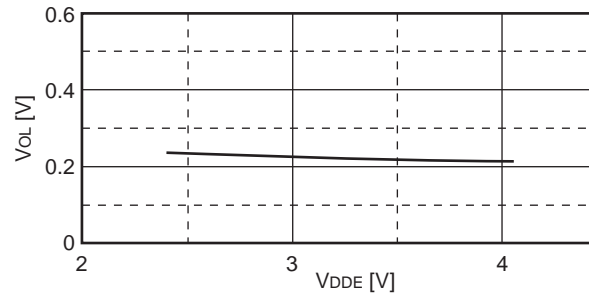
**I<sub>CCH</sub>-V<sub>DDI</sub> example characteristics**  
 Ta = + 25 °C



**V<sub>OH</sub>-V<sub>DDE</sub> example characteristics**  
 Ta = + 25 °C



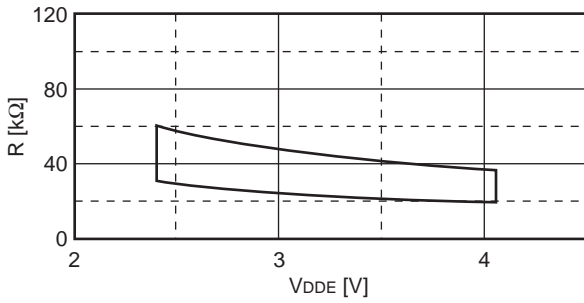
**V<sub>OL</sub>-V<sub>DDE</sub> example characteristics**  
 Ta = + 25 °C



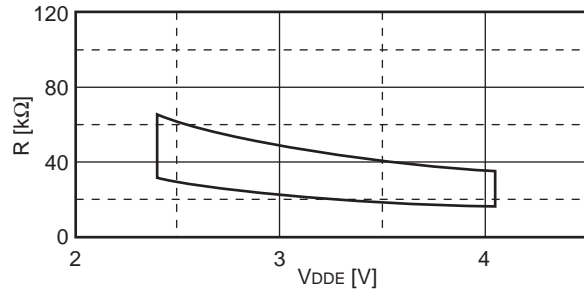
Note : Not including USB I/O

(Continued)

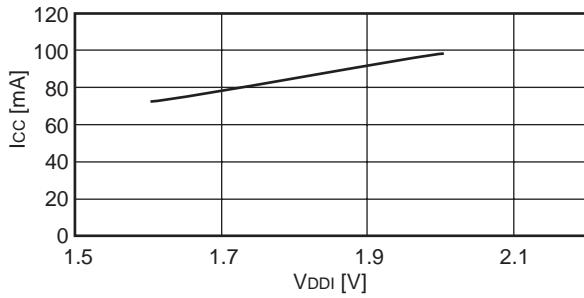
Pull-up resistor example characteristics  
 $T_a = +25\text{ }^\circ\text{C}$



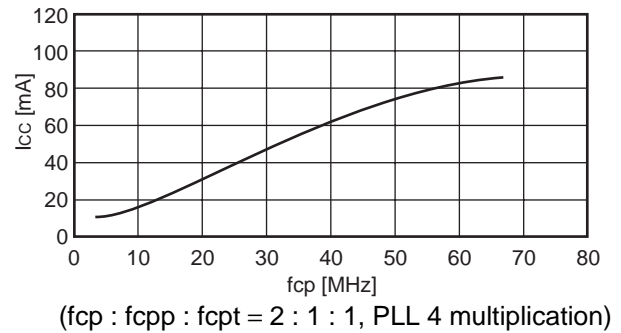
Pull-down resistor example characteristics  
 $T_a = +25\text{ }^\circ\text{C}$



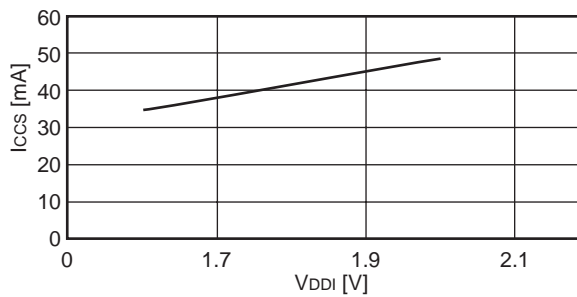
$I_{CC}$ - $V_{DDI}$  example characteristics  
 $T_a = +25\text{ }^\circ\text{C}$ ,  $f_{cp} = 68\text{ MHz}$   
 $f_{cpp} = 34\text{ MHz}$ ,  $f_{cpt} = 34\text{ MHz}$



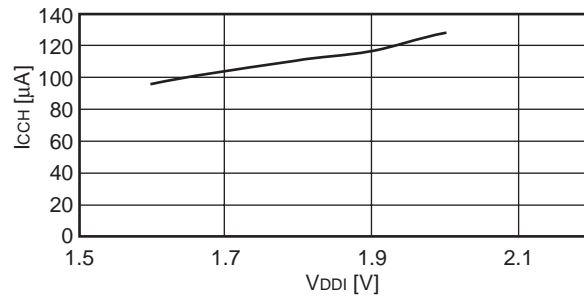
$I_{CC}$ - $f_{CP}$  example characteristics  
 $T_a = +25\text{ }^\circ\text{C}$ ,  $V_{DDE} = 3.3\text{ V}$   
 $V_{DDI} = 1.8\text{ V}$



$I_{CCS}$ - $V_{DDI}$  example characteristics  
 $T_a = +25\text{ }^\circ\text{C}$



$I_{CCH}$ - $V_{DDI}$  example characteristics  
 $T_a = +25\text{ }^\circ\text{C}$

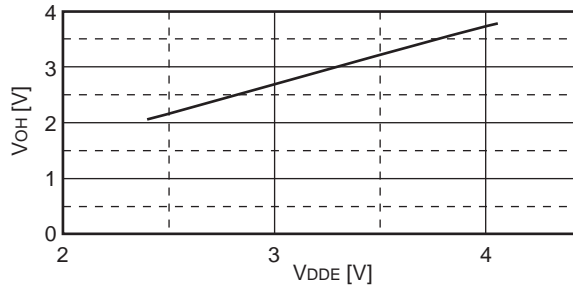


Note : Not including USB I/O

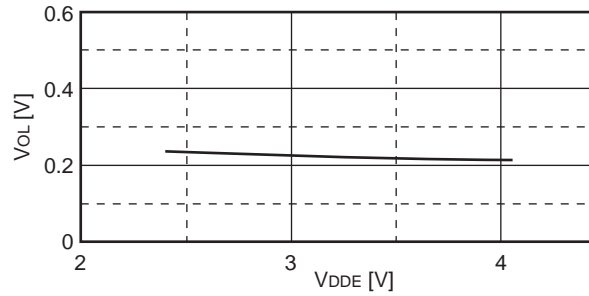
(Continued)

(Continued)

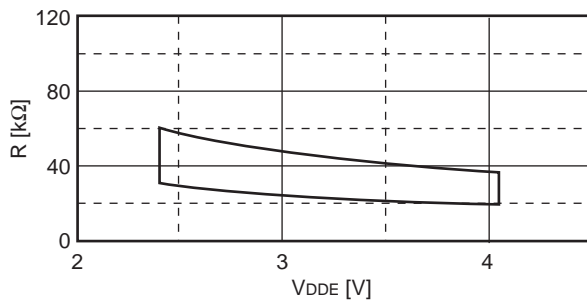
$V_{OH}-V_{DDE}$  example characteristics  
 $T_a = +25\text{ }^\circ\text{C}$



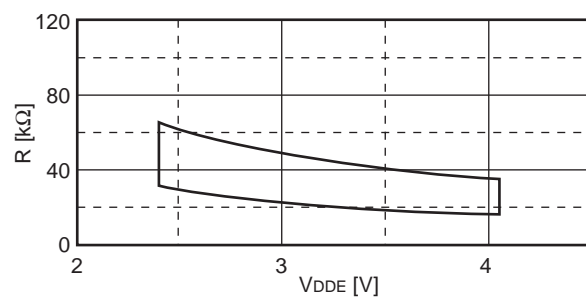
$V_{OL}-V_{DDE}$  example characteristics  
 $T_a = +25\text{ }^\circ\text{C}$



Pull-up resistor example characteristics  
 $T_a = +25\text{ }^\circ\text{C}$



Pull-down resistor example characteristics  
 $T_a = +25\text{ }^\circ\text{C}$



Note : Not including USB I/O

# MB91305

## ■ ORDERING INFORMATION

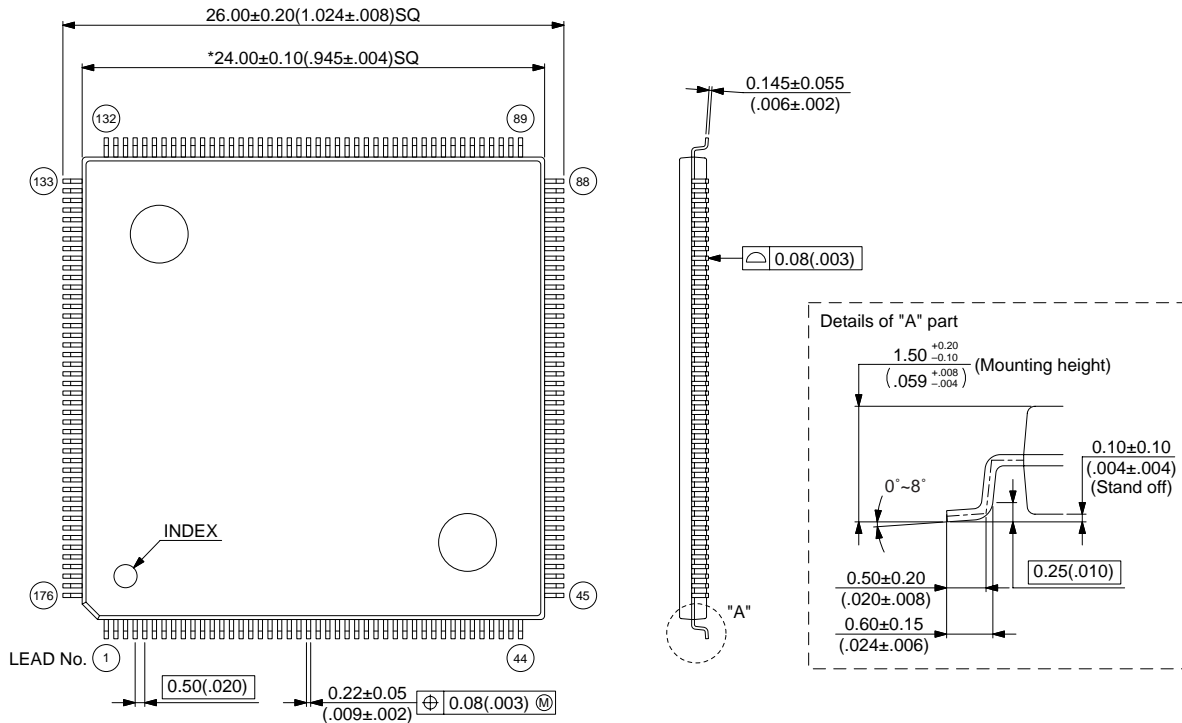
Part number	Package	Remarks
MB91305PMC	176-pin plastic LQFP (FPT-176P-M07)	



## PACKAGE DIMENSION

176-pin plastic LQFP  
(FPT-176P-M07)

- Note 1) \* : Values do not include resin protrusion.  
Resin protrusion is +0.25 (.010) Max (each side) .  
Note 2) Pins width and pins thickness include plating thickness.  
Note 3) Pins width do not include tie bar cutting remainder.



© 2004 FUJITSU LIMITED F176013S-c-1-1

Dimensions in mm (inches).  
Note: The values in parentheses are reference values.

The information for microcontroller supports is shown in the following homepage.  
<http://www.fujitsu.com/global/services/microelectronics/product/micom/support/index.html>

## FUJITSU LIMITED

All Rights Reserved.

The contents of this document are subject to change without notice. Customers are advised to consult with FUJITSU sales representatives before ordering.

The information, such as descriptions of function and application circuit examples, in this document are presented solely for the purpose of reference to show examples of operations and uses of Fujitsu semiconductor device; Fujitsu does not warrant proper operation of the device with respect to use based on such information. When you develop equipment incorporating the device based on such information, you must assume any responsibility arising out of such use of the information. Fujitsu assumes no liability for any damages whatsoever arising out of the use of the information.

Any information in this document, including descriptions of function and schematic diagrams, shall not be construed as license of the use or exercise of any intellectual property right, such as patent right or copyright, or any other right of Fujitsu or any third party or does Fujitsu warrant non-infringement of any third-party's intellectual property right or other right by using such information. Fujitsu assumes no liability for any infringement of the intellectual property rights or other rights of third parties which would result from the use of information contained herein.

The products described in this document are designed, developed and manufactured as contemplated for general use, including without limitation, ordinary industrial use, general office use, personal use, and household use, but are not designed, developed and manufactured as contemplated (1) for use accompanying fatal risks or dangers that, unless extremely high safety is secured, could have a serious effect to the public, and could lead directly to death, personal injury, severe physical damage or other loss (i.e., nuclear reaction control in nuclear facility, aircraft flight control, air traffic control, mass transport control, medical life support system, missile launch control in weapon system), or (2) for use requiring extremely high reliability (i.e., submersible repeater and artificial satellite).

Please note that Fujitsu will not be liable against you and/or any third party for any claims or damages arising in connection with above-mentioned uses of the products.

Any semiconductor devices have an inherent chance of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

If any products described in this document represent goods or technologies subject to certain restrictions on export under the Foreign Exchange and Foreign Trade Law of Japan, the prior authorization by Japanese government will be required for export of those products from Japan.